Neousys Technology Inc.

SEMIL-2000 Series

SEMIL-2200 Series

User Manual

v1.3

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Legal Information

All Neousys Technology Inc. products shall be subject to the latest Standard Warranty Policy

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Before installing any software, applications or components provided by a third party, customer should ensure that they are compatible and interoperable with Neousys Technology Inc. product by checking in advance with Neousys Technology Inc.. Customer is solely responsible for ensuring the compatibility and interoperability of the third party's products. Customer is further solely responsible for ensuring its systems, software, and data are adequately backed up as a precaution against possible failures, alternation, or loss.

For questions in regards to hardware/ software compatibility, customers should contact Neousys Technology Inc. sales representative or technical support.

To the extent permitted by applicable laws, Neousys Technology Inc. shall NOT be responsible for any interoperability or compatibility issues that may arise when (1) products, software, or options not certified and supported; (2) configurations not certified and supported are used; (3) parts intended for one system is installed in another system of different make or model.

Contact Information

For contact information, please visit our official website

Declaration of Conformity

FCC	This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at own expense.
CE	The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.

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All other names, brands, products or services are trademarks or registered trademarks of their respective owners.

Safety Precautions

- Read these instructions carefully before you install, operate, or transport the system.
- Install the system or DIN rail associated with, at a sturdy location
- Install the power socket outlet near the system where it is easily accessible
- Secure each system module(s) using its retaining screws
- Place power cords and other connection cables away from foot traffic. Do not place items over power cords and make sure they do not rest against data cables
- Shutdown, disconnect all cables from the system and ground yourself before touching internal modules
- Ensure that the correct power range is being used before powering the device
- Should a module fail, arrange for a replacement as soon as possible to minimize down-time
- If the system is not going to be used for a long time, disconnect it from mains (power socket) to avoid transient over-voltage

Battery Warning

- Batteries are at risk of exploding if incorrectly installed
- Do not attempt to recharge, force open, or heat the battery
- Replace the battery only with the same or equivalent type recommended by the manufacturer

Service and Maintenance

- ONLY qualified personnel should service the system
- Shutdown the system, disconnect the power cord and all other connections before servicing the system
- When replacing/ installing additional components (expansion card, memory module, etc.), insert them as gently as possible while assuring connectors are properly engaged

ESD Precautions

- Handle add-on module, motherboard by their retention screws or the module's frame/ heat sink. Avoid touching the PCB circuit board or add-on module connector pins
- Use a grounded wrist strap and an anti-static work pad to discharge static electricity when installing or maintaining the system
- Avoid dust, debris, carpets, plastic, vinyl and styrofoam in your work area.
- Do not remove any module or component from its anti-static bag before installation

Restricted Access Location

The controller is intended for installation only in the certain environment where both these condition apply:

- Access can only be gained by SERVICE PERSONS or by USERS who have been instructed about the reasons for the restrictions applied to the location and about any precautions that shall be taken
- Access is through the use of a TOOL or lock and key, or other means of security, and is controlled by the authority responsible for the location

About This Manual

This user manual introduces Neousys Technology SEMIL-2000 series, an IP69K waterproof extreme-rugged fanless GPU computer that supports NVIDIA® L4 while featuring workstation-grade Intel® chipset and offers excellent passive thermal performance with M12 connectors for robust and cost-effectiveness.

Applicable systems

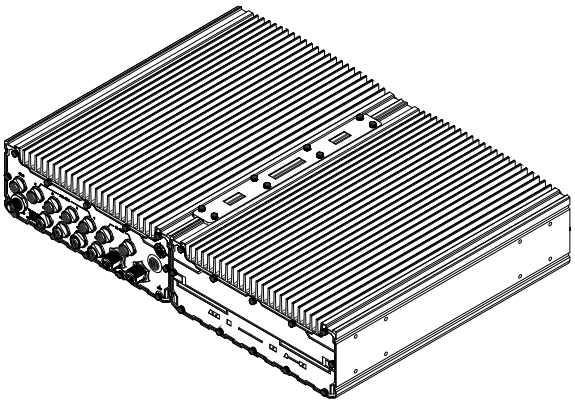
Series	Description
SEMIL-2000	19" 2U half-rack mount IP69K waterproof computer supporting Intel® 14th / 13th/ 12th-Gen Core™ processor with 2x M12 10GbE and 4x M12 PoE+ ports
SEMIL-2000GC	19" 2U rack mount IP69K waterproof computer including NVIDIA® L4, supporting Intel® 14th/ 13th/ 12th-Gen Core™ processor with 2x M12 10GbE and 4x M12 PoE+ ports
SEMIL-2200	19" 2U half-rack mount IP69K waterproof computer supporting Intel® 14th / 13th/ 12th-Gen Core™ processor, MIL-STD-810H, MIL-STD-461G, MIL-STD-1275D compliant
SEMIL-2200GC	19" 2U rack mount IP69K waterproof computer including NVIDIA® L4, supporting Intel® 14th/ 13th/ 12th-Gen Core™ processor, MIL-STD-810H, MIL-STD-461G, MIL-STD-1275D compliant

Revision History

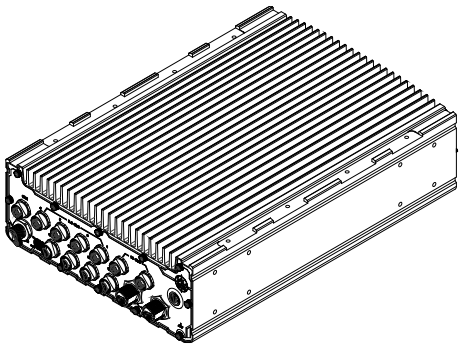
Version	Date	Description
1.0	Mar. 2024	Initial release
1.1	Oct. 2025	Added SEMIL-2008/ 2048GC/ 2207/ 2247GC
1.2	Mar. 2026	Updated screw torque range specifications
1.3	Jun. 2026	Updated SEMIL-2200 series CPU BIOS information

1 Introduction

The Neousys SEMIL-2000/ 2000GC series is an extreme-rugged, IP69K-rated edge AI platform engineered for mission-critical applications operating in the harshest environments. Featuring a 2U 19-inch rack-mount chassis, the system is fully dustproof, waterproof, and capable of fanless operation ranging from -40°C to 70°C temperatures.



SEMIL-2000GC/ 2200GC Series



SEMIL-2000/ 2200 Series

Powered by Intel® 14th/13th/12th-Gen Core™ processors based on Intel® 7 photolithography, the SEMIL-2000/ 2000GC series delivers outstanding hybrid performance and energy efficiency while supporting up to 64 GB DDR5 ECC/non-ECC memory. At its core, the SEMIL-2000GC/ 2200GC series integrates an NVIDIA® L4 GPU, offering up to 2.5× the performance of the Tesla T4, enabling advanced AI inference and acceleration at the edge, in extreme environments.

The SEMIL series adopts a corrosion-resistant stainless steel and aluminum chassis to counteract moisture and salinity with up to IP69K protection, ensuring long-term reliability in marine, defense, and outdoor deployments. Its ruggedized M12 connectors provide secure, vibration-resistant connections for a wide range of I/O, including two CAN bus 2.0 with SocketCAN drivers, multiple USB 3.2, and seven Ethernet ports, two of which support 10GbE. Additionally, it offers four optional 802.3at PoE+ ports capable of supplying up to 25.5W per port, along with M.2 NVMe and mini-PCIe expansion, and dual 2.5" SATA SSD/HDD bays for storage flexibility.

Designed for demanding mobility and defense environments, the platform supports an 8V to 48V or 9V to 36V wide-range DC input with ignition power control, and complies with MIL-STD-810H for shock, vibration, and temperature endurance. For specific model variants, they also meet MIL-STD-461G for electromagnetic compatibility and MIL-STD-1275D for vehicular power requirements.

1.1 Specifications

1.1.1 SEMIL-2007 Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-14900/ i9-14900T - Intel® Core™ i7-14700/ i7-14700T - Intel® Core™ i5-14500/ i5-14400/ i5-14500T - Intel® Core™ i3-14100/ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-13900E/ i9-13900TE - Intel® Core™ i7-13700E/ i7-13700TE - Intel® Core™ i5-13500E/ i5-13400E/ i5-13500TE - Intel® Core™ i3-13100E/ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-12900E/ i9-12900TE - Intel® Core™ i7-12700E/ i7-12700TE - Intel® Core™ i5-12500E/ i5-12500TE - Intel® Core™ i3-12100E/ i3-12100TE - Intel® Pentium® G7400E/ G7400TE - Intel® Celeron® G6900E/ G6900TE
Chipset	Intel® Q670E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Memory	Up to 128 GB DDR5 4800 SDRAM (two SODIMM slots)
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10GbE Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5GbE Ethernet by Intel I226-IT (PoE+) (M12 X-coded) 1x GbE Ethernet by Intel I219-LM (with WoL) (M12 X-coded)
PoE+	4x IEEE 802.3at PoE+ PSE with 100 W total power budget
CANbus	2x CAN 2.0 port, supporting SocketCAN in Linux
Serial port	2x isolated 3-wire RS-232 ports (COM1/ COM2)
	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports in M12 A-code
Video port	2x Type-C USB connector supporting DP output (via the shared USB3.2 Gen1x1 port)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD

Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot
M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module 1x M.2 2230 E key socket for Wi-Fi
Power Supply	
DC Input	8V to 48V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E, tested burn-in PL2 35W mode: 114W (Max.) @ 24V 35W mode: 119W (Max.) @ 48V 65W mode: 151W (Max.) @ 24V 65W mode: 157W (Max.) @ 48V
Mechanical	
Dimension	220mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	6kg
Mounting Method	Rack-mount and wall-mount
Environmental	
Operating Temperature	With 35W CPU -40°C to 70°C With >= 65W CPU -40°C to 70°C (configured as 35W TDP mode) -40°C to 60°C (configured as 65W TDP mode)
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H, 514.8C-IV. Category 4
Shock	MIL-STD-810H, 516.8 Procedure I
EMC	EN 50121 (EN 50155 EMC) CE/FCC Class A, according to EN 55032 & EN 55024
Ingress protection	IP69K

1.1.2 SEMIL-2008 Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-14900/ i9-14900T - Intel® Core™ i7-14700/ i7-14700T - Intel® Core™ i5-14500/ i5-14400/ i5-14500T - Intel® Core™ i3-14100/ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-13900E/ i9-13900TE - Intel® Core™ i7-13700E/ i7-13700TE - Intel® Core™ i5-13500E/ i5-13400E/ i5-13500TE - Intel® Core™ i3-13100E/ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-12900E/ i9-12900TE - Intel® Core™ i7-12700E/ i7-12700TE - Intel® Core™ i5-12500E/ i5-12500TE - Intel® Core™ i3-12100E/ i3-12100TE - Intel® Pentium® G7400E/ G7400TE - Intel® Celeron® G6900E/ G6900TE
Chipset	Intel® R680E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Memory	Up to 128 GB ECC/ non-ECC DDR5 4800 SDRAM (two SODIMM slots)
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10GbE Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5GbE Ethernet by Intel I226-IT (PoE+) (M12 X-coded) 1x GbE Ethernet by Intel I219-LM (with WoL) (M12 X-coded) 1x 2.5GbE Ethernet by Intel I226-IT (M12 X-coded)
PoE+	4x IEEE 802.3at PoE+ PSE with 100 W total power budget
CANbus	2x CAN 2.0 port, supporting SocketCAN in Linux
Serial port	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports in M12 A-code
Video port	2x Type-C USB connector supporting DP output (via the shared USB3.2 Gen1x1 port)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD
Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot

M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module
Power Supply	
DC Input	8V to 48V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E, tested burn-in PL2 35W mode: 114W (Max.) @ 24V 35W mode: 119W (Max.) @ 48V 65W mode: 151W (Max.) @ 24V 65W mode: 157W (Max.) @ 48V
Mechanical	
Dimension	220mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	6kg
Mounting Method	Rack-mount and wall-mount
Environmental	
Operating Temperature	With 35W CPU -40°C to 70°C With >= 65W CPU -40°C to 70°C (configured as 35W TDP mode) -40°C to 60°C (configured as 65W TDP mode)
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H, 514.8C-IV. Category 4
Shock	MIL-STD-810H, 516.8 Procedure I
EMC	EN 50121 (EN 50155 EMC) CE/FCC Class A, according to EN 55032 & EN 55024
Ingress protection	IP69K

1.1.3 SEMIL-2207 Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-14900T - Intel® Core™ i7-14700T - Intel® Core™ i5-14500T - Intel® Core™ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-13900TE - Intel® Core™ i7-13700TE - Intel® Core™ i5-13500TE - Intel® Core™ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-12900TE - Intel® Core™ i7-12700TE - Intel® Core™ i5-12500TE - Intel® Core™ i3-12100TE
Chipset	Intel® R680E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Memory	Up to 128 GB ECC/ non-ECC DDR5 4800 SDRAM (two SODIMM slots)
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10GbE Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5GbE Ethernet by Intel I226-IT (M12 X-coded) 1x GbE Ethernet by Intel I219-LM (with WoL) (M12 X-coded)
CANbus	2x CAN 2.0 port, supporting SocketCAN in Linux
Serial port	2x isolated 3-wire RS-232 ports (COM1/ COM2) 1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports in M12 (A-coded)
Video port	2x Type-C USB connector supporting DP output (via the shared USB3.2 Gen1x1 port)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD
Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot
M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module 1x M.2 2230 E key socket for Wi-Fi
Power Supply	

DC Input	9V to 36V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E, tested burn-in PL2 35W mode: 114W (Max.) @ 24V
Mechanical	
Dimension	220mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	12kg
Mounting Method	Wall-mount (standard), rack-mount (standard)
Environmental	
Operating Temperature	-40°C to 70°C
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H: 514.8C-VII. Category 4
Shock	MIL-STD-810H: 516.8 Procedure I
EMC	MIL-STD-461G: - CE102 (10kHz – 10MHz) - RE102 (2Mhz – 18GHz) - RS103 (2MHz – 18GHz, 50V/m)
Electrical Systems	MIIL-STD-1275D: Normal operating mode (ripples, surges, spikes)
Ingress protection	IP69K

1.1.4 SEMIL-2047GC Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-14900/ i9-14900T - Intel® Core™ i7-14700/ i7-14700T - Intel® Core™ i5-14500/ i5-14400/ i5-14500T - Intel® Core™ i3-14100/ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-13900E/ i9-13900TE - Intel® Core™ i7-13700E/ i7-13700TE - Intel® Core™ i5-13500E/ i5-13400E/ i5-13500TE - Intel® Core™ i3-13100E/ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-12900E/ i9-12900TE - Intel® Core™ i7-12700E/ i7-12700TE - Intel® Core™ i5-12500E/ i5-12500TE - Intel® Core™ i3-12100E/ i3-12100TE - Intel® Pentium® G7400E/ G7400TE - Intel® Celeron® G6900E/ G6900TE
Chipset	Intel® Q670E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Memory	Up to 128 GB DDR5 4800 SDRAM (two SODIMM slots)
Accelerated GPU	NVIDIA® L4 GPU
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10Gb Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5Gb Ethernet by Intel I226-IT (PoE+) (M12 X-coded) 1x Gb Ethernet by Intel I219-LM (with WoL) (M12 X-coded)
PoE+	4x IEEE 802.3at PoE+ PSE with 100 W total power budget
CANbus	2x isolated CAN 2.0 port, supporting SocketCAN in Linux
Serial port	2x isolated 3-wire RS-232 ports (COM1/ COM2) 1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports (M12 A-coded)
Video port	2x Type-C USB connector supporting DP output (shared USB3.2 Gen1x1)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD
Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot

M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module 2x M.2 2230 E key socket for Wi-Fi
Power Supply	
DC Input	8V to 48V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E with NVIDIA L4, tested GPU-burn, burn-in PL2 35W mode: 192W (Max.) @ 24V 35W mode: 194W (Max.) @ 48V 65W mode: 238W (Max.) @ 24V 65W mode: 234W (Max.) @ 48V
Mechanical	
Dimension	440mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	12 kg
Mounting Method	Rack-mount and wall-mount
Environmental	
Operating Temperature	With 35W CPU -40°C to 70°C With CPU operating >= 65W -40°C to 70°C (configured as 35W TDP mode) -40°C to 60°C (configured as 65W TDP mode)
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H, 514.8C-IV. Category 4
Shock	MIL-STD-810H, 516.8 Procedure I
EMC	EN 50121 (EN 50155 EMC) CE/FCC Class A, according to EN 55032 & EN 55035
Ingress protection	IP69K

1.1.5 SEMIL-2048GC Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-14900/ i9-14900T - Intel® Core™ i7-14700/ i7-14700T - Intel® Core™ i5-14500/ i5-14400/ i5-14500T - Intel® Core™ i3-14100/ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-13900E/ i9-13900TE - Intel® Core™ i7-13700E/ i7-13700TE - Intel® Core™ i5-13500E/ i5-13400E/ i5-13500TE - Intel® Core™ i3-13100E/ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 65W/ 35W TDP) - Intel® Core™ i9-12900E/ i9-12900TE - Intel® Core™ i7-12700E/ i7-12700TE - Intel® Core™ i5-12500E/ i5-12500TE - Intel® Core™ i3-12100E/ i3-12100TE - Intel® Pentium® G7400E/ G7400TE - Intel® Celeron® G6900E/ G6900TE
Chipset	Intel® R680E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Memory	Up to 128 GB ECC/ non-ECC DDR5 4800 SDRAM (two SODIMM slots)
Accelerated GPU	NVIDIA® L4 GPU
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10Gb Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5Gb Ethernet by Intel I226-IT (PoE+) (M12 X-coded) 1x Gb Ethernet by Intel I219-LM (with WoL) (M12 X-coded) 1x 2.5GbE Ethernet by Intel I226-IT (M12 X-coded)
PoE+	4x IEEE 802.3at PoE+ PSE with 100 W total power budget
CANbus	2x isolated CAN 2.0 port, supporting SocketCAN in Linux
Serial port	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports (M12 A-coded)
Video port	2x Type-C USB connector supporting DP output (shared USB3.2 Gen1x1)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD
Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot
M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module

Power Supply	
DC Input	8V to 48V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E with NVIDIA L4, tested GPU-burn, burn-in PL2 35W mode: 192W (Max.) @ 24V 35W mode: 194W (Max.) @ 48V 65W mode: 238W (Max.) @ 24V 65W mode: 234W (Max.) @ 48V
Mechanical	
Dimension	440mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	12 kg
Mounting Method	Rack-mount and wall-mount
Environmental	
Operating Temperature	With 35W CPU -40°C to 70°C With CPU operating >= 65W -40°C to 70°C (configured as 35W TDP mode) -40°C to 60°C (configured as 65W TDP mode)
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H, 514.8C-IV. Category 4
Shock	MIL-STD-810H, 516.8 Procedure I
EMC	EN 50121 (EN 50155 EMC) CE/FCC Class A, according to EN 55032 & EN 55035
Ingress protection	IP69K

1.1.6 SEMIL-2247GC Specifications

System Platform	
Processor	Supporting Intel® 14th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-14900T - Intel® Core™ i7-14700T - Intel® Core™ i5-14500T - Intel® Core™ i3-14100T
	Supporting Intel® 13th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-13900TE - Intel® Core™ i7-13700TE - Intel® Core™ i5-13500TE - Intel® Core™ i3-13100TE
	Supporting Intel® 12th-Gen Core™ CPU (LGA1700 socket, 35W TDP) - Intel® Core™ i9-12900TE - Intel® Core™ i7-12700TE - Intel® Core™ i5-12500TE - Intel® Core™ i3-12100TE
Chipset	Intel® R680E platform controller hub
Graphics	Integrated Intel® UHD Graphics 770 (32EU)
Acceleration GPU	NVIDIA® L4 GPU
Memory	Up to 128 GB ECC/ non-ECC DDR5 4800 SDRAM (two SODIMM slots)
AMT	Supports Intel vPro/ AMT 16.0
TPM	Supports dTPM 2.0
I/O Interface	
Ethernet	2x 10GbE Ethernet by X550-AT2 (with WoL) (M12 X-coded) 4x 2.5GbE Ethernet by Intel I226-IT (M12 X-coded) 1x GbE Ethernet by Intel I219-LM (with WoL) (M12 X-coded)
CANbus	2x CAN 2.0 port, supporting SocketCAN in Linux
Serial port	2x isolated 3-wire RS-232 ports (COM1/ COM2) 1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
USB port	2x Type-C USB 3.2 Gen1x1 (5Gbps) ports (shared DisplayPort) 2x USB 2.0 ports in M12 (A-coded)
Video port	2x Type-C USB connector supporting DP output (via the shared USB3.2 Gen1x1 port)
Storage Interface	
SATA HDD	2x internal SATA ports for 2.5” HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen4x4) for NVMe SSD
Expansion Bus	
Mini PCI-E	3x full-size mini PCI Express sockets with SIM slot
M.2	1x M.2 2242/3052 B key socket with dual SIM slot for M.2 5G/ 4G module 1x M.2 2230 E key socket for Wi-Fi

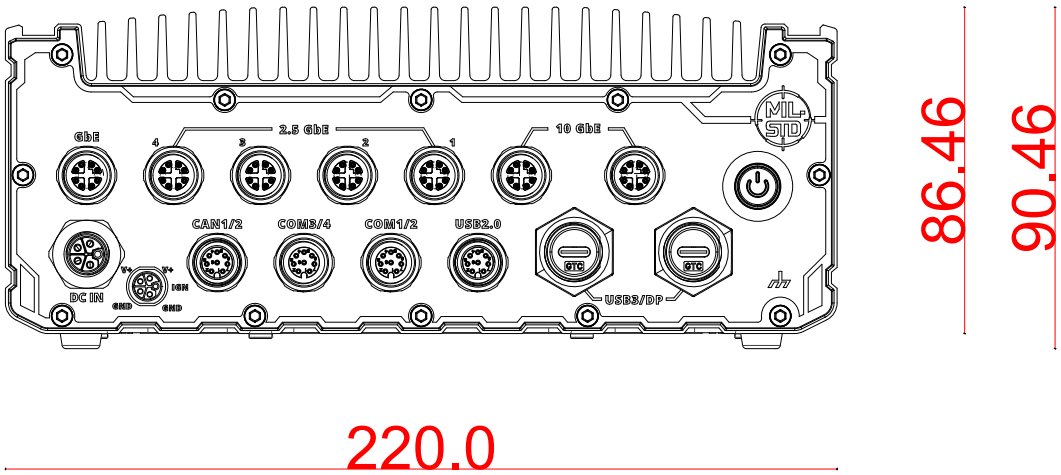
Power Supply	
DC Input	9V to 36V DC input, with reverse polarity protection (M12 L-coded)
Ignition Control	Built-in ignition power control (IGN/ GND signal via M12 L-coded connector)
Max. Power Consumption	For reference only, actual consumption may vary depending on configuration. With i9-13900E, tested burn-in PL2 35W mode: 114W (Max.) @ 24V
Mechanical	
Dimension	440mm (W) x 310mm (D) x 90.5mm (H) (excluding rack-mount bracket)
Weight	12kg
Mounting Method	Wall-mount (standard), rack-mount (standard)
Environmental	
Operating Temperature	-40°C to 70°C
Storage Temperature	-40°C to 85°C
Humidity	10% to 90%, non-condensing
Vibration	MIL-STD-810H: 514.8C-VII. Category 4
Shock	MIL-STD-810H: 516.8 Procedure I
EMC	MIL-STD-461G: - CE102 (10kHz – 10MHz) - RE102 (2Mhz – 18GHz) - RS103 (2MHz – 18GHz, 50V/m)
Electrical Systems	MIIL-STD-1275D: Normal operating mode (ripples, surges, spikes)
Ingress protection	IP69K

1.2 SEMIL-2000/ 2200 Series Dimension

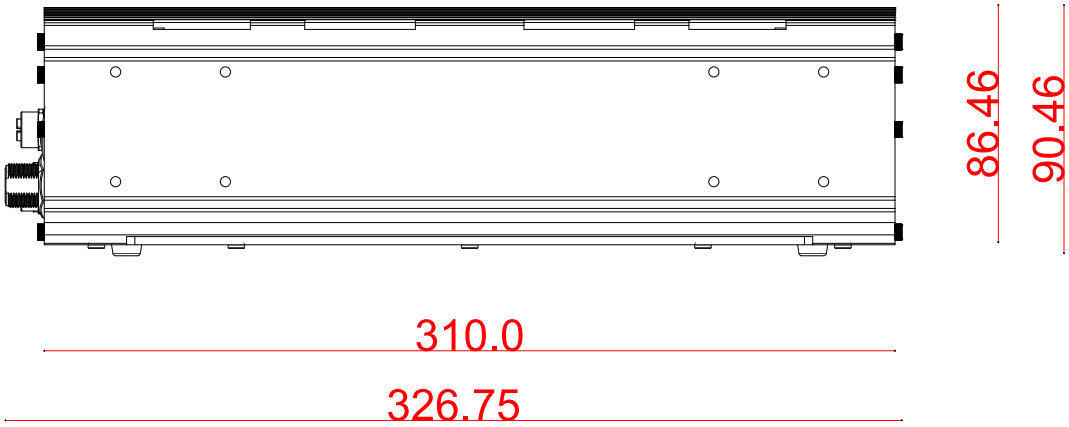
NOTE

All measurements are in millimeters (mm).

1.2.1 SEMIL-2000/ 2200 Series Front Panel View



1.2.2 SEMIL-2000/ 2200 Series Side Panel View

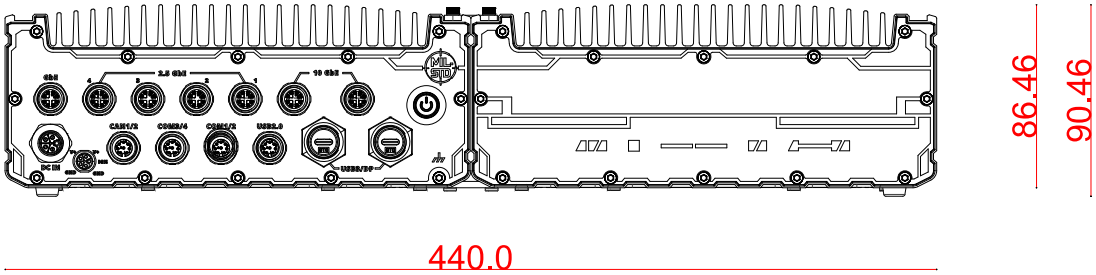


1.3 SEMIL-2000GC/ 2200GC Series Dimension

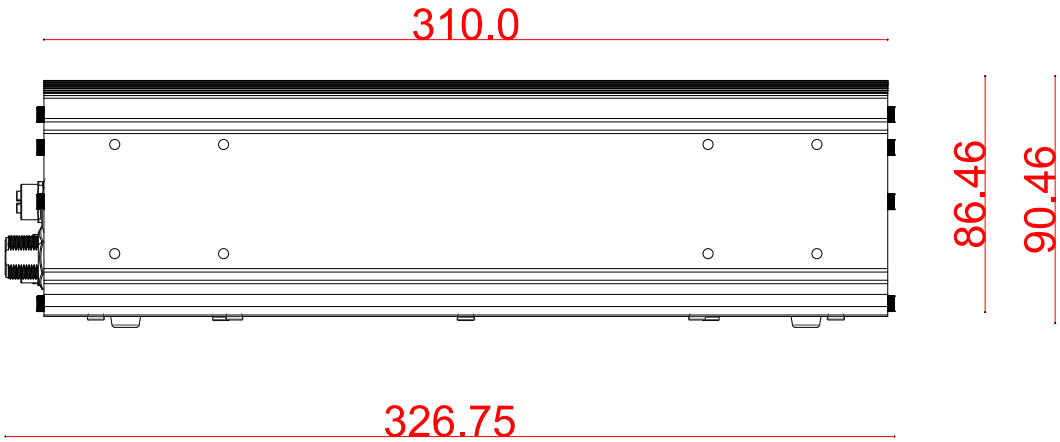
NOTE

All measurements are in millimeters (mm).

1.3.1 SEMIL-2000GC/ 2200GC Series Front View



1.3.2 SEMIL-2000GC/ 2200GC Series Side View



2 System Overview

Upon receiving and unpacking your system, please check immediately if the package contains all the items listed in the following table. If any item(s) are missing or damaged, please contact your local dealer or Neousys Technology.

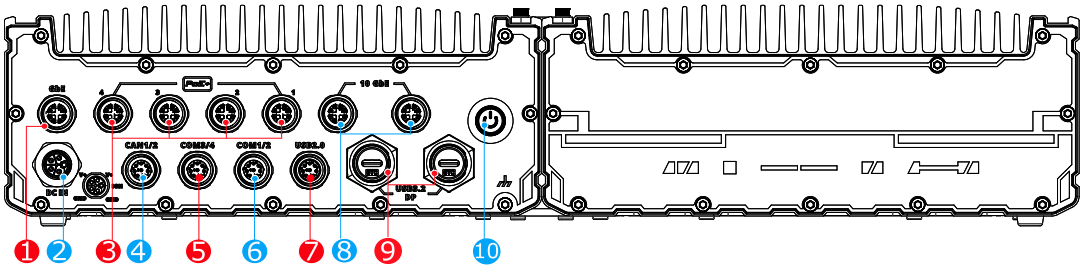
2.1 SEMIL-2000/ 2000GC Series Packing List

System / Pack	SEMIL-2000	Qty
1	SEMIL-2000GC series system (If you ordered CPU, RAM, HDD, please verify these items)	1
2	Accessory box, which contains • CPU bracket • Wall-mounting bracket • Rackmount handle	 1 4 2

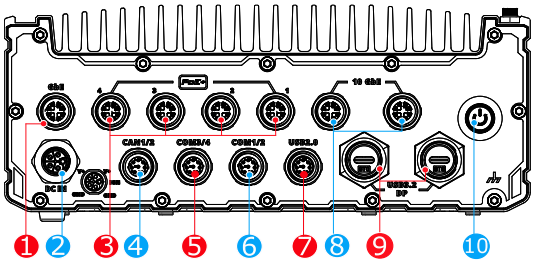
2.2 SEMIL-2200/ 2200GC Series Packing List

System / Pack	SEMIL-2000	Qty
1	SEMIL-2000GC series system (If you ordered CPU, RAM, HDD, please verify these items)	1
2	Accessory box, which contains • CPU bracket • Wall-mounting bracket • Rackmount handle	 1 4 2

2.3 SEMIL-2007/ 2047GC Series Front Panel



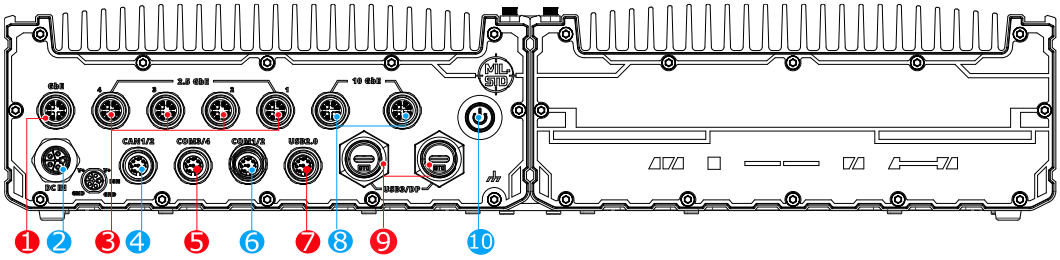
SEMIL-2047GC



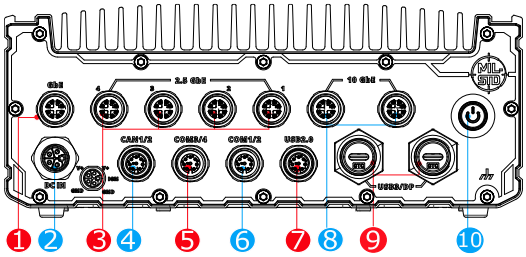
SEMIL-2007

o.	Item	Description
1	GbE	M12 X-coded 1Gb Ethernet via Intel i219-LM
2	DC-in	8V to 48V or 9V to 36V DC input, with reverse polarity protection (M12 L-coded)
3	2.5GbE & PoE+	The M12 X-coded 2.5Gb Ethernet ports are backward compatible with 1GbE. The Power over Ethernet (PoE) connection provides both data connection and electric power to devices (eg. IP camera).
4	CAN1/ 2	The CANbus 2.0 connectivity allows the system to communicate with other CAN devices
5	COM3/ 4	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
6	COM1/ 2	COM 1 & 2 are isolated RS-232 ports via an M12 A-coded connector.
7	USB 2.0	The M12 A-coded USB 2.0 port is backward-compatible with USB 1.1/ 1.0.
8	10GbE	The 10GbE is backwards compatible with 5Gb, 2.5Gb, and GbE connections.
9	Type-C USB or DisplayPort	Type-C USB 3.2 Gen1x1 (5Gbps) port, and supports alternative mode for DisplayPort
10	Power button	Use this button to turn on or force shutdown the system. This button can also be used to clear the system's CMOS.

2.4 SEMIL-2207/ 2247GC Series Front Panel



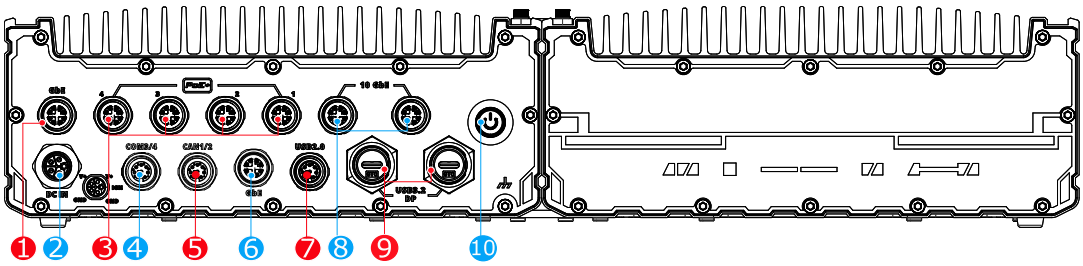
SEMIL-2247GC



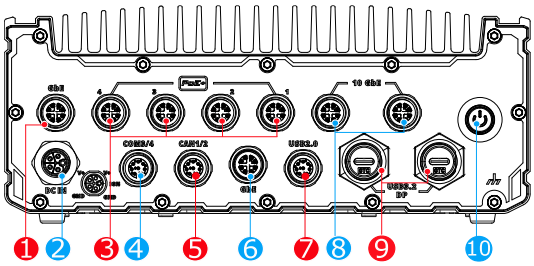
SEMIL-2207

o.	Item	Description
1	GbE	M12 X-coded 1Gb Ethernet via Intel i219-LM
2	DC-in	8V to 48V or 9V to 36V DC input, with reverse polarity protection (M12 L-coded)
3	2.5GbE	The M12 X-coded 2.5Gb Ethernet ports are backward compatible with 1GbE.
4	CAN1/ 2	The CANbus 2.0 connectivity allows the system to communicate with other CAN devices
5	COM3/ 4	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
6	COM1/ 2	COM 1 & 2 are isolated RS-232 ports via an M12 A-coded connector.
7	USB 2.0	The M12 A-coded USB 2.0 port is backward-compatible with USB 1.1/ 1.0.
8	10GbE	The 10GbE is backwards compatible with 5Gb, 2.5Gb, and GbE connections.
9	Type-C USB or DisplayPort	Type-C USB 3.2 Gen1x1 (5Gbps) port, and supports alternative mode for DisplayPort
10	Power button	Use this button to turn on or force shutdown the system. This button can also be used to clear the system's CMOS.

2.5 SEMIL-2008/ 2048GC Series Front Panel



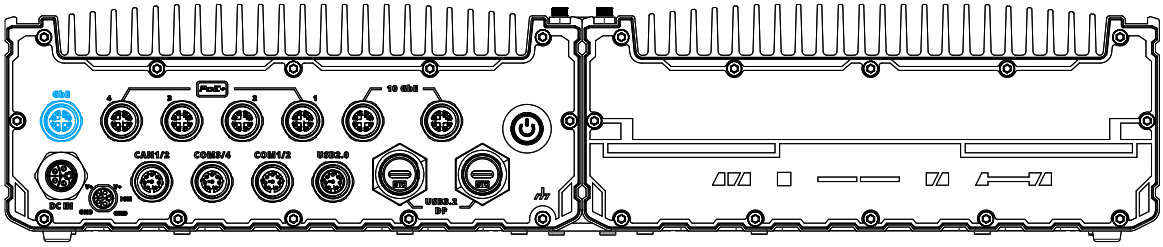
SEMIL-2048GC



SEMIL-2008

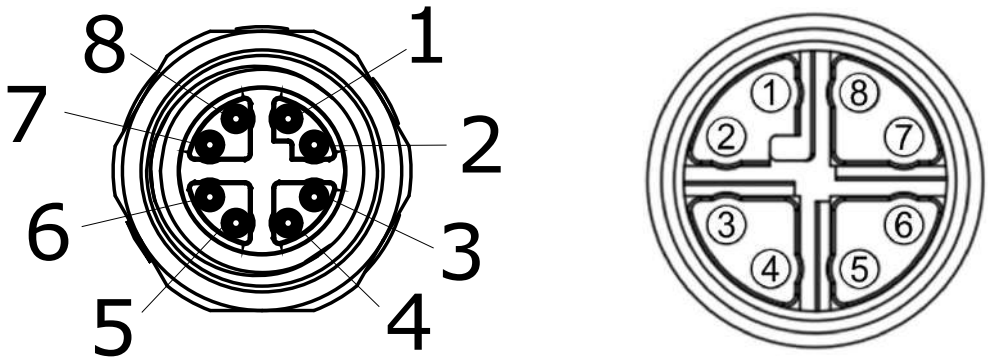
No.	Item	Description
1	GbE	M12 X-coded 1Gb Ethernet via Intel i219-LM
2	DC-in	8V to 48V or 9V to 36V DC input, with reverse polarity protection (M12 L-coded)
3	2.5GbE & PoE+	The M12 X-coded 2.5Gb Ethernet ports are backward compatible with 1GbE. The Power over Ethernet (PoE) connection provides both data connection and electric power to devices (eg. IP camera).
4	COM3/ 4	1x isolated 3-wire RS232 (COM3) & 1x RS-422/ 485 port (COM4)
5	CAN1/ 2	The CANbus 2.0 connectivity allows the system to communicate with other CAN devices
6	GbE	M12 X-coded 1Gb Ethernet via Intel i219-LM
7	USB 2.0	The M12 A-coded USB 2.0 port is backward-compatible with USB 1.1/ 1.0.
8	10GbE	The 10GbE is backwards compatible with 5Gb, 2.5Gb, and GbE connections.
9	Type-C USB or DisplayPort	Type-C USB 3.2 Gen1x1 (5Gbps) port, and supports alternative mode for DisplayPort
10	Power button	Use this button to turn on or force shutdown the system. This button can also be used to clear the system's CMOS.

2.5.1 Gb Ethernet



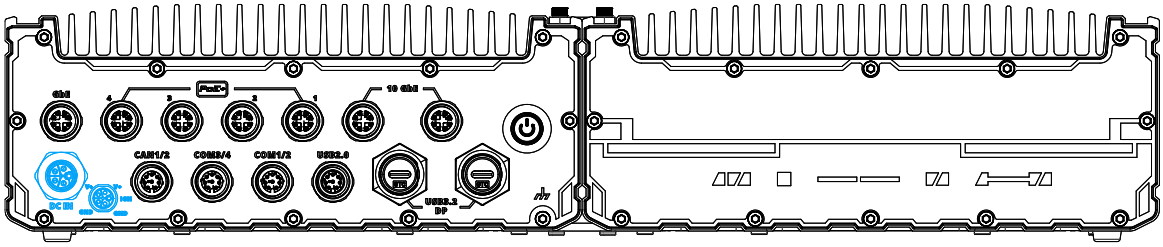
The system offers one Gb Ethernet port implemented Intel i219. It supports Wake on LAN and is also compatible with Intel® AMT (Active Management Technology) to support advanced features such as remote SOL desktop and remote on/ off control.

Pin Definition



Signal	Panel side	Cable connector end
DA+	1	1
DA-	2	2
DB+	3	3
DB-	4	4
DD+	5	5
DD-	6	6
DC-	7	7
DC+	8	8

2.5.2 DC-IN Connector

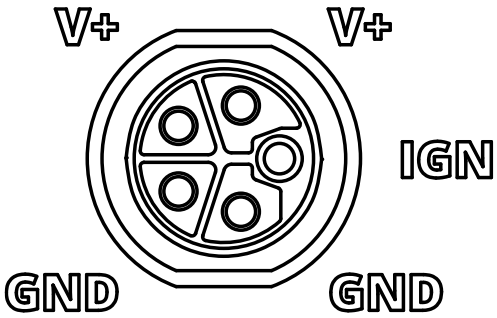


The system accepts a wide range of DC power input from 8V to 48V or 9V to 36V with reverse polarity protection via a M12 L-coded connector. The M12 L-coded connectors offer COTS availability and ultra-rugged connection reliability when wiring DC power.

WARNING

Please make sure the voltage of DC power is correct before you connect it to the system. Supplying a voltage over the maximum designated voltage (36V or 48V) will damage the system.

Connector Pin Definition

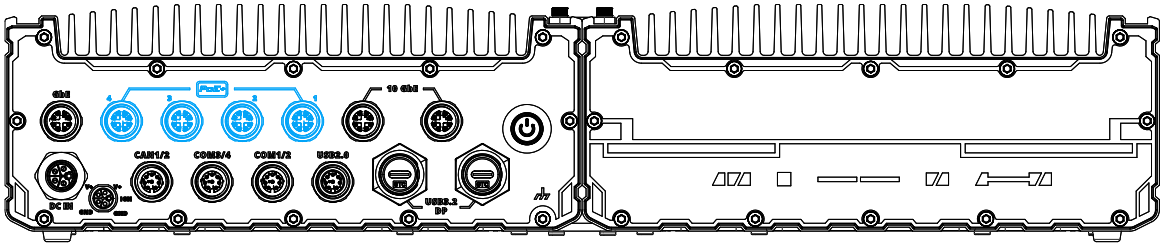


Signal	Wire color
V+	
V+	
GND	
GND	
IGN	

2.5.3 2.5 Gb Ethernet and PoE+ Port

NOTE

The PoE+ function is available on SEMIL-2008/ 2047GC/ 2048GC systems.

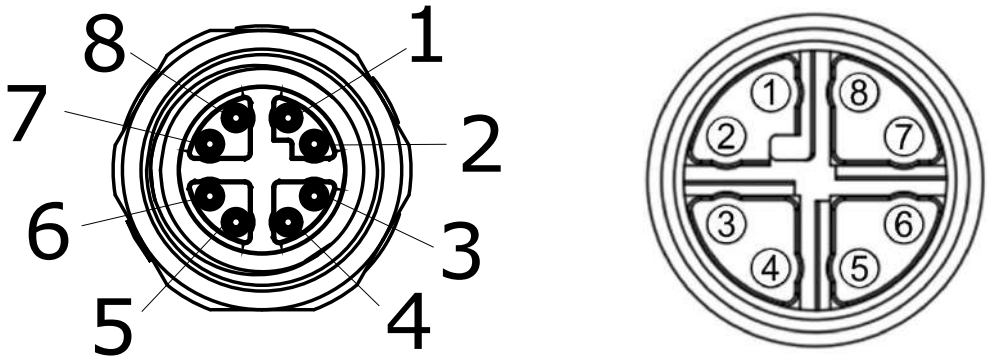


The system offers 2.5Gb Ethernet ports with PoE+ via M12 X-coded connectors on the front panel.

Power over Ethernet (PoE) supplies electrical power and data on a CAT-5/CAT-6 Ethernet cable. Acting as a PoE PSE (Power Sourcing Equipment), compliant with IEEE 802.3at, each PoE port delivers up to 25.5W to a Powered Device (PD). PoE can automatically detect and determine if the connected device requires power or not, so it is compatible with standard Ethernet devices as well.

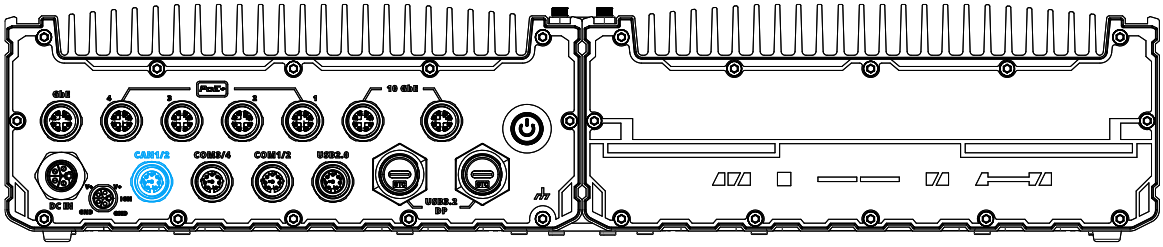
Each port has one dedicated PCI Express link for maximum network performance.

Connector Pin Definition

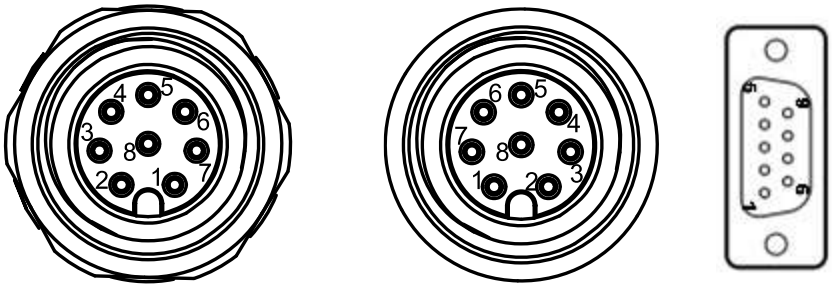


Signal	Panel side	Cable connector end
DA+	1	1
DA-	2	2
DB+	3	3
DB-	4	4
DD+	5	5
DD-	6	6
DC-	7	7
DC+	8	8

2.5.4 CAN bus Port 1/ 2

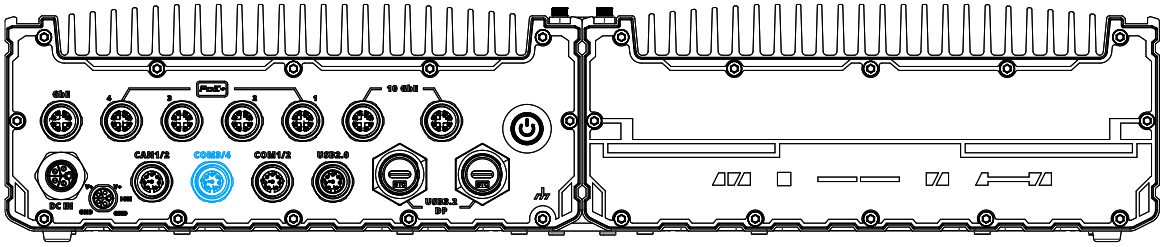


CAN bus is a robust industrial bus with a pair of differential signals and is commonly used in various industrial and in-vehicles applications. The CAN bus port supports CAN2.0A and CAN2.0B up to 1Mbps.



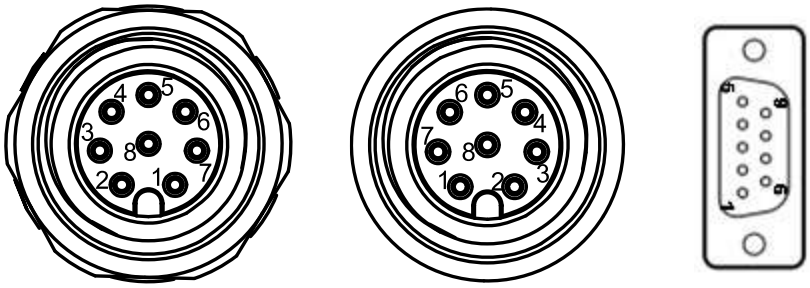
M12 Panel side		M12 Cable end	DB9 end	Signal
Signal	**M12 panel pin**	**M12 cable pin**	**COM pin**	
CAN_ISO1_H	1	1	3	CAN1
CAN_ISO1_L	2	2	2	
CAN_ISO_GND	3	3	5	
-	4	4	-	-
-	5	5	-	-
CAN_ISO2GND	6	6	5	CAN2
CAN_ISO2_L	7	7	2	
CAN_ISO2_H	8	8	3	

2.5.5 COM3/ COM4 Port



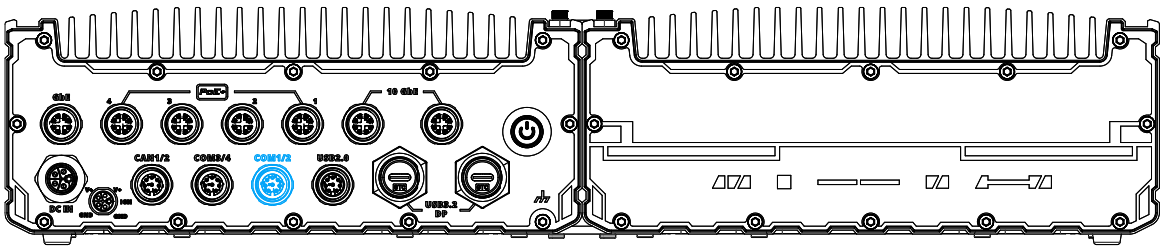
The system provides an isolated COM3 port (RS-232) and a COM4 port (RS-422/ 485) to communicate with external devices.

Connector Pin Definition



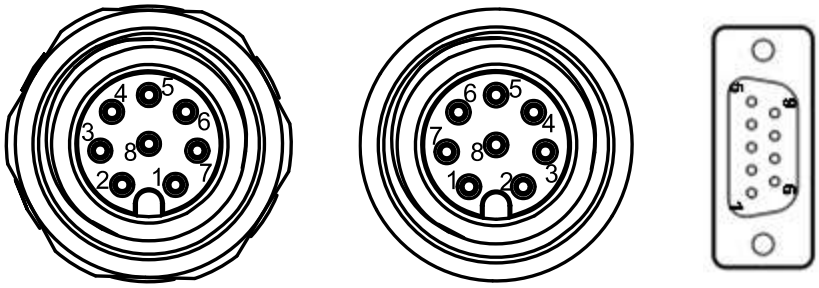
M12 Panel side		M12 Cable end	COM cable	Signal
Signal	**M12 panel pin**	**M12 cable pin**	**COM pin**	
RXD3	1	1	2	COM3
TXD3	6	6	3	
GND	7	7	5	
TXP4	2	2	2	COM4
TXN4	3	3	8	
RXP4	4	4	3	
RXN4	5	5	4	
GND	8	8	5	

2.5.6 COM1/ COM2 Port



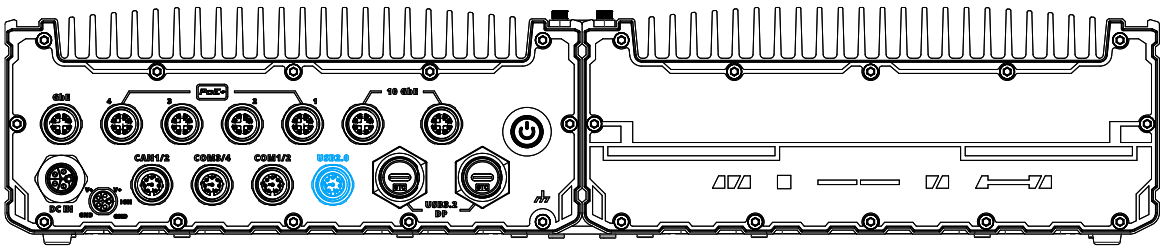
The system provides two isolated COM ports via an M12 A-coded connector for communicating with external devices. COM 1 and 2 ports are 3-wire RS-232 specifications and provide up to 115200 bps baud rate.

Connector Pin Definition



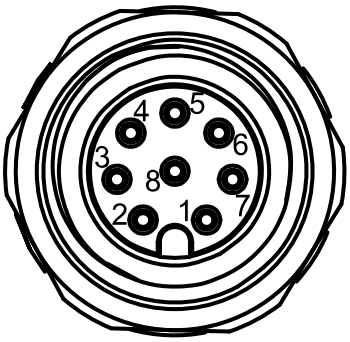
M12 Panel side		M12 Cable end	COM cable	Signal
Signal	**M12 panel pin**	**M12 cable pin**	**COM pin**	
TXD1	1	1	3	COM1
RXD1	2	2	2	
ISOGND1	3	3	5	
-	4	4	-	-
-	5	5	-	-
ISOGND2	6	6	5	COM2
RXD2	7	7	2	
TXD2	8	8	3	

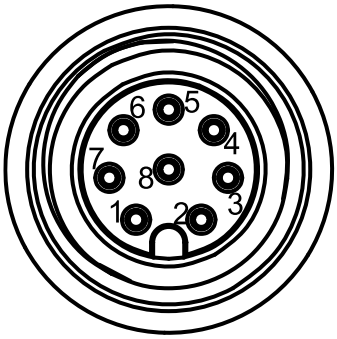
2.5.7 USB2.0 Port



The USB2.0 ports are implemented via native xHCI (eXtensible Host Controller Interface) controller and are backward compatible with USB 1.1 and USB 1.0 devices. Legacy USB support is also provided so you can use USB keyboard/mouse in DOS environment.

Connector Pin Definition

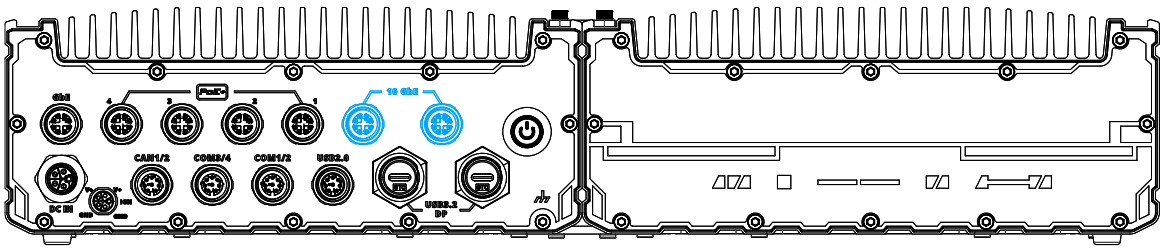




Panel side **Cable connector end**

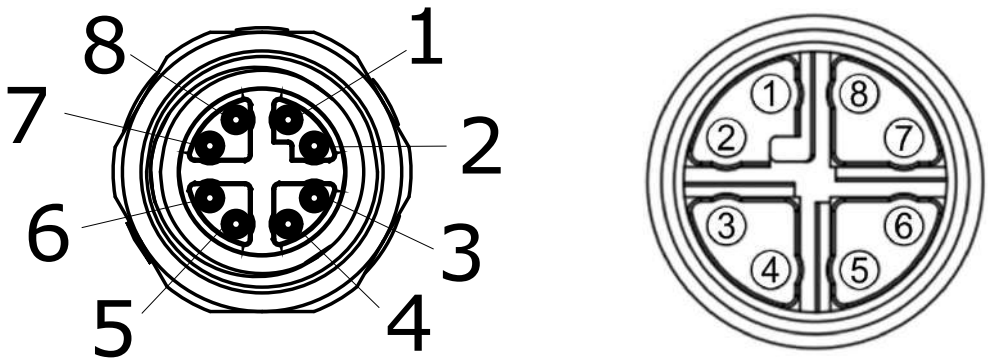
Signal	M12 panel side	M12 cable connector end	Wire color
D1+	1	1	
D1-	2	2	
VCC_USB	3	3	
GND	4	4	
GND	5	5	
VCC_USB	6	6	
D2-	7	7	
D2+	8	8	

2.5.8 10Gb Ethernet



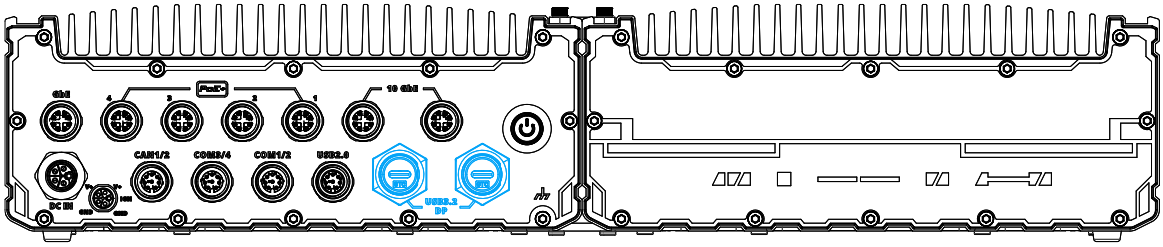
The two 10Gb Ethernet ports support Wake-on-LAN via M12 X-coded connector implemented using Intel® X550AT controller on the front panel. The port is backwards compatible with 5Gb, 2.5Gb, and Gb Ethernet connections.

Connector Pin Definition



Signal	Panel side	Cable connector end
DA+	1	1
DA-	2	2
DB+	3	3
DB-	4	4
DD+	5	5
DD-	6	6
DC-	7	7
DC+	8	8

2.5.9 Type-C USB 3.2 Gen 1 Ports/ DisplayPort



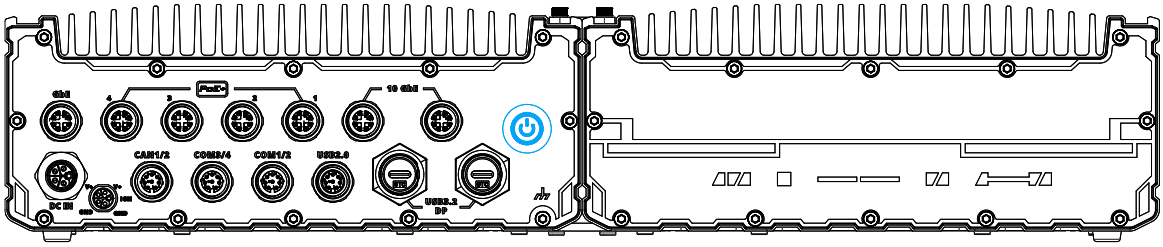
The system's USB 3.2 Gen1x1 type-C port offers up to 5Gbps of data transfer bandwidth, and is implemented via the native xHCI (eXtensible Host Controller Interface) controller. The port is backward compatible with USB3.2 Gen.1 USB 2.0, USB 1.1 and USB 1.0 devices via a USB hub (not included) to connect to external devices.

xHCI driver is supported natively in Windows 10, therefore you do not need to install the xHCI driver prior to utilizing USB functions.

The USB Type-C port can also be used alternatively for DisplayPort output to support resolutions up to 3840 x 2160 (4K).

Or by plugging in a USB Type-C hub, you may use USB and DisplayPort simultaneously.

2.5.10 Power Button



The power button is a non-latched switch for ATX mode on/off operation. To turn on the system, press the power button and the PWR LED should light-up. To turn off the system, issuing a shutdown command in OS is preferred, or you can simply press the power button. To force shutdown when the system freezes, press and hold the power button for 5 seconds. Please note that there is a 5-second interval between on/off operations (i.e. once the system is turned off, there is a 5-second wait before you can power-on the system).

To clear the system CMOS using the power button, please refer to the following instructions.

1. Unplug the DC power cable from the system.
2. With the cable unplugged, press and hold the power button.
3. With the power button held down, reconnect the DC power cable to the system.
4. Continue to press and hold down the button for a further 5 seconds after connecting the DC power cable.
5. Release the power button to complete the clear CMOS procedure.

2.6 Internal I/Os

WARNING

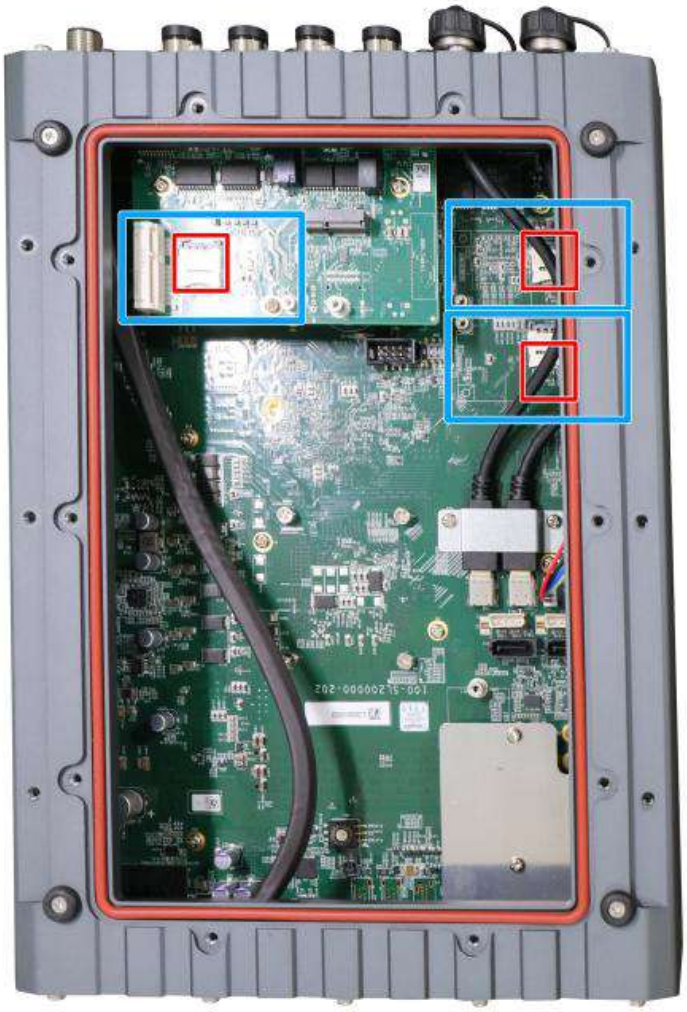
Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

In addition to connectors on the enclosure panel, the system also provides internal expansion slots such as for hard drives, mini-PCIe, and access to ignition control rotary switch.

2.6.1 mini-PCIe Expansion Slot

NOTE

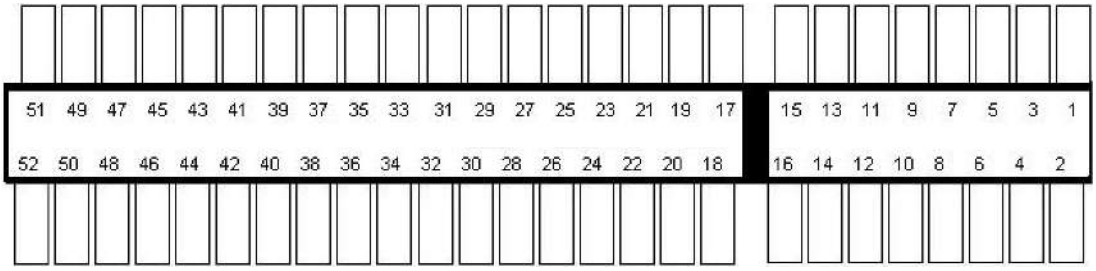
For demonstration purposes, only the compartment with accessible expansion modules will be shown.



The system has mini-PCIe sockets. There are plenty of off-the-shelf mini-PCIe modules with versatile capabilities. By installing a mini-PCIe module, your system can have expanded features such as 5G/4G, WIFI, GPS, CAN bus, analog frame grabber, etc.

If the module is installed after initial purchase, you may need to return the unit to Neousys Technology or an authorized SEMIL distributor for SMA antenna installation.

mini-PCIe slot definition

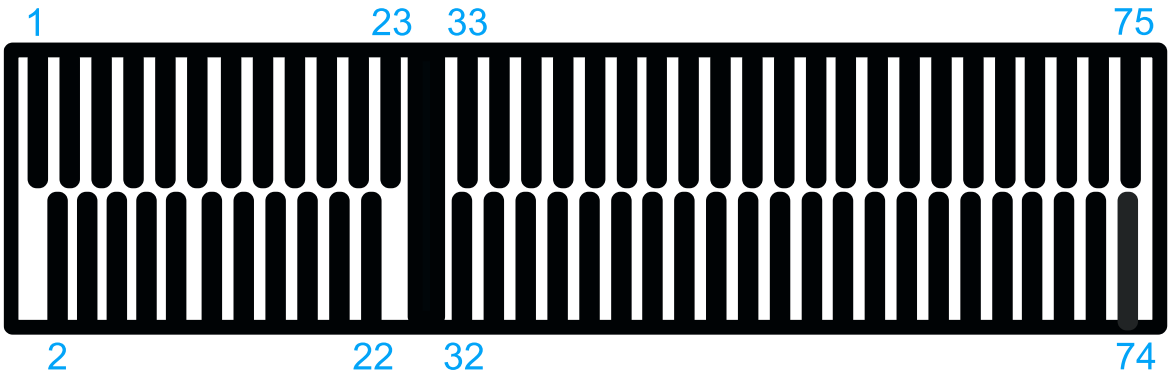


Pin #	Signal	Pin #	Signal
1	WAKE#	**2**	+3.3Vaux
3	COEX1	**4**	GND
5	COEX2	**6**	+1.5V
7	CLKREQ#	**8**	UIM_PWR
9	GND	**10**	UIM_DATA
11	REFCLK-	**12**	UIM_CLK
13	REFCLK+	**14**	UIM_RESET
15	GND	**16**	UIM_VPP
Mechanical Key			
17	Reserved* (UIM_C8)	**18**	GND
19	Reserved* (UIM_C4)	**20**	W_DISABLE#
21	GND	**22**	PERST#
23	PERn0	**24**	+3.3Vaux
25	PERp0	**26**	GND
27	GND	**28**	+1.5V
29	GND	**30**	SMB_CLK
31	PETn0	**32**	SMB_DATA
33	PETp0	**34**	GND
35	GND	**36**	USB_D-
37	GND	**38**	USB_D+
39	+3.3Vaux	**40**	GND
41	+3.3Vaux	**42**	LED_WWAN#
43	GND	**44**	LED_WLAN#
45	Reserved	**46**	LED_WPAN#
47	Reserved	**48**	+1.5V
49	Reserved	**50**	GND
51	Reserved	**52**	+3.3Vaux

2.6.2 M.2 2230 E Key Slot

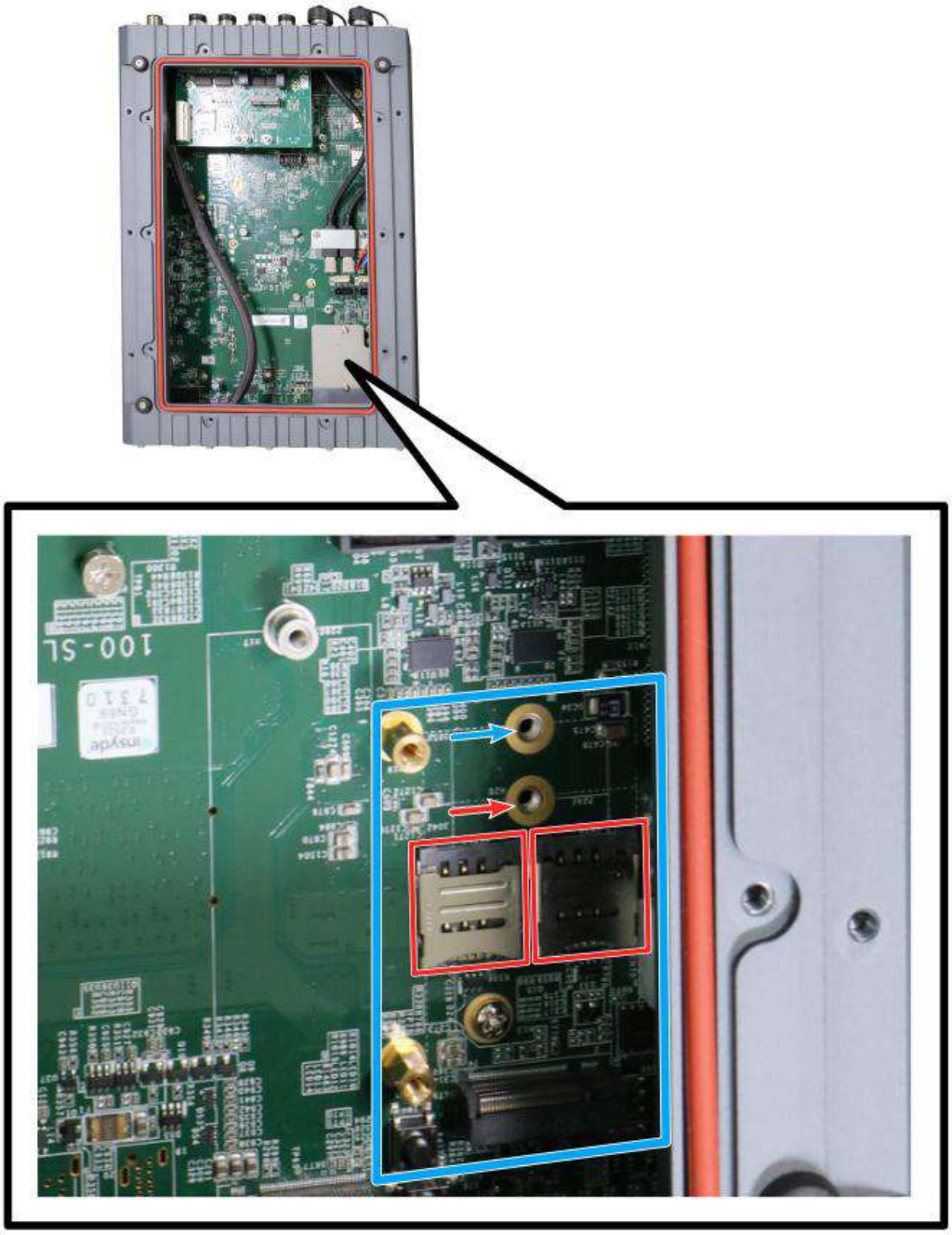
The system has an M.2 2230 E key socket that offers PCIe Gen3 x1 and USB2.0 signal for WiFi module installation.

M.2 2230 E Key Pin Definition



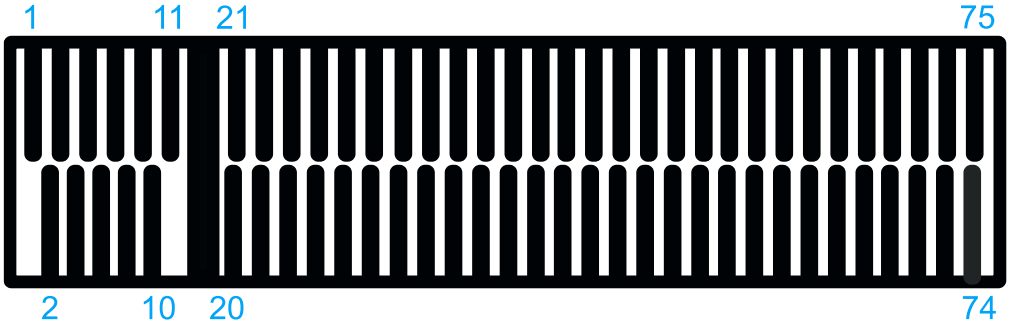
Pin #	Signal	Pin #	Signal
1	GND	**2**	+3V3
3	USB_D+	**4**	+3V3
5	USB_D-	**6**	
7	GND	**8**	
9		**10**	-
11		12	
13		**14**	
15		**16**	
17		**18**	GND
19		**20**	
21	-	**22**	-
23	-		
Mechanical Key			
33	GND	**32**	
35	PETP0	**34**	
37	PETN0	**36**	
39	GND	**38**	
41	PER P0	**40**	
43	PER N0	**42**	
45	GND	**44**	
47	REFCLK_P0	**46**	
49	REFCLK_N0	**48**	
51	GND	**50**	
53	CLKREQ#	**52**	PERST#
55		**54**	
57	GND	**56**	W_DISABLE#
59		**58**	
61		**60**	
63	GND	**62**	
65		**64**	
67		**66**	
69	GND	**68**	
71		**70**	
73		**72**	+3V3
75	GND	**74**	+3V3

2.6.3 M.2 2242/ 3052 B Key Slot



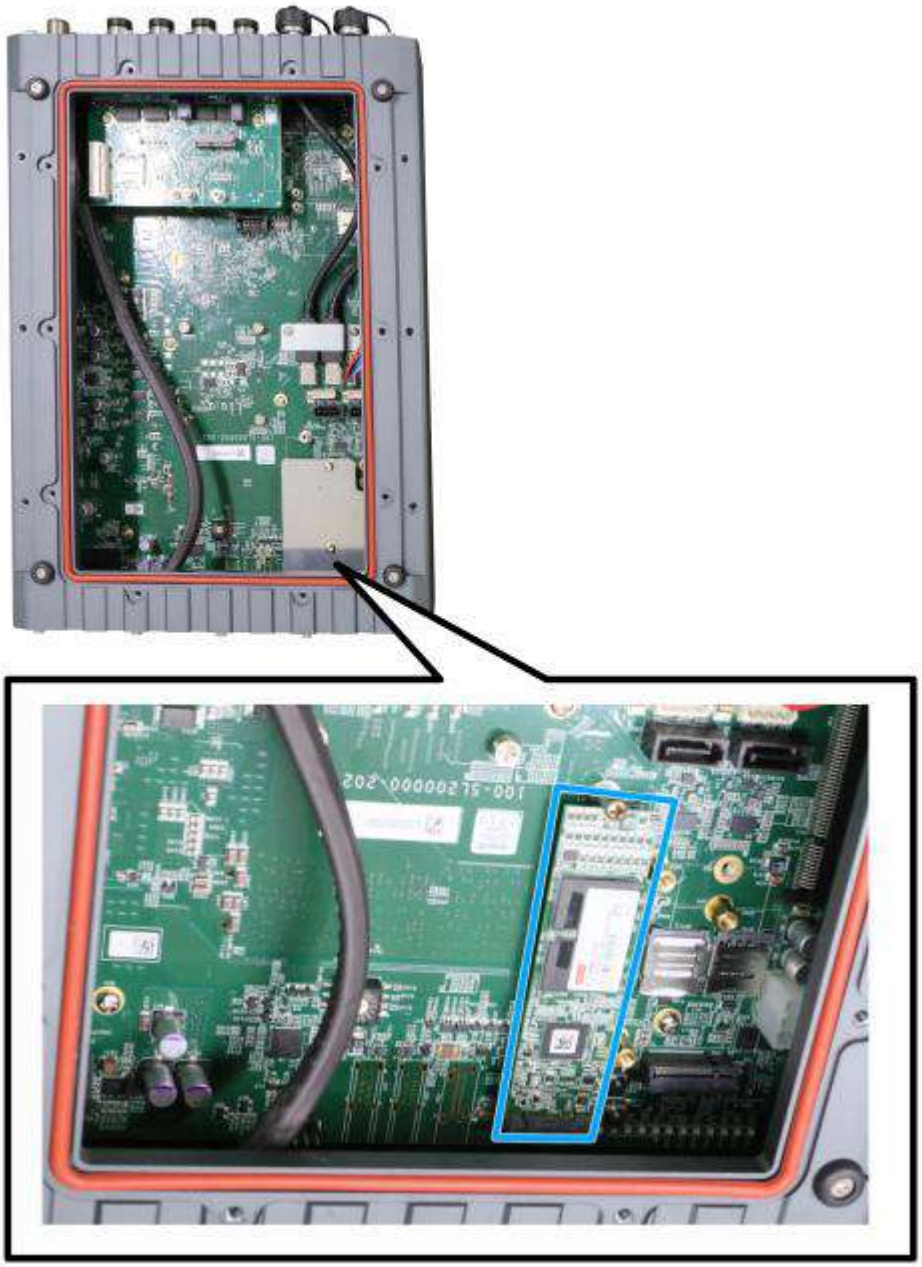
Underneath the heat-spreader, the system has an M.2 2242/ 3052 slot (indicated in **blue**) with 5G/ 4G SIM slots (indicated in **red**). A copper standoff is provided for you to secure onto the motherboard into the **red arrow** location for an M.2 2242 module, or into the **blue arrow** location for an M.2 3052 module. By installing a 5G or 4G M.2 module and SIM card, you can access the internet via the provider's network.

M.2 (B Key) Slot Pin Definition



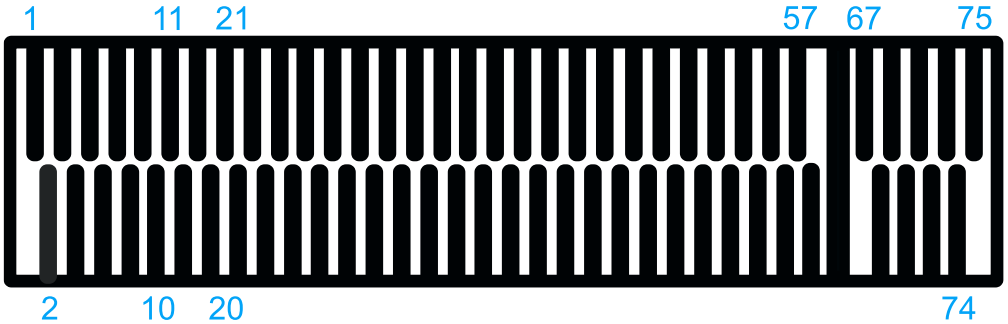
Pin #	Signal	Pin #	Signal
1	-	2	+3V3
3	GND	4	+3V3
5	GND	6	FULL_CARD_POWER_OFF_N
7	USB_D+	8	W_DISABLE_N
9	USB_D-	10	-
11	GND		
Mechanical Key			
21	-	20	-
23	-	22	-
25	-	24	-
27	GND	26	-
29	USB3.0-RX-	28	-
31	USB3.0-RX+	30	UIM1-RESET
33	GND	32	UIM1-CLK
35	USB3.0-TX-	34	UIM1-DATA
37	USB3.0-TX+	36	UIM1-PWR
39	GND	38	-
41	PERn0 / SATA-B+	40	UIM2-DET
43	PERp0 / SATA-B-	42	UIM2-DATA
45	GND	44	UIM2-CLK
47	PETn0 / SATA-A-	46	UIM2-RST
49	PETp0 / SATA-A+	48	UIM2-PWR
51	GND	50	PERST_N
53	REFCLKN	52	-
55	REFCLKP	54	-
57	GND	56	-
59	-	58	-
61	-	60	-
63	-	62	-
65	-	64	-
67	RESET_N	66	UIM1_DETECT
69	CONFIG_1	68	-
71	GND	70	+3V3
73	GND	72	+3V3
75	-	74	+3V3

2.6.4 M.2 2280 M Key Slot (PCIe Gen4 x4) for NVMe SSD



Underneath the heat-spreader, the system has a Gen4 x4 PCIe M.2 2280 slot for you to install an NVMe SSD. The M.2 NVMe SSD offers significantly better system performances when compared to a 2.5” SSD.

M.2 (M Key) Slot Pin Definition



Pin #	Signal	Pin #	Signal
1	GND	2	+3V3
3	GND	4	+3V3
5	PERN3	6	-
7	PERP3	8	-
9	GND	10	DAS/DSS_N
11	PETN3	12	+3V3
13	PETP3	14	+3V3
15	GND	16	+3V3
17	PERN2	18	+3V3
19	PERP2	20	-
21	GND	22	-
23	PETN2	24	-
25	PETP2	26	-
27	GND	28	-
29	PERN1	30	-
31	PERP1	32	-
33	GND	34	-
35	PETN1	36	-
37	PETP1	38	-
39	GND	40	-
41	PERn0	42	-
43	PERp0	44	-
45	GND	46	-
47	PETn0	48	-
49	PETp0	50	PERST_N
51	GND	52	-
53	REFCLKN	54	-
55	REFCLKP	56	-
57	GND	58	-
Mechanical Key			
67	-	68	SUSCLK
69	PEDET	70	+3V3
71	GND	72	+3V3
73	GND	74	+3V3
75	GND		

3 System Installation

Before disassembling the system enclosure and installing components and modules, please make sure you have done the following:

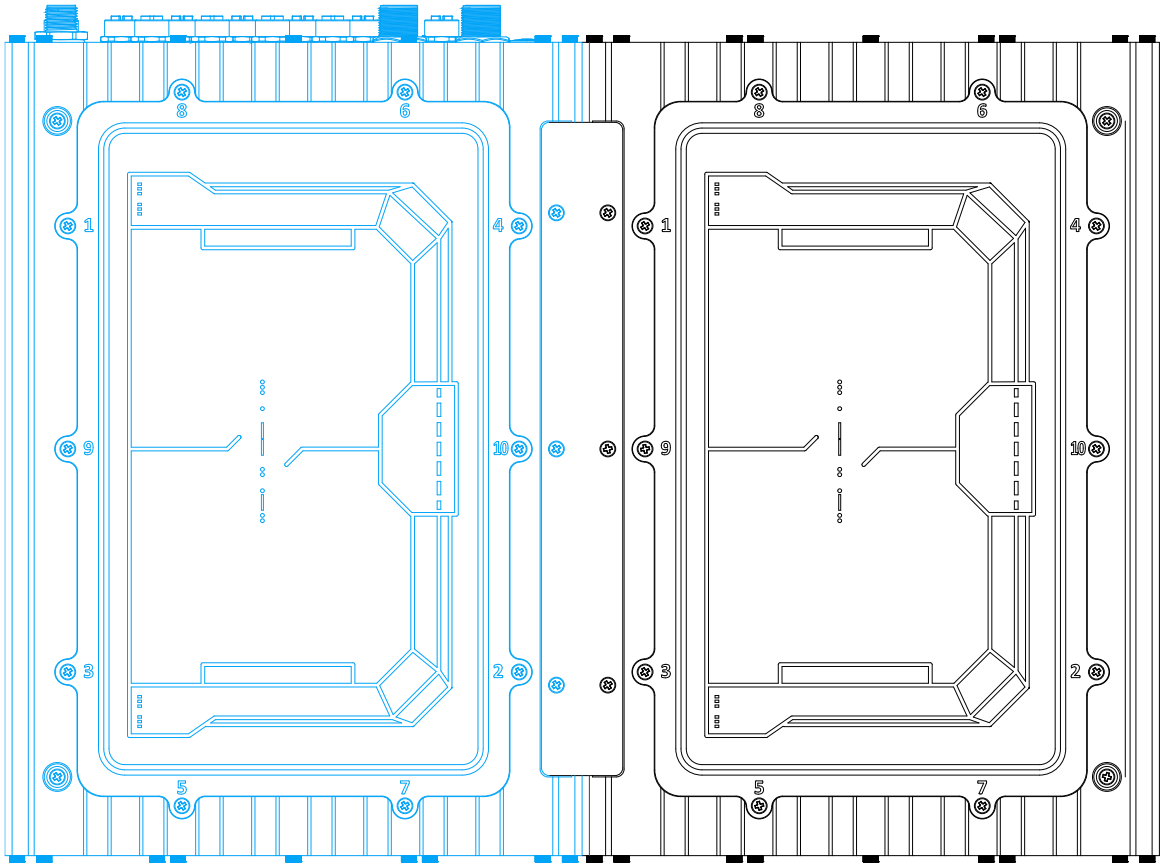
- It is recommended that only qualified service personnel should install and service this product to avoid injury or damage to the system.
- Please observe all ESD procedures at all times to avoid damaging the equipment.
- Before disassembling your system, please make sure the system has powered off, all cables and antenna (power, video, data, etc.) are disconnected.
- Place the system on a flat and sturdy surface (remove from mounts or out of server cabinets) before proceeding with the installation/ replacement procedure.

3.1 Accessing the System

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

For demonstration purposes, illustrations will only show the accessible section (highlighted in **blue**) of the system for a clearer installation view.



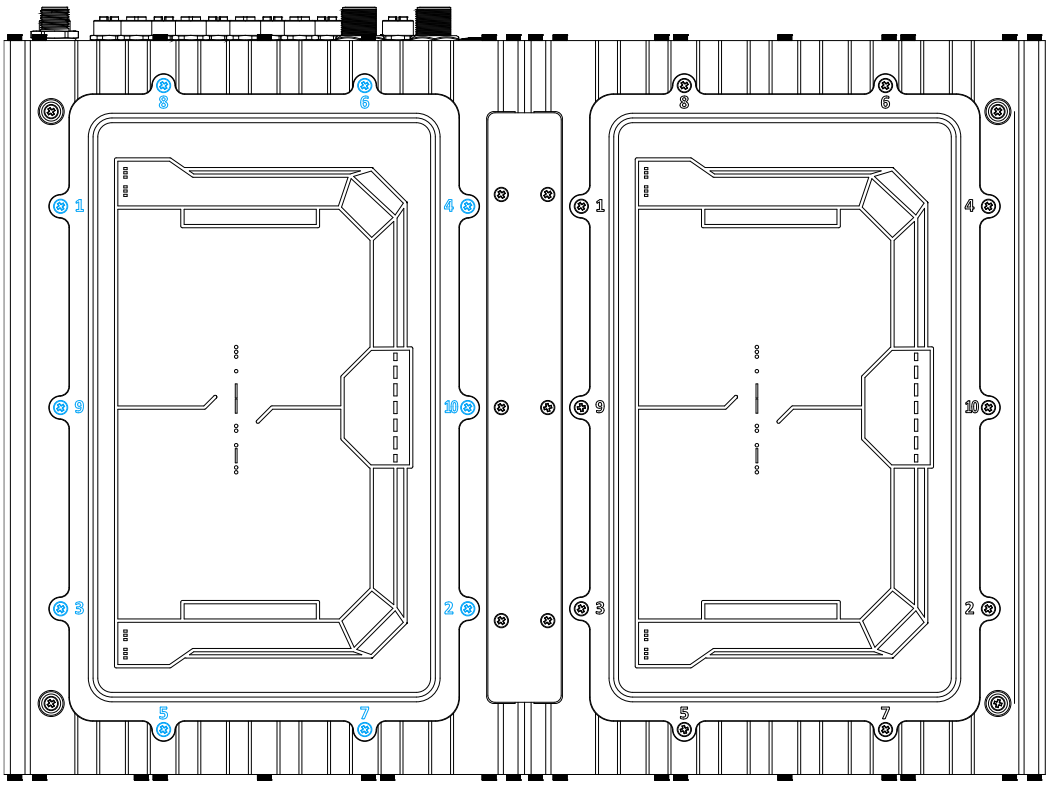
3.2 Mini-PCIe Module Installation

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

To install mini-PCIe modules into the system, please refer to the following instructions:

1. Disconnect all cable connections and shut down the system.
2. Turn the system upside-down and place it on a flat sturdy surface.
3. Unscrew the screws indicated in **blue**, in descending order.



4. Gently lift the panel and you will see the internal components.

5. If hard drives are installed, disconnect the SATA/ power connector. Pull using the connector body, **DO NOT** pull on the cable!

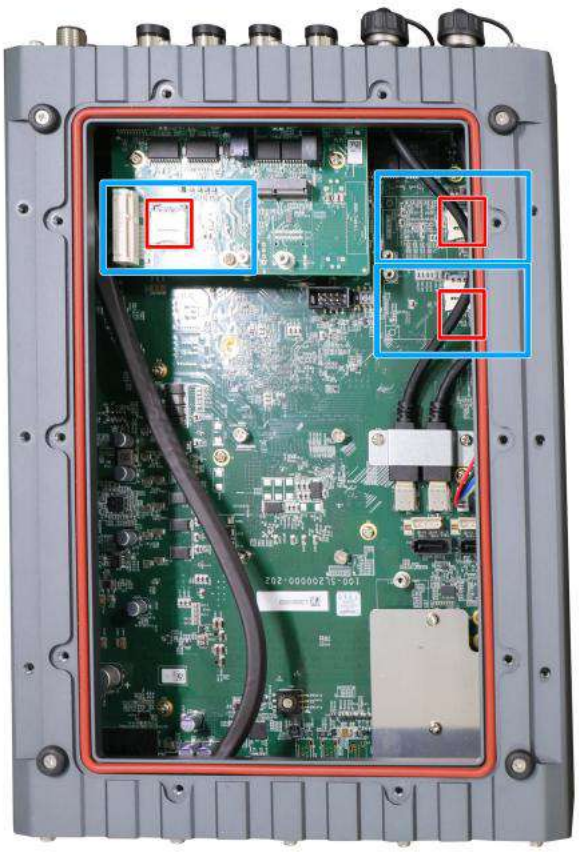
SEMIL-2007/ 2008/ 2047GC/ 2048GC

Filter board in SEMIL-2207/ 2247GC

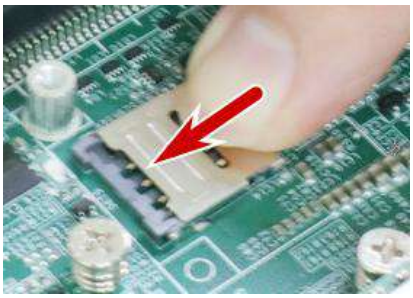
NOTE

*For systems with filter board, **DO NOT** disconnect the cables, and set the panel on the side.*

6. Identify the locations of the mini-PCIe slots and their respective SIM slots.



7. If you are installing 5G/ 4G mini-PCIe modules, please install the respective SIM cards first.



Release the SIM holder

Flip-open the holder and place SIM

Secure the SIM card

8. To install mini-PCIe module, simply insert the module into the slot on a 45 degree angle, press down and secure with a screw.

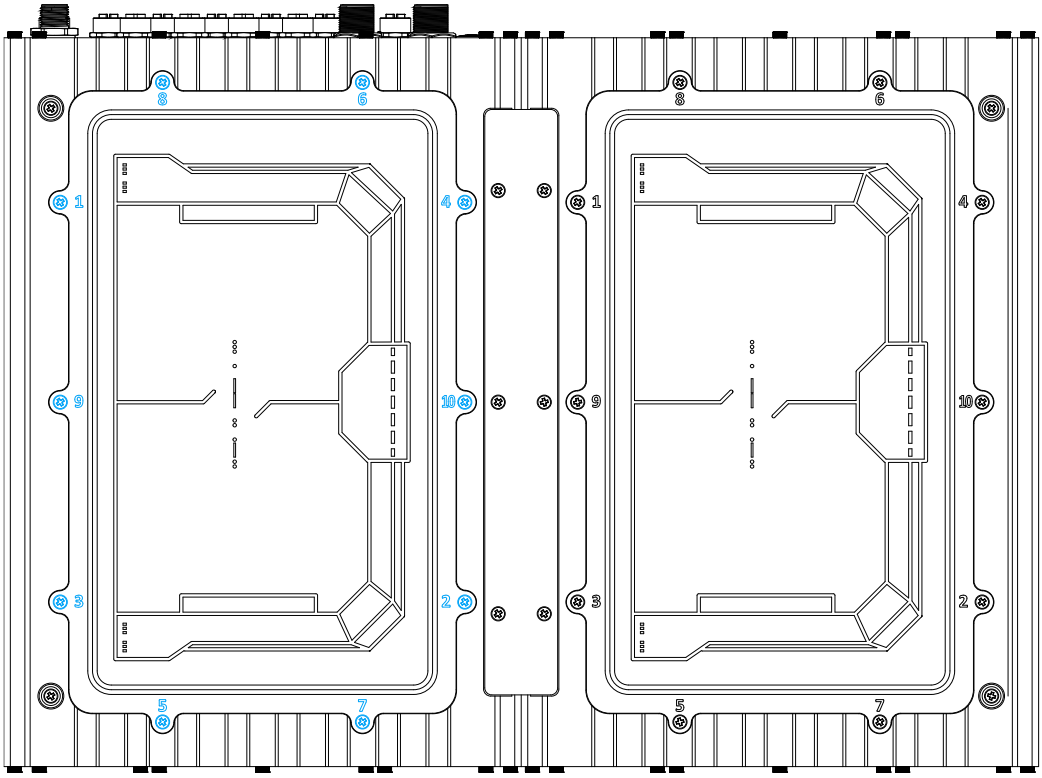
Insert into slot on a 45 degree angle

Secure the module with a screw

9. Refer to the module's manual and connect the antenna.

10. To install an SMA antenna, you may have to return the unit to an authorized Neousys Technology SEMIL distributor to properly install and retain waterproof capability.
11. Make sure the O-ring is properly seated in the groove, gently tug all cables back into the enclosure and place the bottom panel back on.

12. Secure the indicated screws at a torque range of 8.1 – 9.9kgf-cm in ascending order to complete the installation procedure.



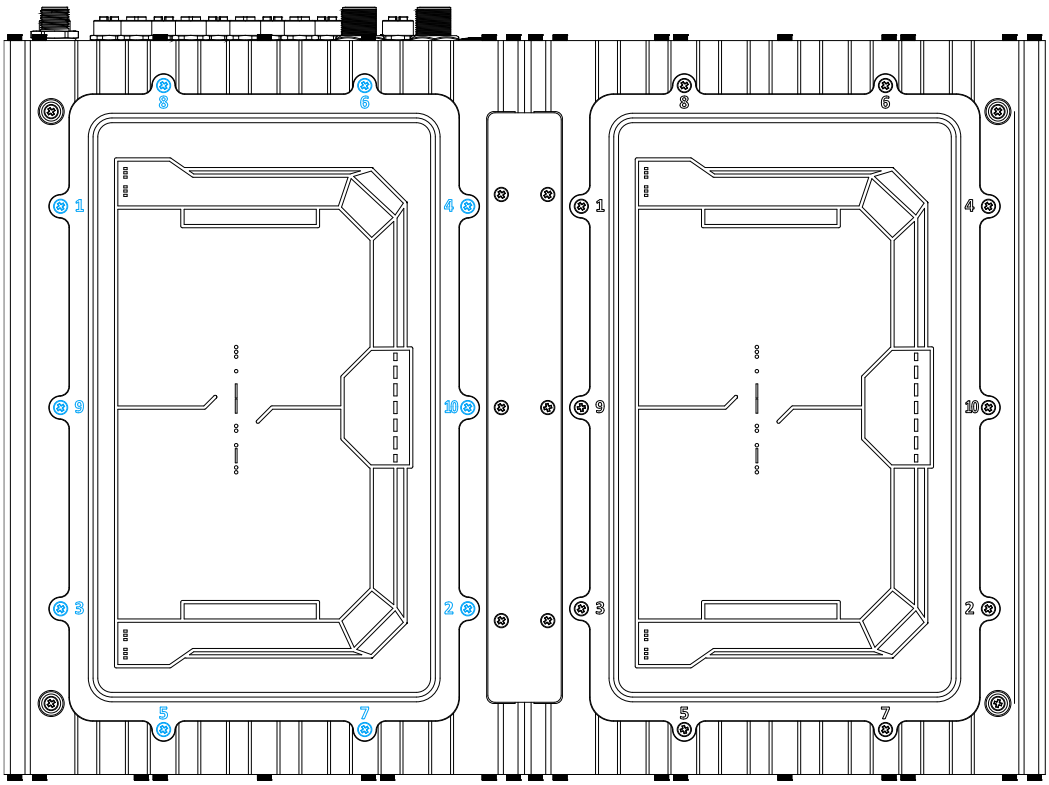
3.3 M.2 2280 M Key for NVMe SSD Installation

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

To install the module into the system, please refer to the following instructions:

1. Disconnect all cable connections and shut down the system.
2. Turn the system upside-down and place it on a flat sturdy surface.
3. Unscrew the screws indicated in **blue**, in descending order.



4. Gently lift the panel and you will see the internal components.

5. If hard drives are installed, disconnect the SATA/ power connector. Pull using the connector body, **DO NOT** pull on the cable!

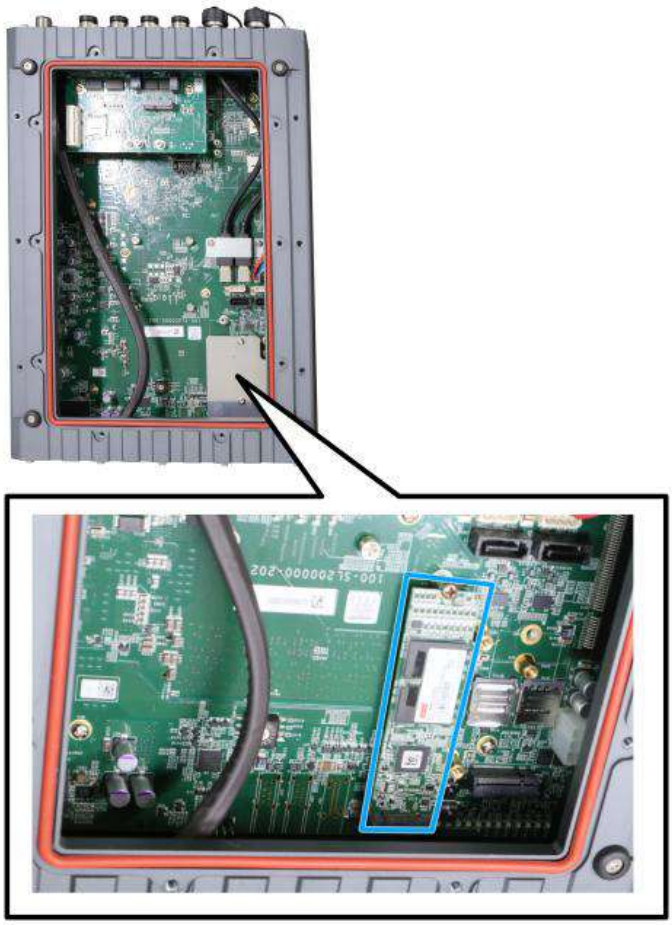
SEMIL-2007/ 2008/ 2047GC/ 2048GC

Filter board in SEMIL-2207/ 2247GC

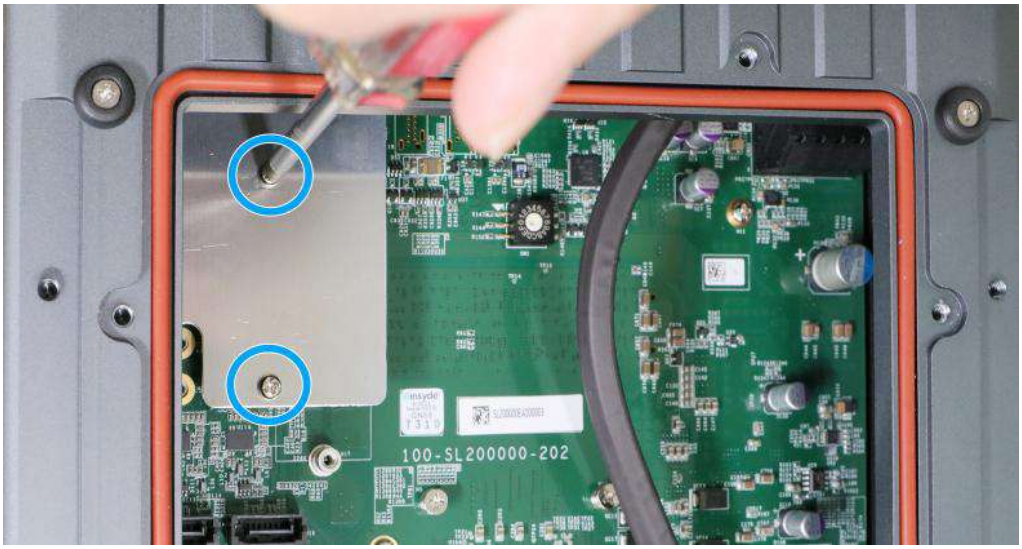
NOTE

*For systems with filter board, **DO NOT** disconnect the cables, and set the panel on the side.*

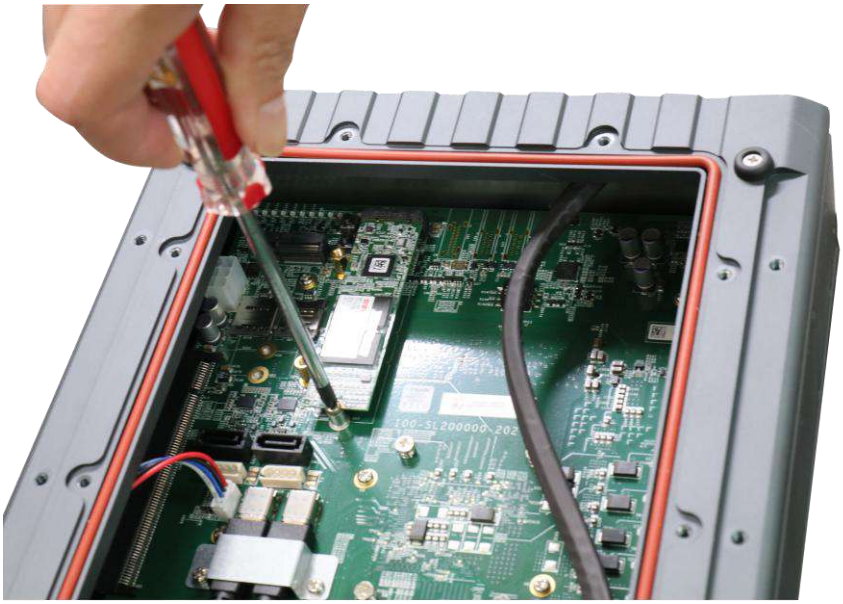
6. Identify the location of the M.2 slot (indicated in **blue**) underneath the heat-spreader.



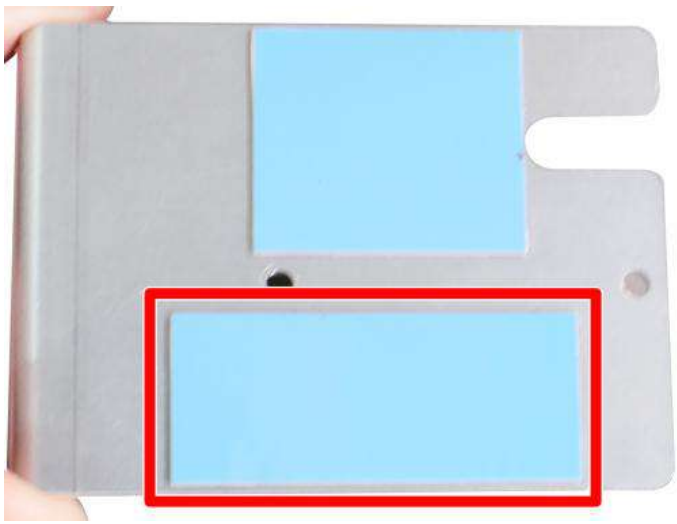
7. To install module, remove the heat-spreader by removing the screws indicated.



8. Insert the module on a 45 degree angle, press down and secure with a screw.



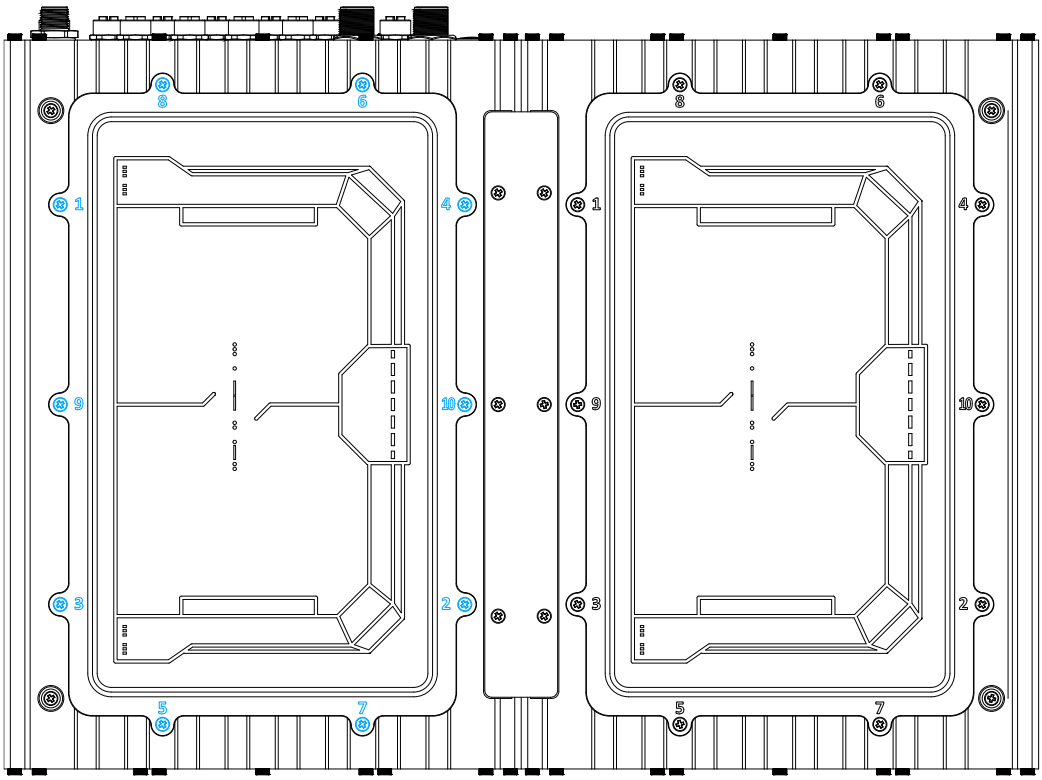
9. Remove the protection film on the thermal pad if you are installing the module for the first time.



10. Reinstall the heat-spreader.

11. Make sure the O-ring is properly seated in the groove, gently tug all cables back into the enclosure and place the bottom panel back on.

12. Secure the indicated screws at a torque range of 8.1 – 9.9kgf-cm in ascending order to complete the installation procedure.



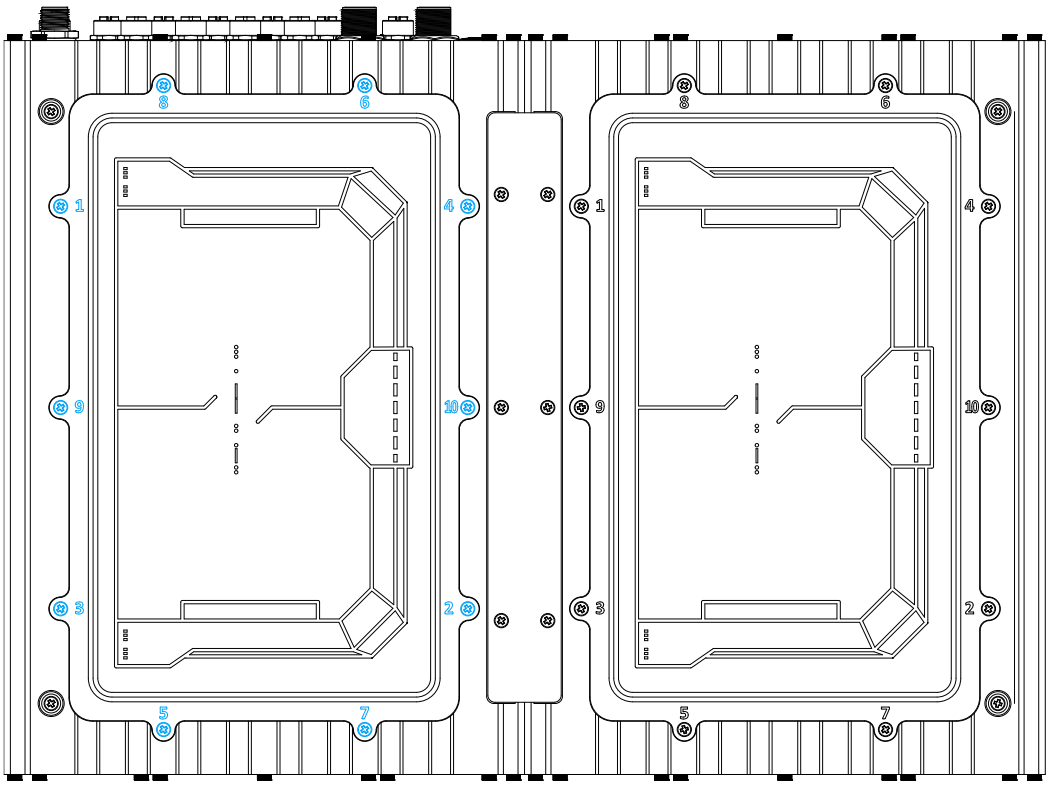
3.4 M.2 2242/ 3052 B Key Module Installation

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

To install the module into the system, please refer to the following instructions:

1. Disconnect all cable connections and shut down the system.
2. Turn the system upside-down and place it on a flat sturdy surface.
3. Unscrew the screws indicated in **blue**, in descending order.



4. Gently lift the panel and you will see the internal components.

5. If hard drives are installed, disconnect the SATA/ power connector. Pull using the connector body, **DO NOT** pull on the cable!

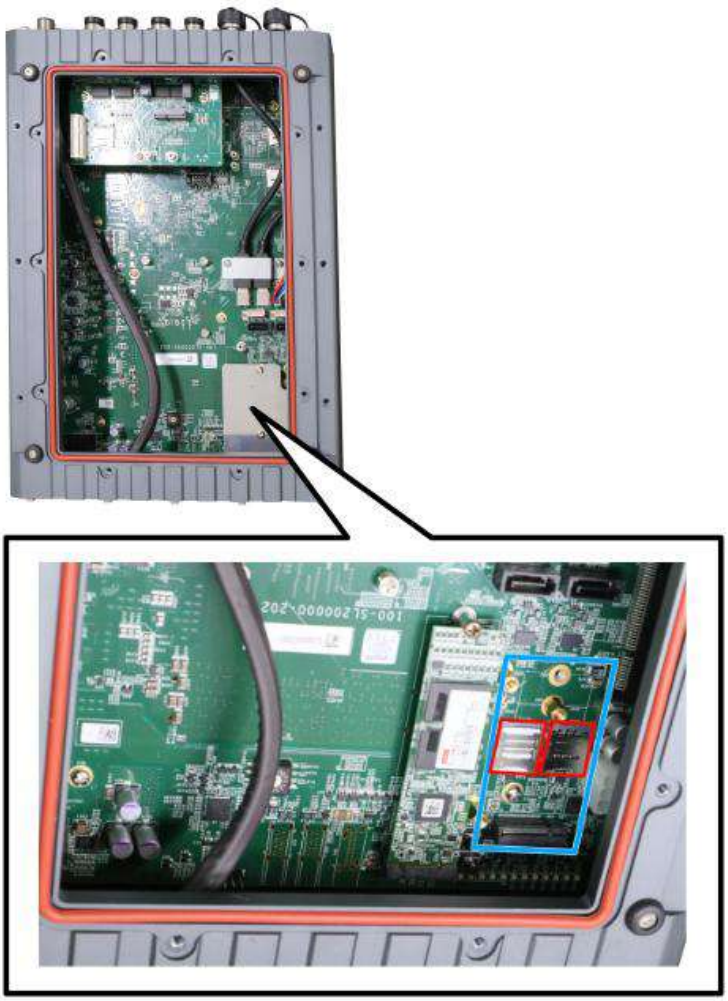
SEMIL-2007/ 2008/ 2047GC/ 2048GC

Filter board in SEMIL-2207/ 2247GC

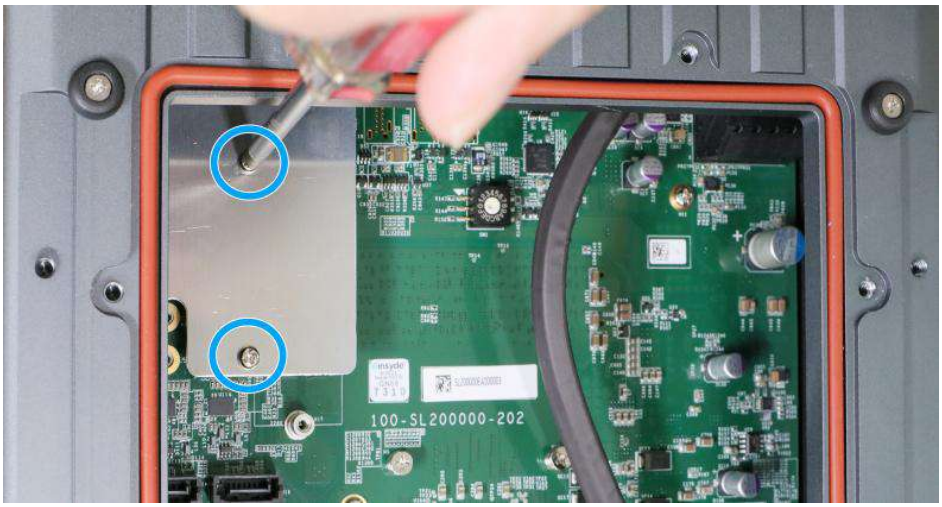
NOTE

*For systems with filter board, **DO NOT** disconnect the cables, and set the panel on the side.*

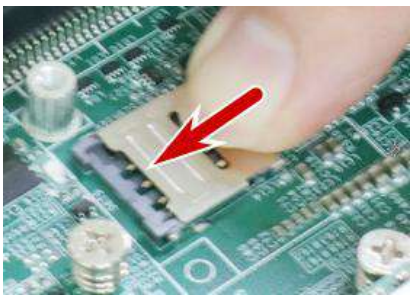
6. Identify the location of the M.2 2242/ 3052 slot (indicated in **blue**) and SIM slots (indicated in **red**) underneath the heat-spreader.



7. To install module, remove the heat-spreader by removing the screws indicated.



8. If you are installing 5G/ 4G mini-PCIe modules, please install the respective SIM cards first.

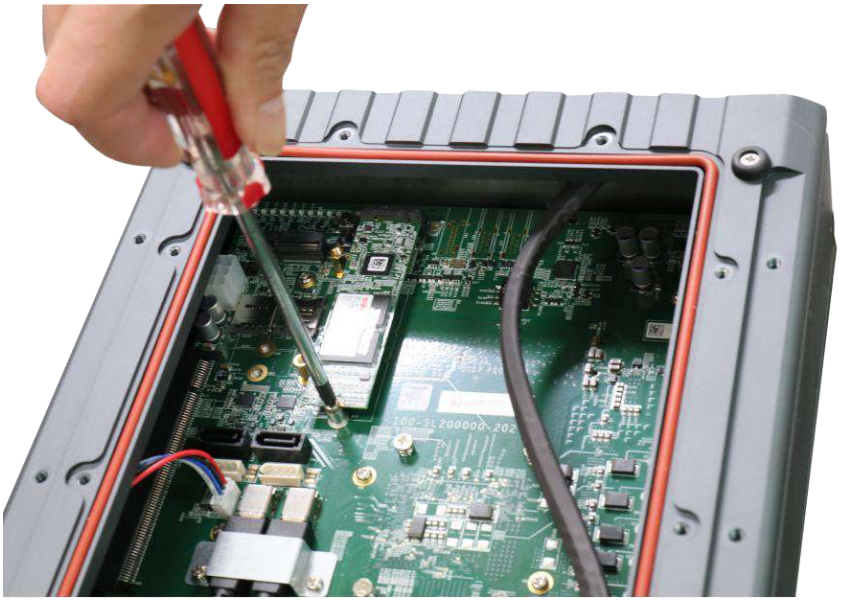


Release the SIM holder

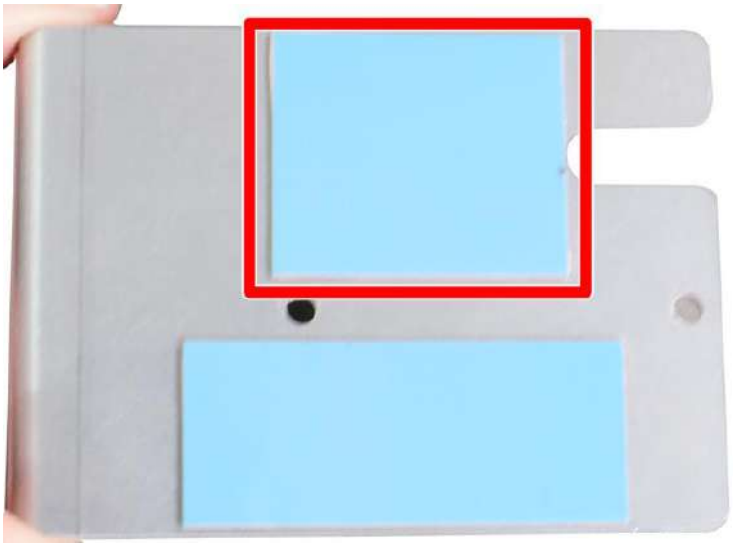
Flip-open the holder and place SIM

Secure the SIM card

9. Insert the module on a 45 degree angle, press down and secure with a screw.



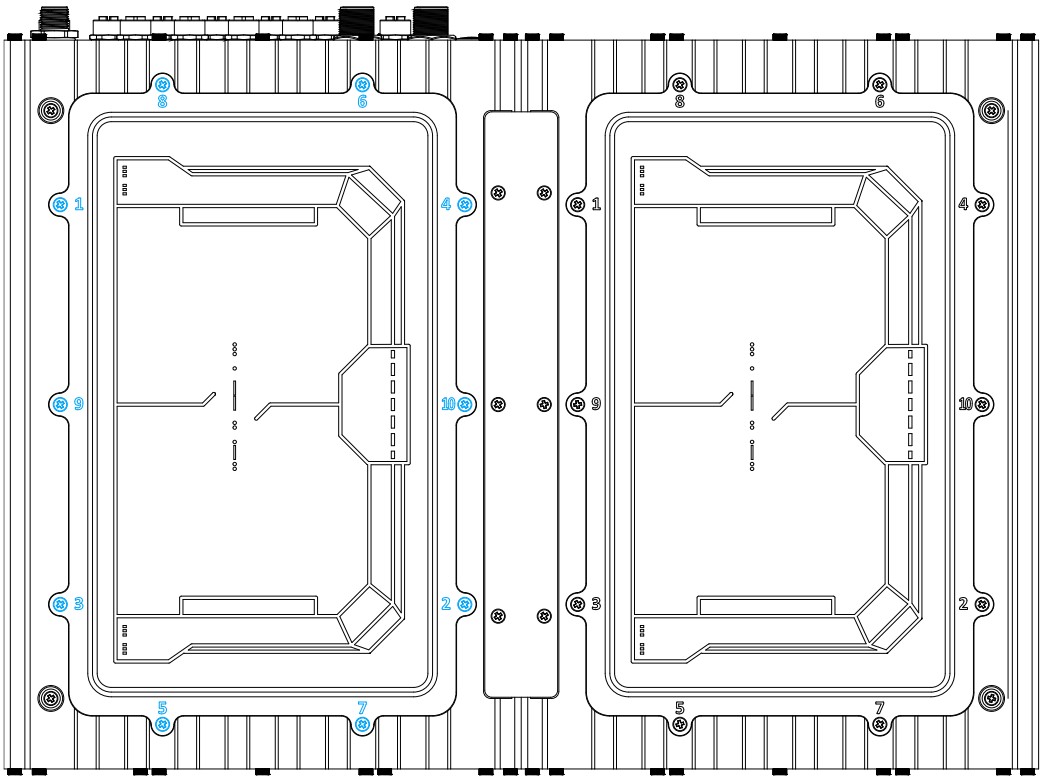
10. Remove the protector film on the heat-spreader if you are installing the module for the first time.



11. Reinstall the heat-spreader.

12. Make sure the O-ring is properly seated in the groove, gently tug all cables back into the enclosure and place the bottom panel back on.

13. Secure the indicated screws at a torque range of 8.1 – 9.9kgf-cm in ascending order to complete the installation procedure.



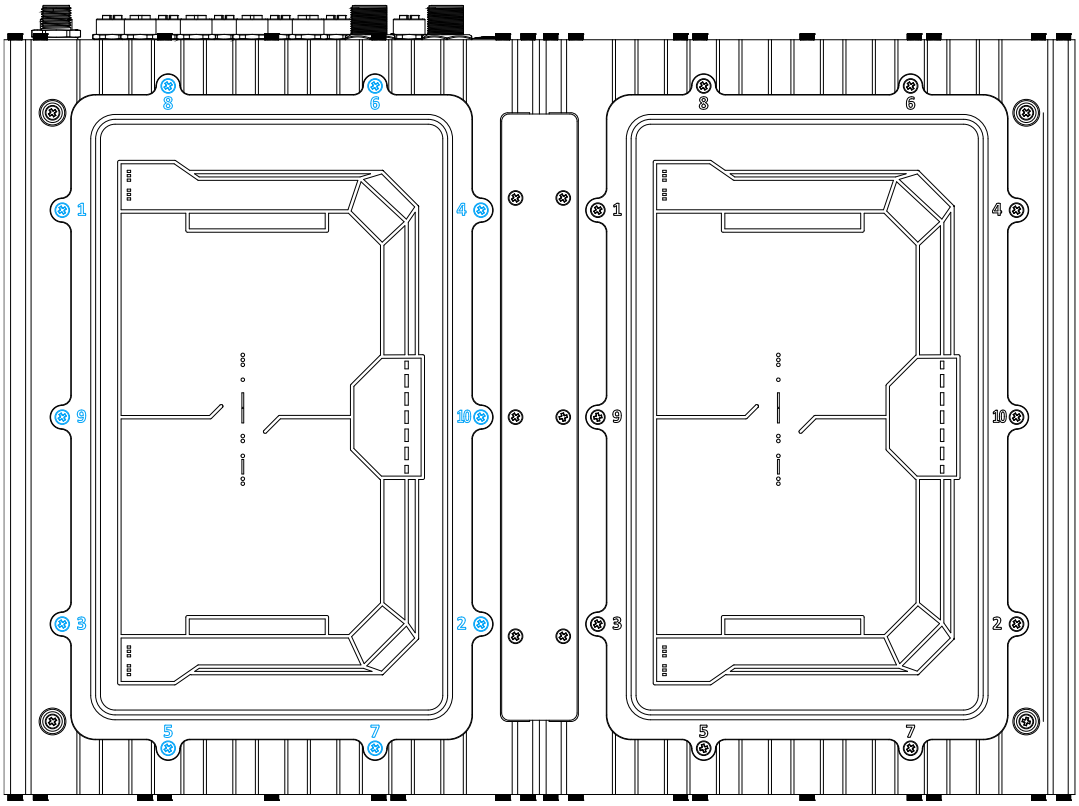
3.5 M.2 2230 E Key Module Installation

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

To install the module into the system, please refer to the following instructions:

1. Disconnect all cable connections and shut down the system.
2. Turn the system upside-down and place it on a flat sturdy surface.
3. Unscrew the screws indicated in **blue**, in descending order.



4. Gently lift the panel and you will see the internal components.

5. If hard drives are installed, disconnect the SATA/ power connector. Pull using the connector body, **DO NOT** pull on the cable!

SEMIL-2007/ 2008/ 2047GC/ 2048GC

Filter board in SEMIL-2207/ 2247GC

NOTE

*For systems with filter board, **DO NOT** disconnect the cables, and set the panel on the side.*

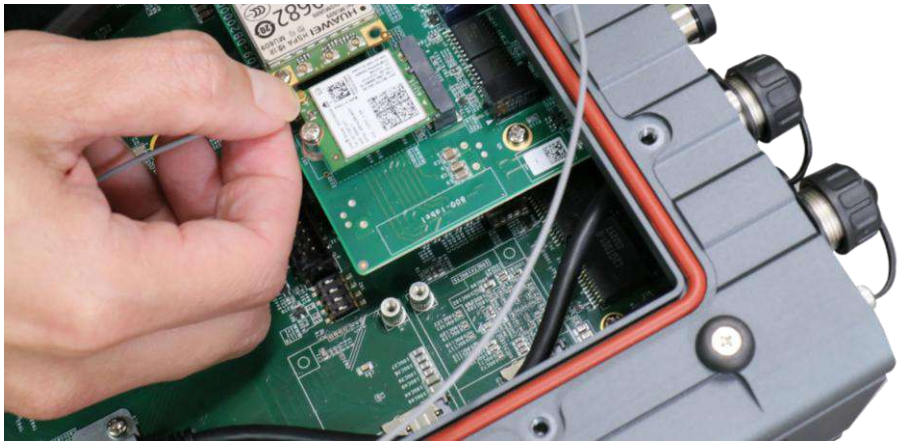
6. Identify the location of the M.2 2230 slot (indicated in **blue**).

7. Insert the module on a 45 degree angle, press down and secure with a screw.

Insert on a 45 degree angle

Secure with a screw

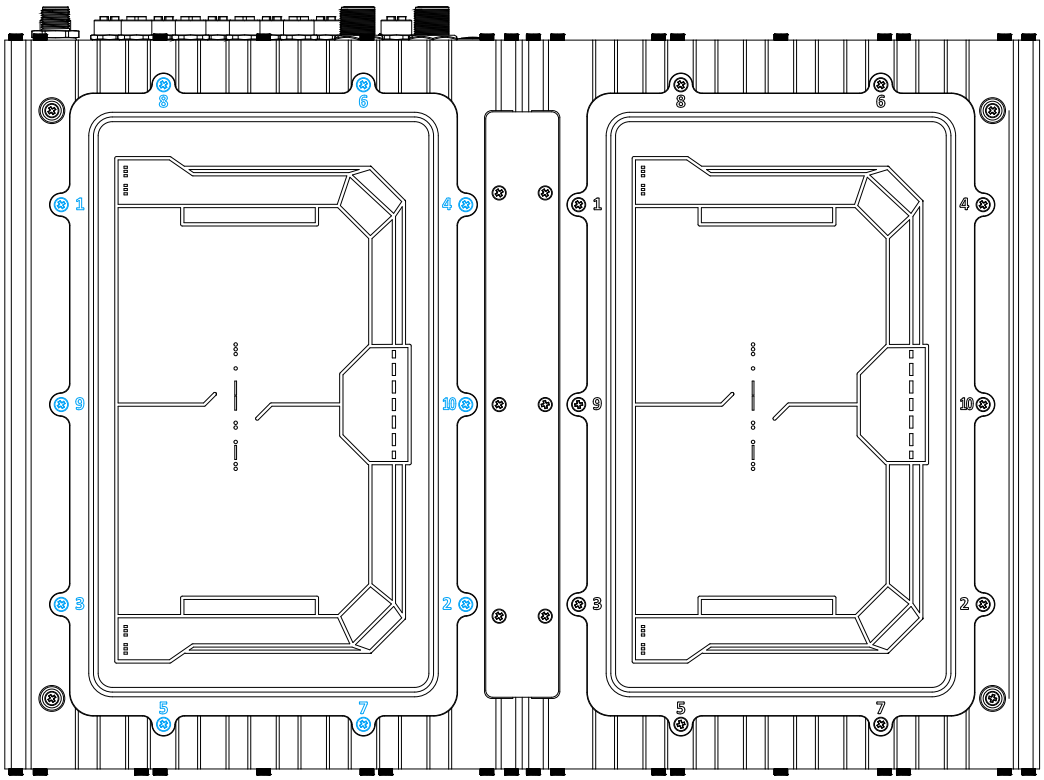
8. Refer to the module's user manual and connect the antenna.



9. To install an SMA antenna, you may have to return the unit to an authorized Neousys Technology SEMIL distributor to properly install and retain waterproof capability.

10. Make sure the O-ring is properly seated in the groove, gently tug all cables back into the enclosure and place the bottom panel back on.

11. Secure the indicated screws at a torque range of 8.1 – 9.9kgf-cm in ascending order to complete the installation procedure.



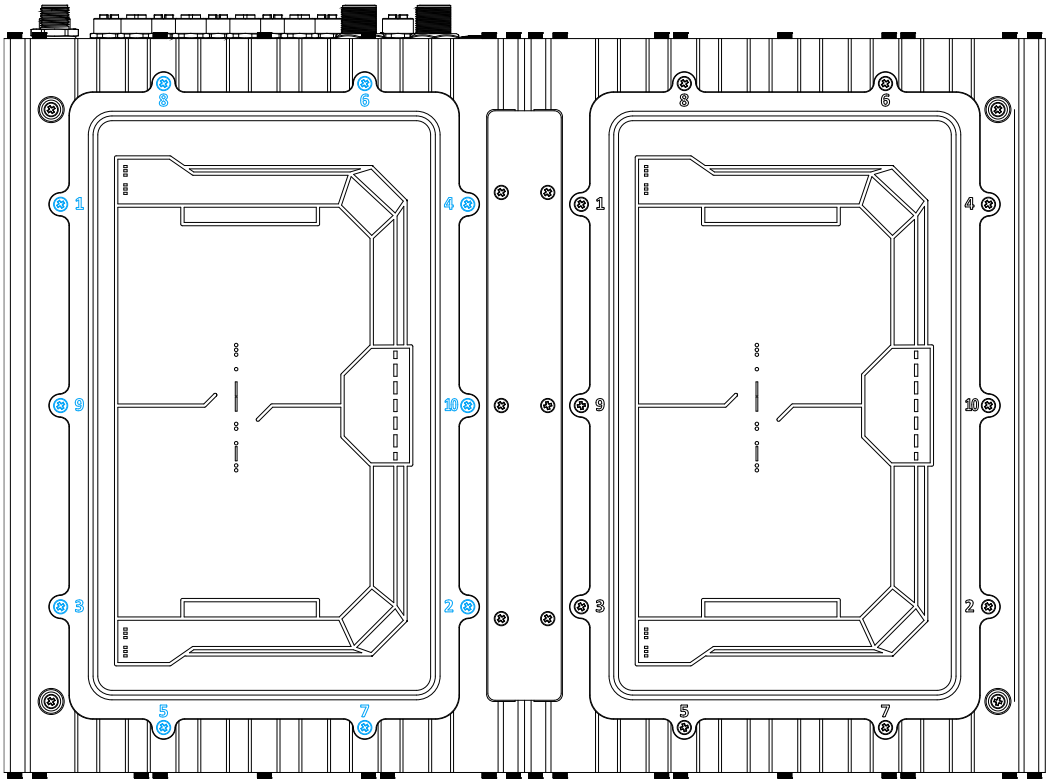
3.6 Hard Drive Installation

WARNING

Installing after-sales internal modules on your own may affect its waterproof capabilities and is not recommended. If you must install internal modules after purchase, please consult your sales representative as you may need to return the system to Neousys Technology or an authorized SEMIL distributor for processing to retain waterproof capability.

To install hard drives into the system, please refer to the following instructions:

1. Disconnect all cable connections and shut down the system.
2. Turn the system upside-down and place it on a flat sturdy surface.
3. Unscrew the screws indicated in **blue**, in descending order.



4. Gently lift the panel and you will see the internal components.

5. If hard drives are installed, disconnect the SATA/ power connector. Pull using the connector body, **DO NOT** pull on the cable!

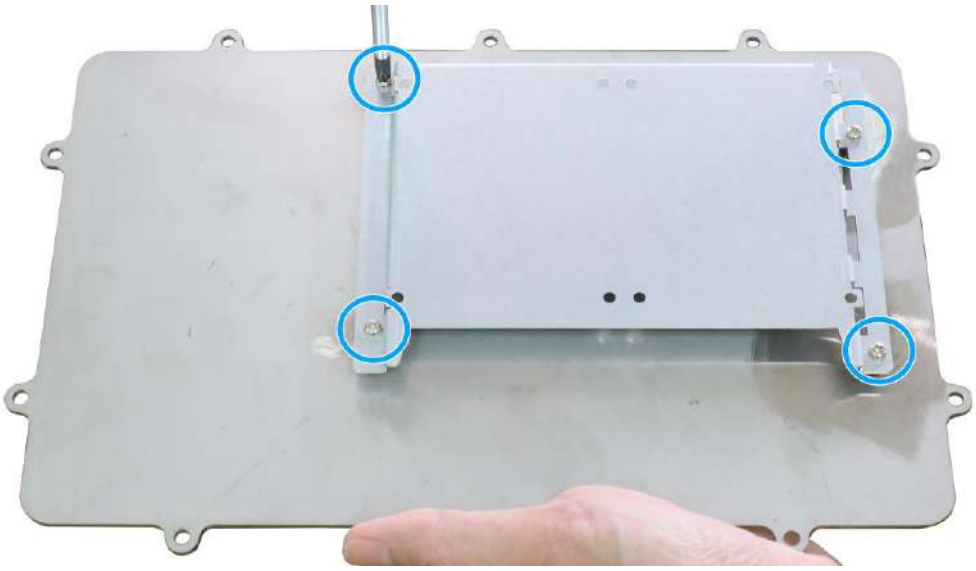
SEMIL-2007/ 2008/ 2047GC/ 2048GC

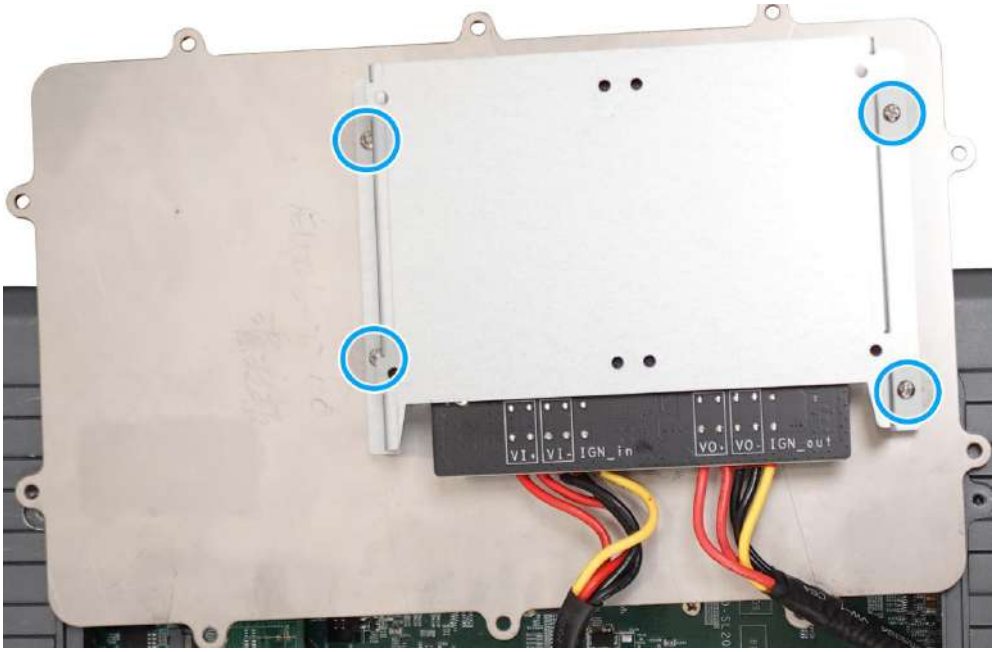
Filter board in SEMIL-2207/ 2247GC

NOTE

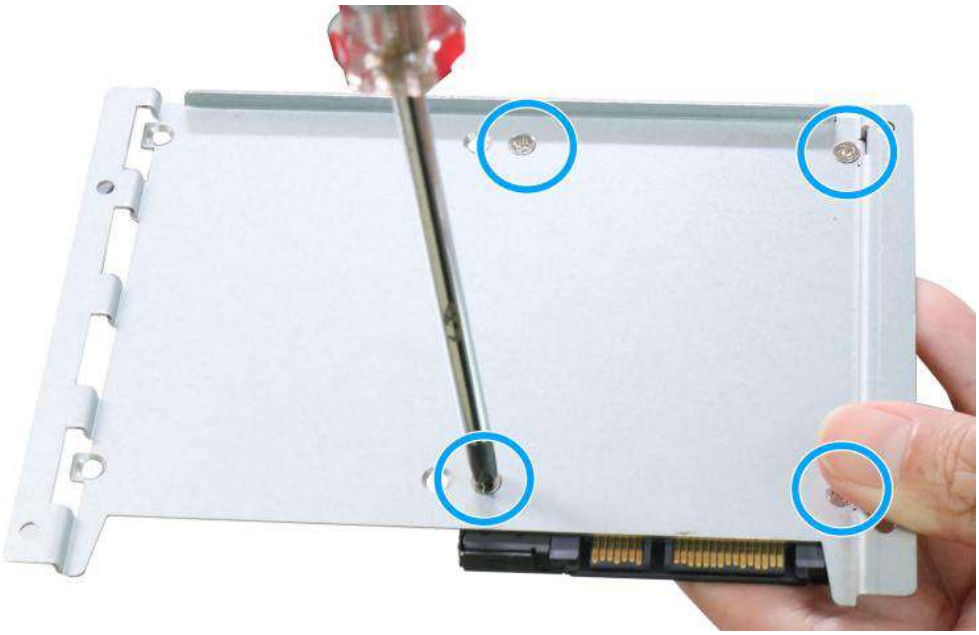
*For systems with filter board, **DO NOT** disconnect the cables, and set the panel on the side.*

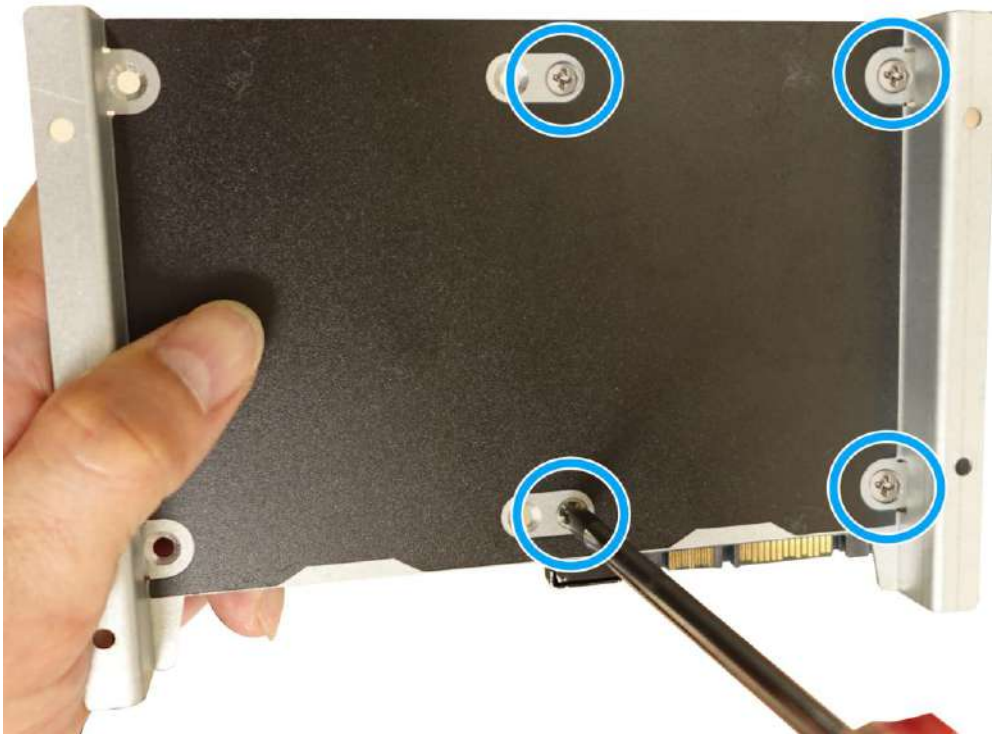
6. Separate the bracket from the panel by removing the screws indicated in **blue**.





7. Install the hard drive by securing the screws indicated.



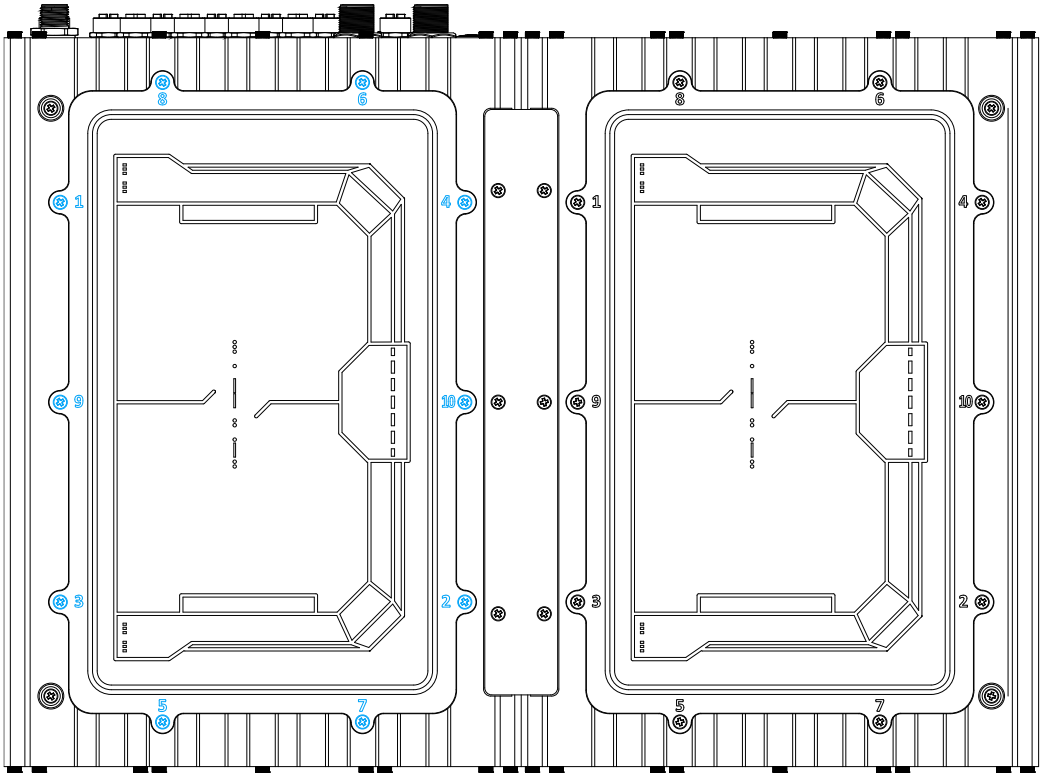


8. Connect the SATA/ power cable onto the hard drive.

9. Repeat steps 7 and 8 if you need to install another hard drive.

10. Make sure the O-ring is properly seated in the groove, gently tug all cables back into the enclosure and place the bottom panel back on.

11. Secure the indicated screws at a torque range of 8.1 – 9.9kgf-cm in ascending order to complete the installation procedure.



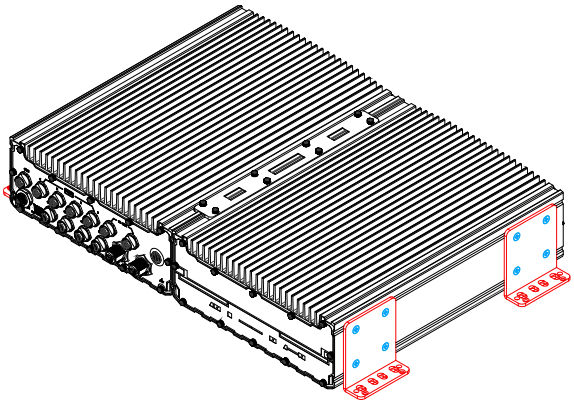
3.7 Wall-mount Bracket Installation

The system comes with wall-mount installation brackets. The four brackets are interchangeable and can be installed on any of the four locations designated for bracket installation. Please follow the procedures below to install the brackets.

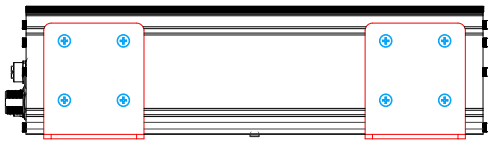
3.7.1 SEMIL-2000GC Series Wall-mount Bracket Installation

1. Remove the four brackets and sixteen screws from the accessory box.

2. To install the bracket (in **red**), simply secure it using the screws (in **blue**) provided.

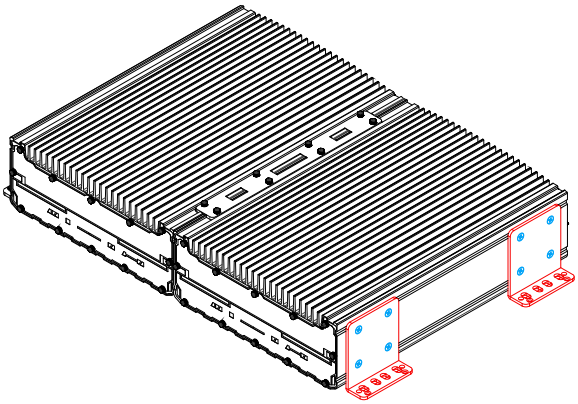


45 degree front view

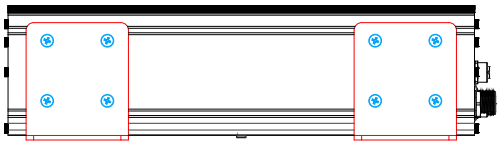


Left side view

3. Repeat the same bracket installation on the other side of the enclosure.



45 degree rear view

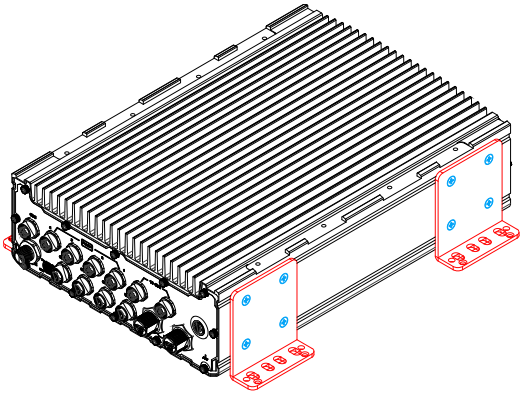


Right side view

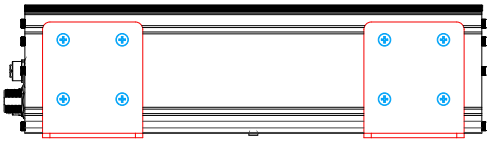
3.7.2 SEMIL-2000 Series Wall-mount Bracket Installation

1. Remove the four brackets and sixteen screws from the accessory box.

2. To install the bracket (in **red**), simply secure it using the screws (in **blue**) provided.

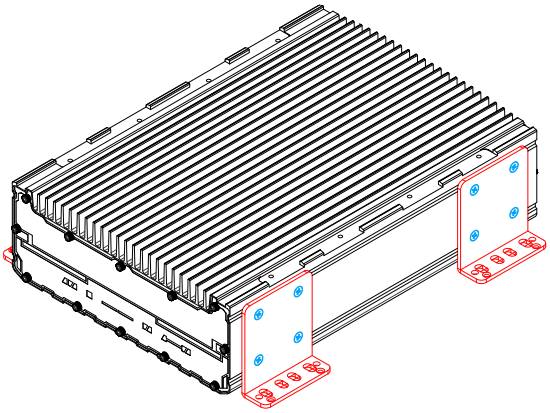


45 degree front view

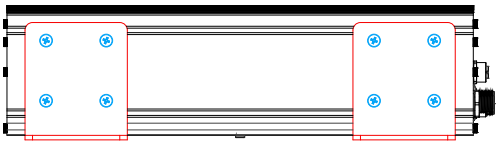


Left side view

3. Repeat the same bracket installation on the other side of the enclosure.



45 degree rear view



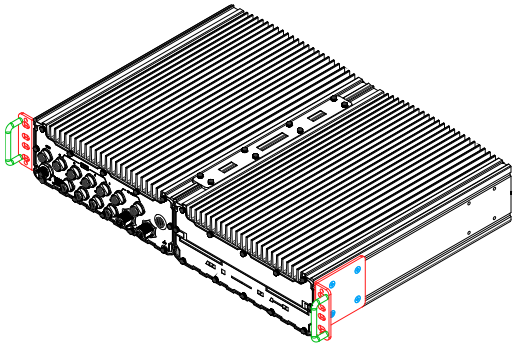
Right side view

3.8 Rack-mount Bracket Installation

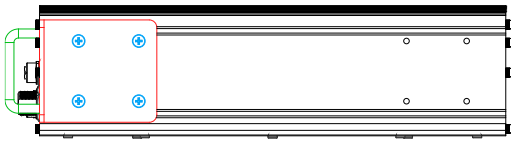
The system comes with rack-mount brackets. The two brackets can be installed so the system can be mounted into a standard 19” server cabinet. Please follow the procedures below to install the brackets.

3.8.1 SEMIL-2000GC Series Rack-mount Bracket Installation

1. There are two brackets (in **red**), two grips (in **green**) and eight screws (in **blue**) for this kit.
2. Secure the brackets (in **red**) on both sides of the enclosure with the screws (**in blue**) supplied.

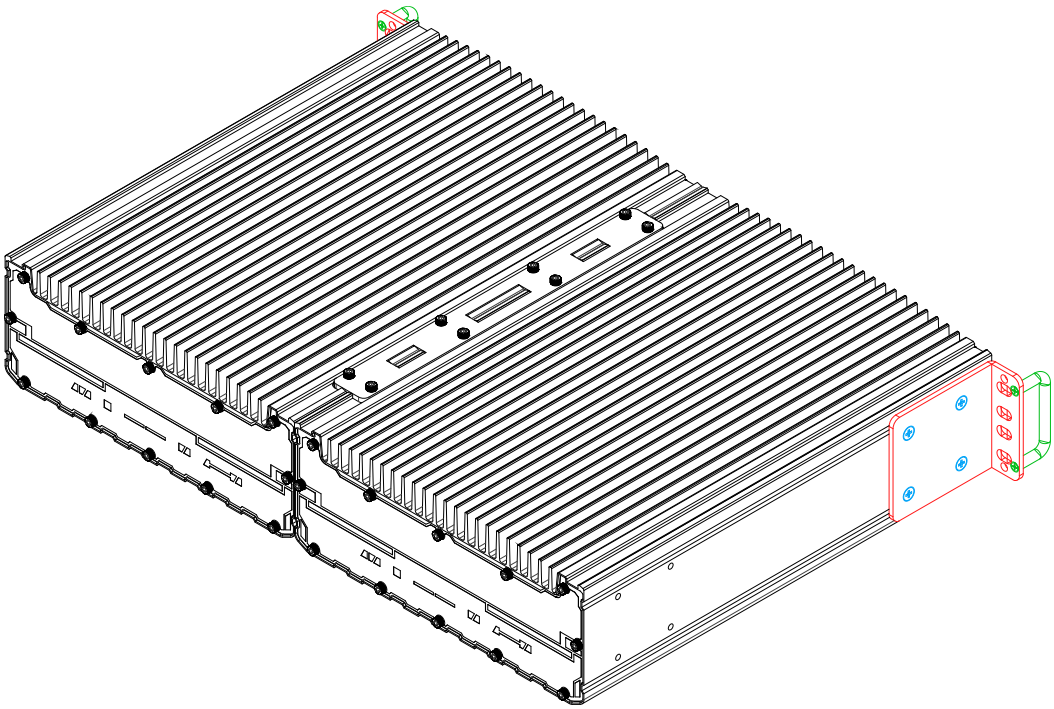


Left side bracket

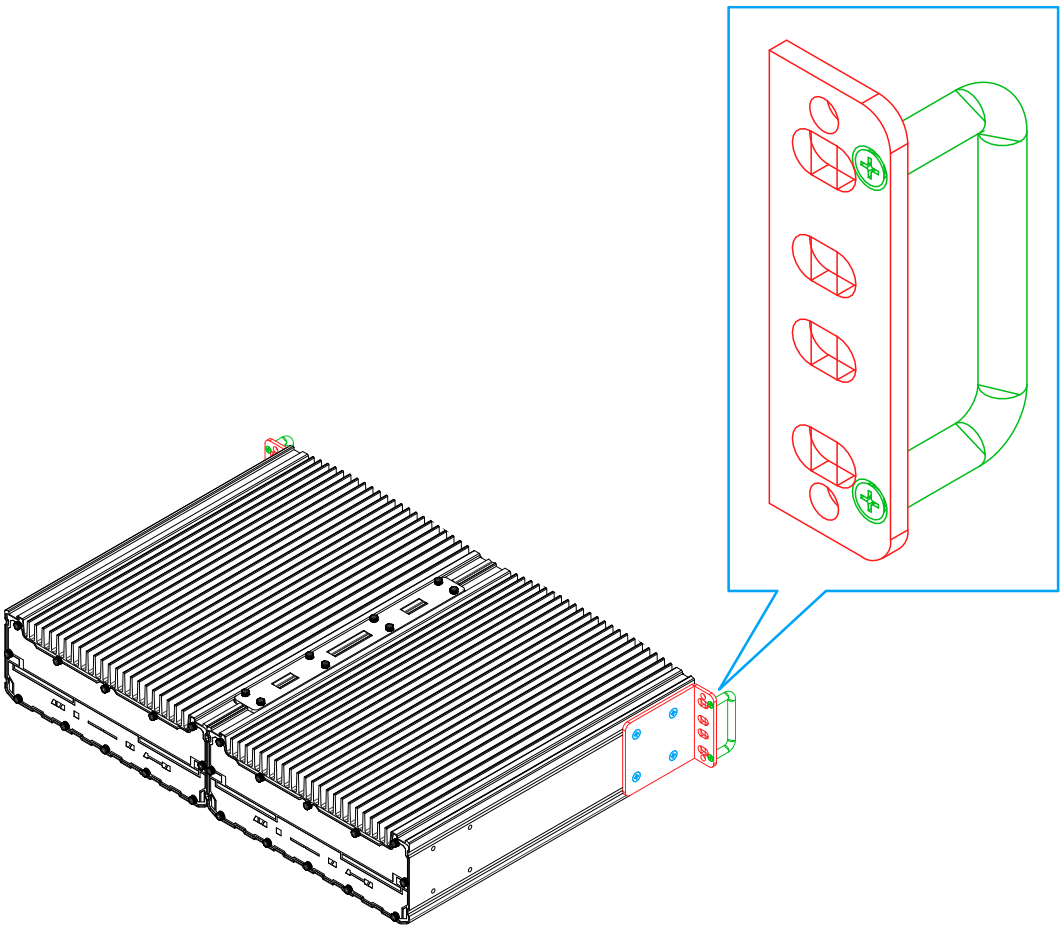


Screws securing the bracket

3. Repeat the same rack mount bracket installation on the other side of the enclosure.

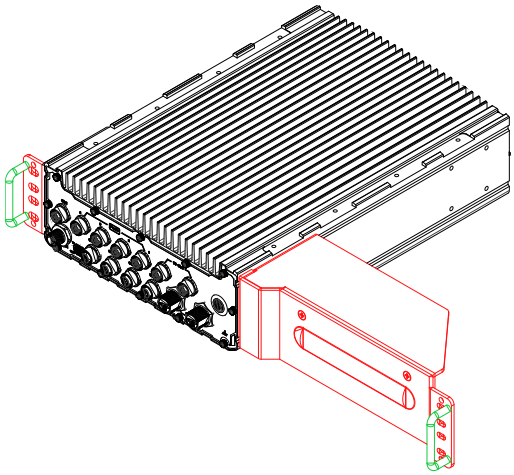


4. The grip (in **green**) can be found in the accessory box and is an optional installation item. Simply match the grip to the openings on the rack mount bracket and secure with M3 screws (in **green**) provided in the accessory box.

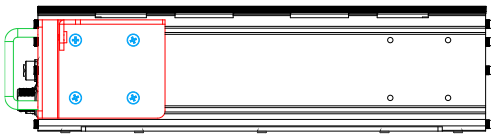


3.8.2 SEMIL-2000 Series Rack-mount Bracket Installation (Optional)

1. There are two brackets (in **red**), two grips (in **green**) and eight screws (in **blue**) for this kit.
2. The larger-sized bracket (in **red**) is to be installed on the left side (next to the power button) of the enclosure with the screws (**in blue**) supplied.

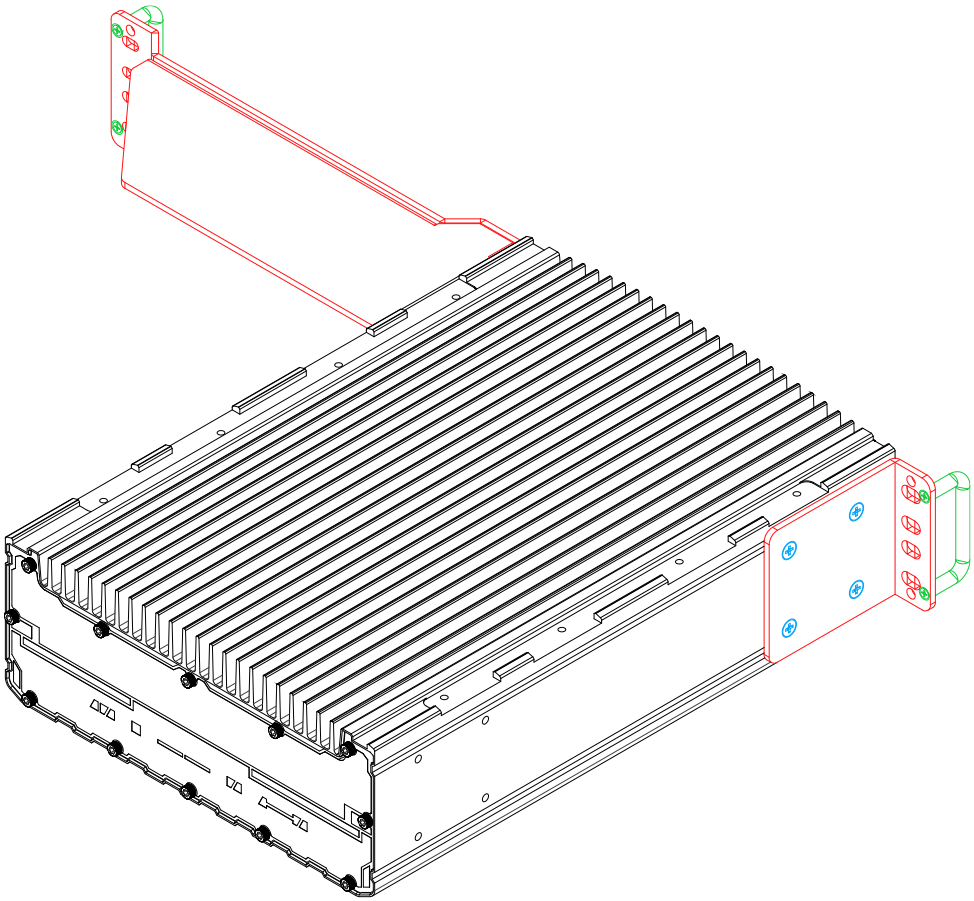


Left side bracket

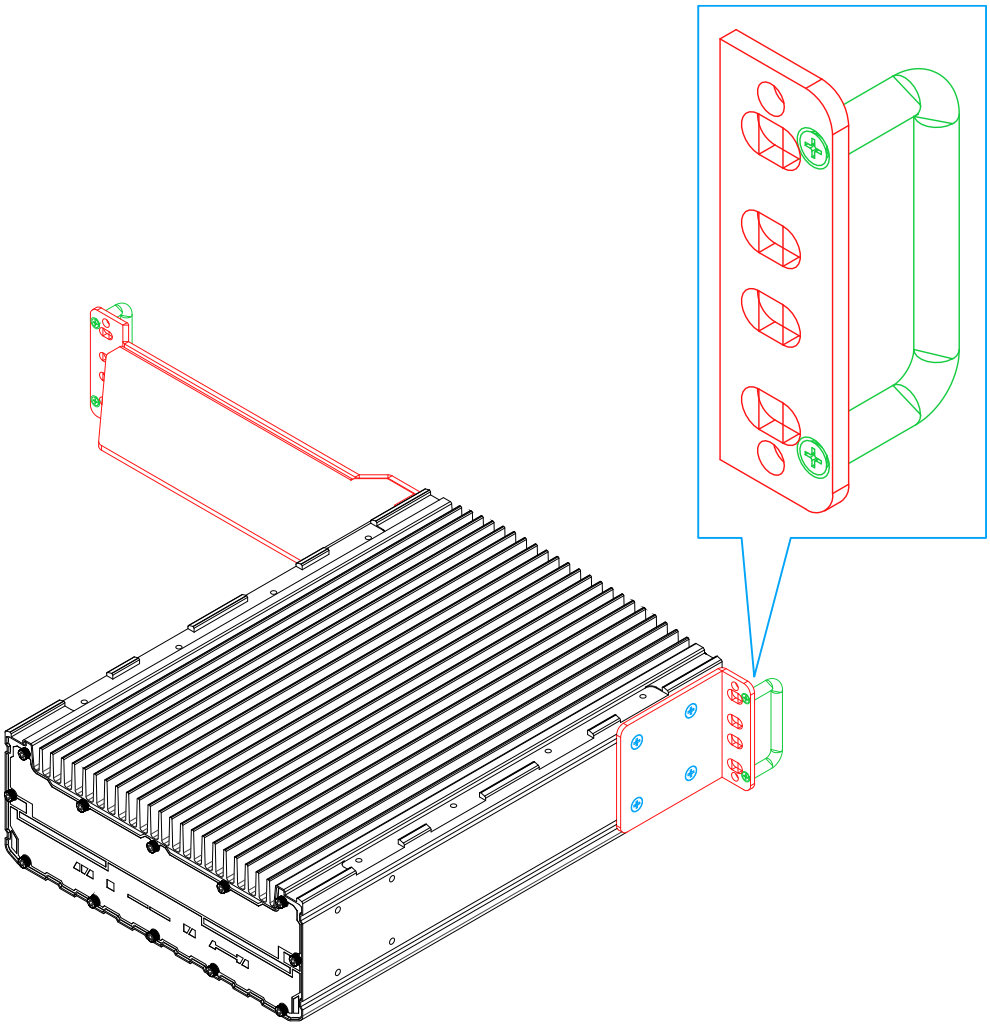


Screws securing the bracket

3. Repeat the same rack mount bracket installation on the other side of the enclosure.



4. The grip (in **green**) can be found in the accessory box and is an optional installation item. Simply match the grip to the openings on the rack mount bracket and secure with M3 screws (in **green**) provided in the accessory box.

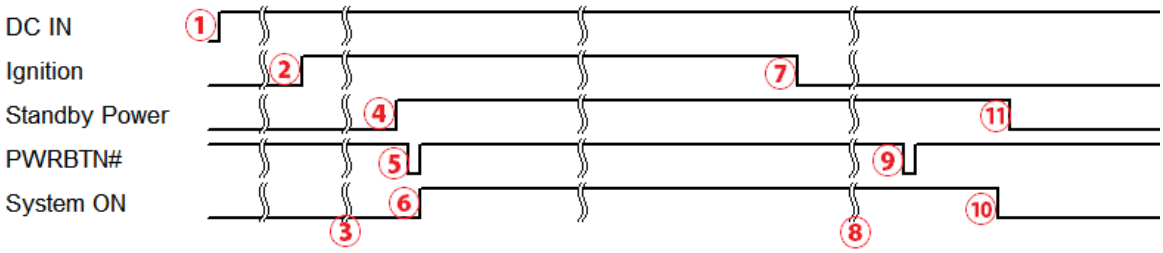


4 Ignition Power Control

The ignition power control module for in-vehicle applications is a MCU-based implementation that monitors the ignition signal and reacts to turn on/off the system according to predefined on/off delay. Its built-in algorithm supports other features such as ultra-low power standby, battery-low protection, system hard-off, etc. In this section, we'll illustrate the principle of ignition power control and operation modes.

4.1 Principles of Ignition Power Control

The basic concept of ignition power control module is to control the timing correlation between ignition signal and system power status. A typical timing correlation is described in following diagram.



1. When DC power is supplied to the system, MCU starts to periodically detect ignition signal. Note that only MCU is working at this moment and the overall power consumption is less than 2 mW.
2. Ignition signal is active (both 12VDC and 24VDC ignition signals are accepted).
3. MCU starts to count a pre-defined power-on delay.
4. Once power-on delay expired, MCU turns on necessary standby power for the system (3.3VSB & 5VSB).
5. A PWRBTN# pulse is then issued to turn on the system (equivalent to one pressing the power button on the front panel).
6. The system is booting and becomes operational.
7. After a period of time, the ignition signal becomes inactive.
8. MCU starts to count a pre-defined power-off delay.
9. Once power-off delay expired, another PWRBTN# pulse is issued to perform a soft-off for the system (ex. a normal shutdown process for Windows system).
10. The system is completely shut down.
11. As MCU detects system is off, it turns off the standby power for the system, and operates in low power mode again (< 2mW power consumption).

4.2 Additional Features of Ignition Power Control

In addition to the typical timing correlation, the ignition power control module offers additional features to provide additional reliability for in-vehicle applications.

1. **Low battery detection**

   The ignition power control module continuously monitors the voltage of DC input when the system is operational. If input voltage is less than 11V (for 12VDC input) or less than 22V (for 24VDC input) over a 60-second duration, it will shut down the system automatically.

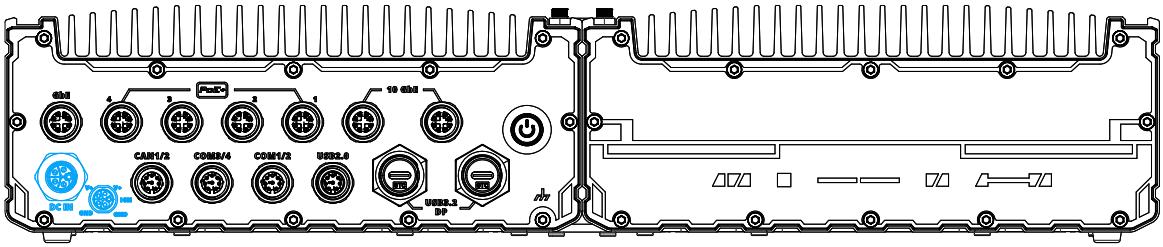
2. **Guarded power-on/ power-off delay duration**

   If ignition signal goes inactive during the power-on delay duration, the ignition power control module will cancel the power-on delay process and go back to idle status. Likewise, if ignition signal goes active during the power-off delay duration, the ignition power control module will cancel the power-off delay process and keep the system running.

3. **System hard-off**

   In some cases, system may fail to shutdown via a soft-off operation due to system/ application halts. The ignition power control module offers a mechanism called “hard-off” to handle this unexpected condition. By detecting the system status, it can determine whether the system is shutting down normally. If not, the ignition power control module will force cut-off the system power 10 minutes after the power-off delay duration.

4.3 Wiring Ignition Signal



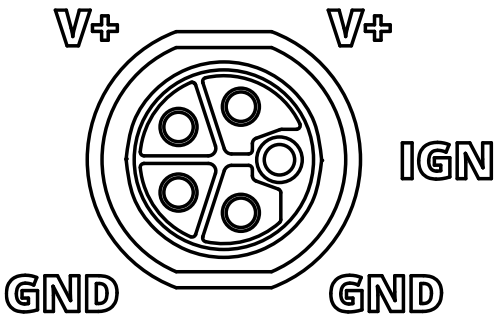
To have ignition power control for in-vehicle usage, you need to supply IGN signal to the system. The IGN input is located on DC-in M12 L-coded connector. Below is the typical wiring configuration for in-vehicle applications.

1. Connect car Battery+ line (12V for sedan, 24V for bus/truck) to V+.
2. Connect car Batter-/ GND line to GND.
3. Connect ACC line to IGN.

WARNING

Please make sure the voltage of DC power is correct before you connect it to the system.
SEMIL-2007/ 2008/ 2047GC/ 2048GC supports up to 48V.
SEMIL-2207/ 2247GC supports up to 36V.
Supplying a voltage over the maximum supported voltage will damage the system.

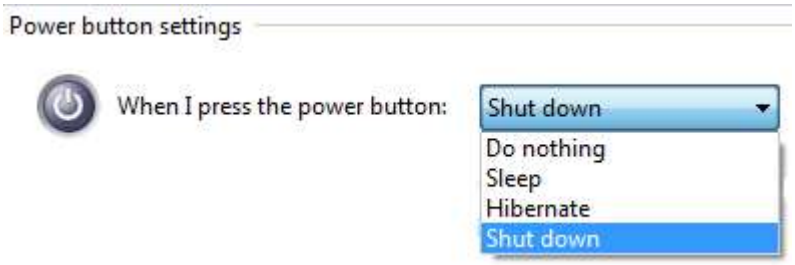
Connector Pin Definition



Signal	Wire color
V+	
V+	
GND	
GND	
IGN	

4.4 Configure your Windows system

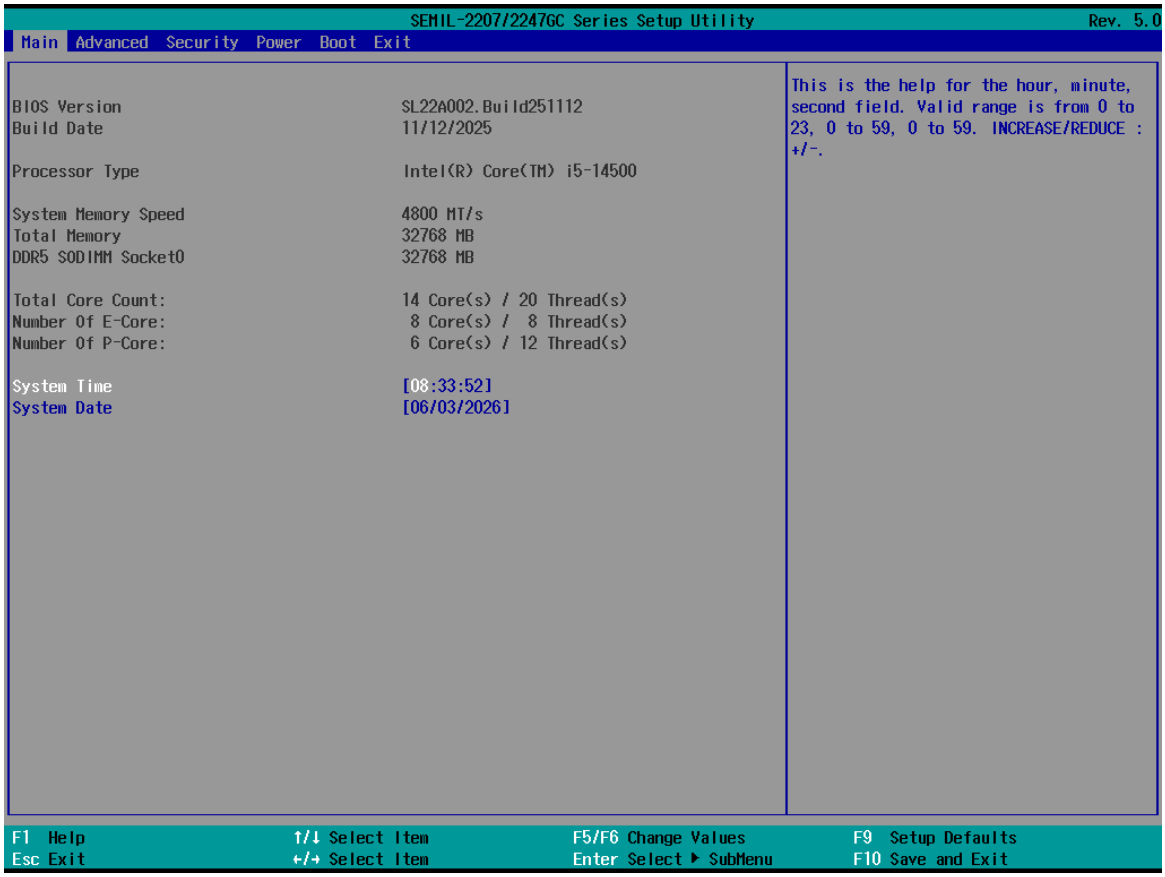
When applying ignition power control to your system, please make sure you've configured your Windows system to initiate a shutdown process when pressing the power button. By default, Windows 10/ 11 goes to sleep (S3) mode when power button is pressed. As sleep (S3) is not a complete shutdown behavior, the ignition control function does not recognize the finish of a normal shut down process and thus users will encounter a system hard-off (power cut-off after 10 minutes). Please configure "When I press the power button" to "Shut down" in your Windows system settings.



5 System Configuration

5.1 BIOS Settings

The system is shipped with factory-default BIOS settings meticulously programmed for optimum performance and compatibility. In this section, we'll illustrate some of BIOS settings you may need to modify. Please always make sure you understand the effect of change before you proceed with any modification. If you are unsure of the function you are changing, it is recommended to change one setting at a time to see its effect(s).

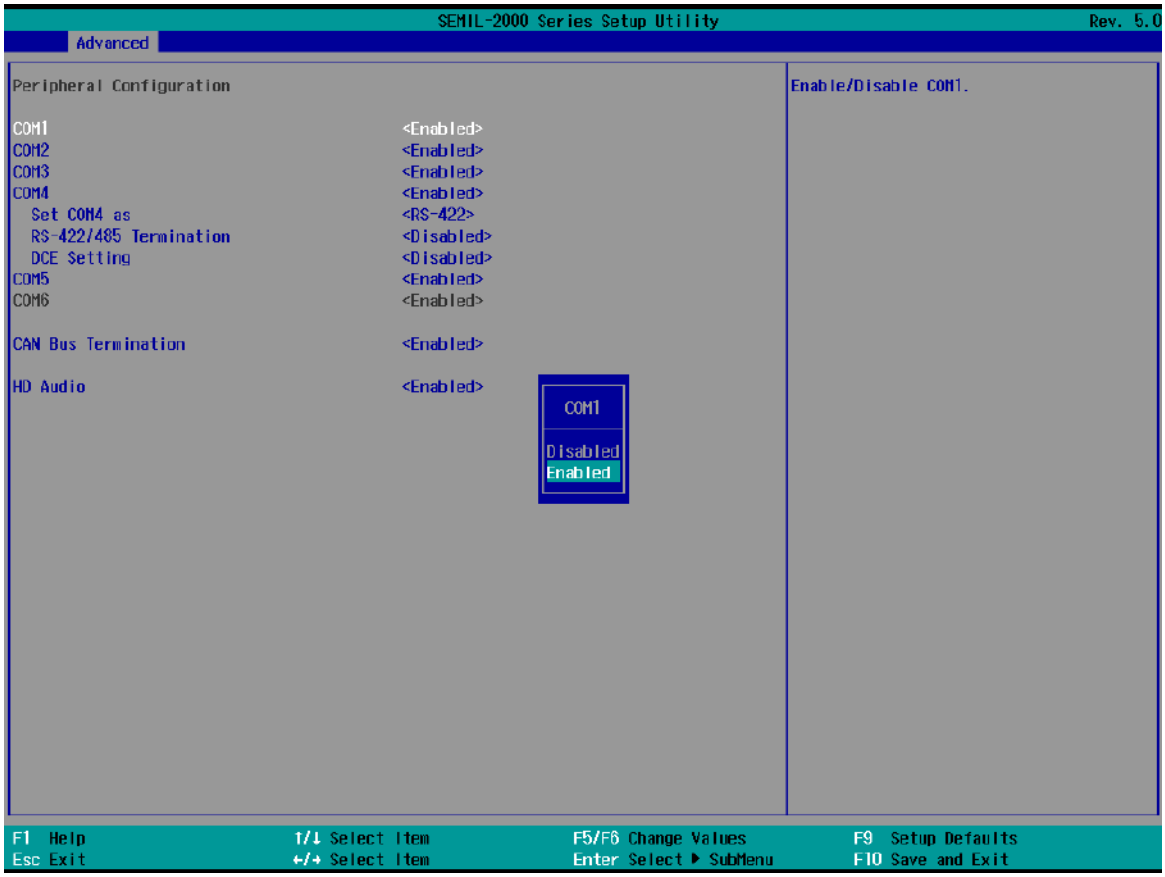


NOTE

Not all BIOS settings will be discussed in this section. If a particular setting/ function you are after requires specific BIOS settings but is not discussed in this section, please contact Neousys Technical Support staff.

5.1.1 COM1/ 2/ 3 Port Configuration

The system's COM1, COM2, and COM3 are isolated 3-wire RS-232 (full-duplex) mode ports.

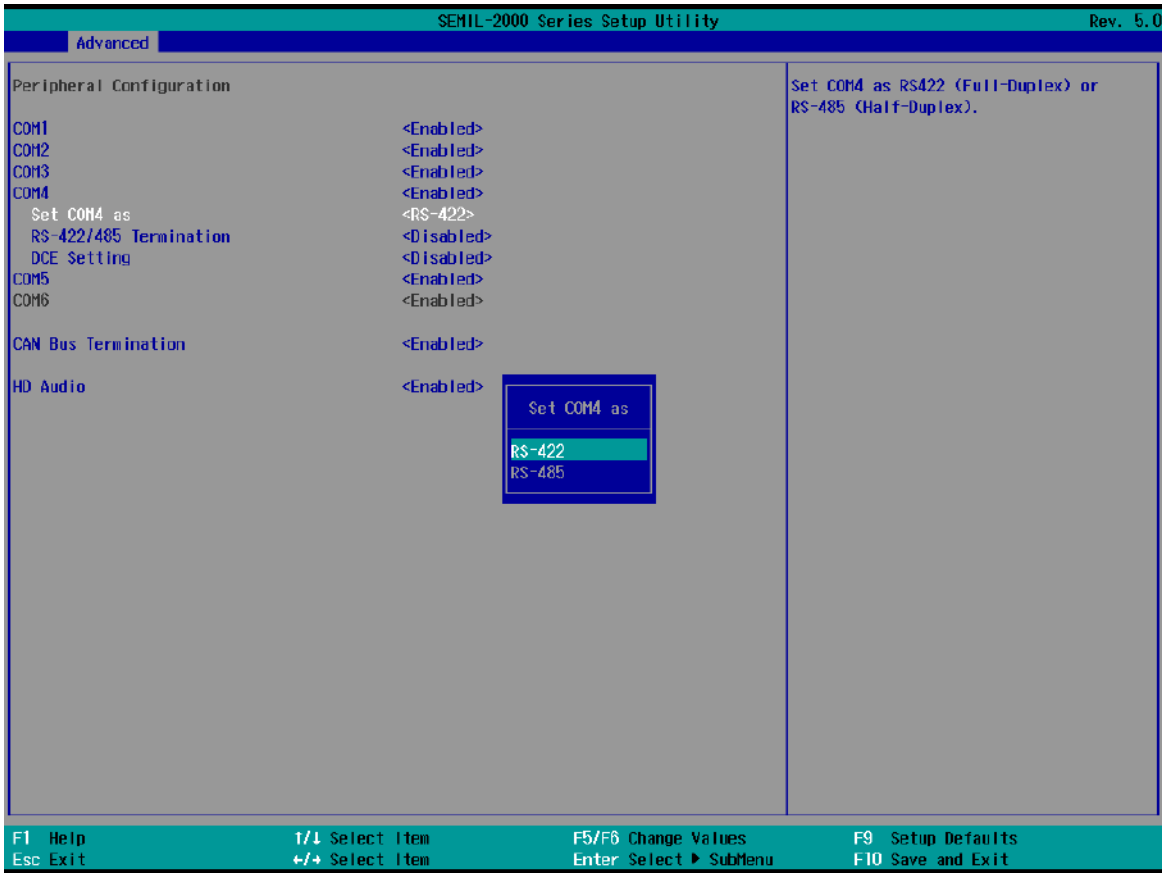


To enable COM port operation:

1. Press F2 when the system boots up to enter the BIOS setup utility.
2. Go to **[Advanced]** → **[Peripheral Configuration]**.
3. Highlight the **[COM]** port you wish to enable, press ENTER, highlight **[Enabled]**, and press ENTER to enable.
4. Once set, press F10 to save setting and exit.

5.1.2 COM 4 Port Configuration

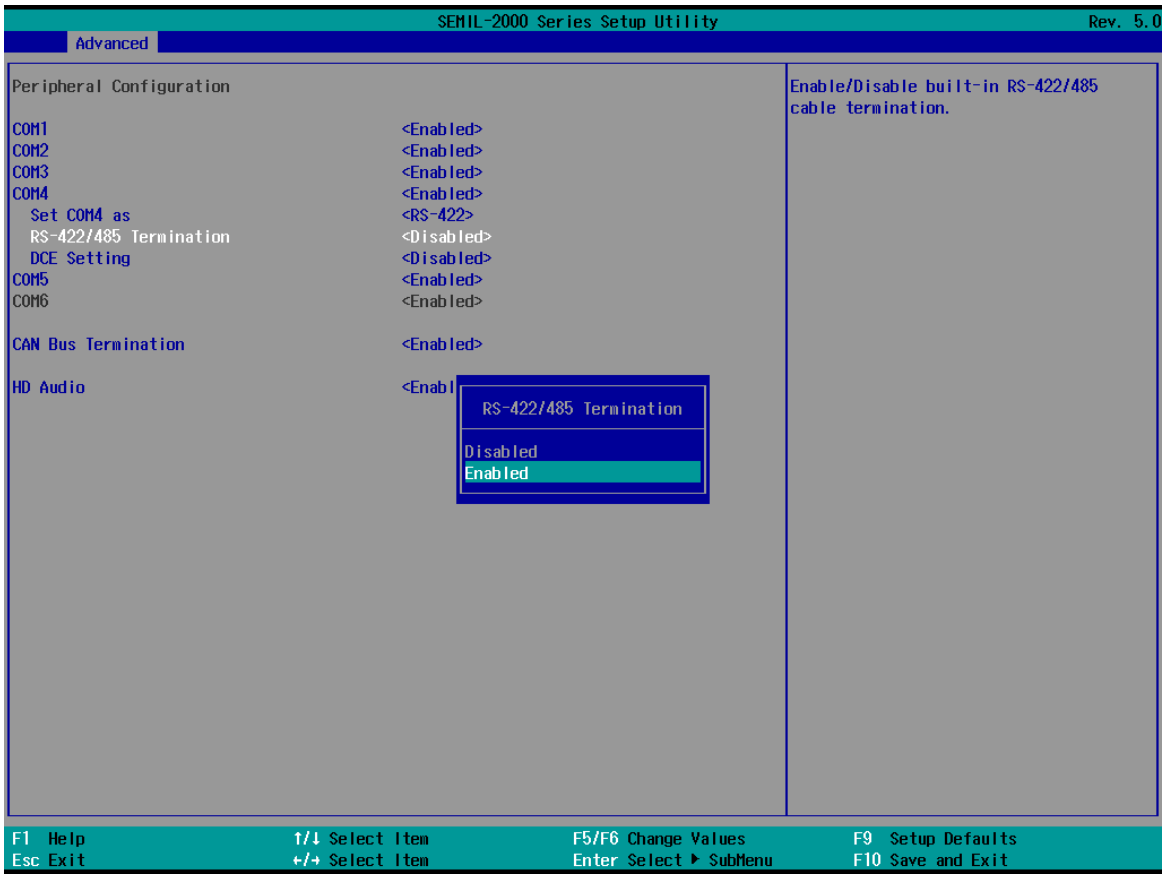
The system's COM4 is a dual mode RS-422/ 485 port.



To enable/ set COM4 port operation:

1. Press F2 when the system boots up to enter the BIOS setup utility.
2. Go to **[Advanced]** → **[Peripheral Configuration]**.
3. Highlight **[COM4]** port, press ENTER, highlight **[Enabled]**, and press ENTER to enable.
4. Once the port has been enabled, go to **[Set COM4 as]**, and press ENTER, highlight your selection and press ENTER to set.
5. Once set, press F10 to save setting and exit.

For RS-422/485 communication, the "*RS-422/485 Termination*" option determines whether to enable/disable internal termination of RS-422/485 transceiver according to your wiring configuration (e.g. with or without external termination).

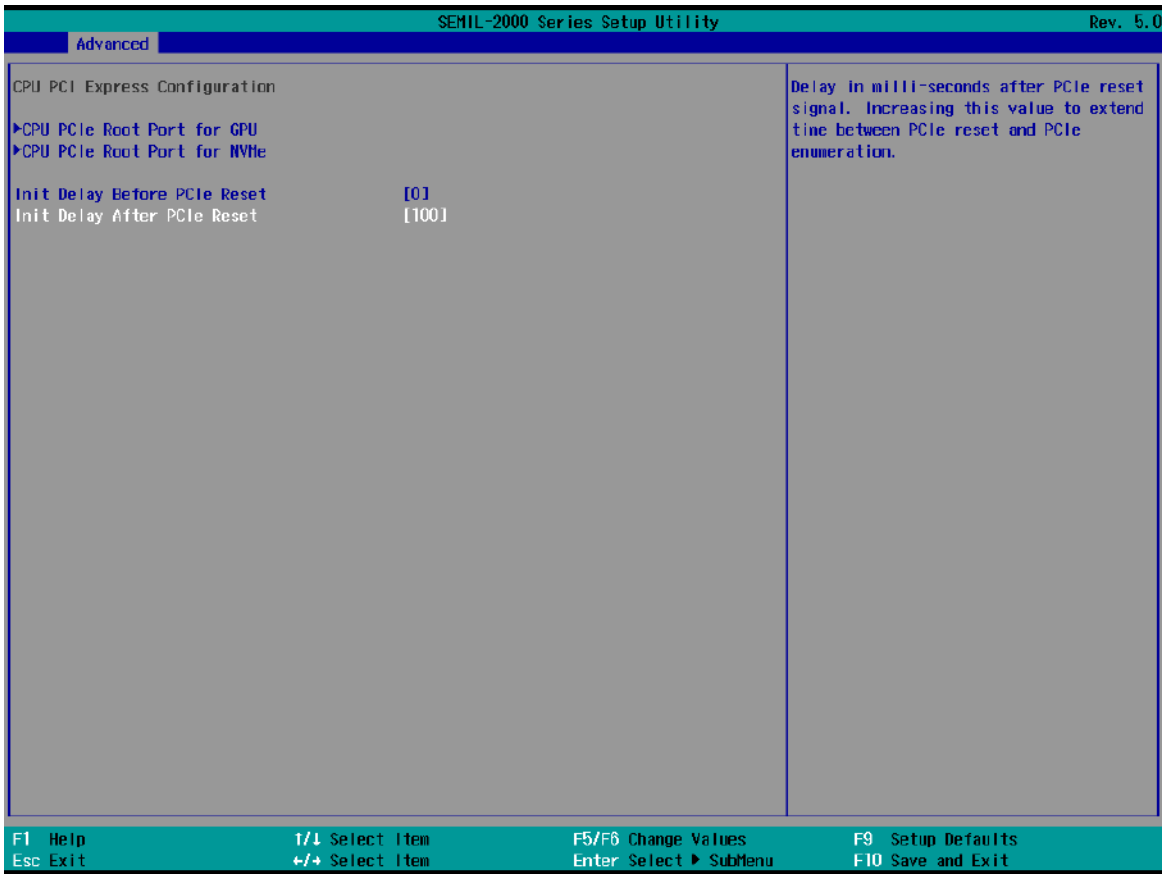


To enable RS-422/ 485 termination:

1. Press F2 when the system boots up to enter the BIOS setup utility.
2. Go to **[Advanced]** → **[Peripheral Configuration]**.
3. Make sure COM4 port has been enabled.
4. Highlight **[RS-422/485 Termination]**, press ENTER, highlight **[Enabled]**, and press ENTER to enable.
5. Once set, press F10 to save setting and exit.

5.1.3 Delay for PEG Initialization

This setting offers delay in milliseconds for PEG port initialization and PCI enumeration. By increasing the delay value, it may eliminate compatibility issue(s) with some PCIe add-on cards.



To set PEG delay in milliseconds:

1. When system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Advanced]** > **[System Agent (SA) Configuration]** > **[CPU PCIe Express Configuration]** and press ENTER.
3. A small window appears and you may enter delay value before or after PCIe reset in ms.
4. When done, press F10 to “Exit Saving Changes”

5.1.4 TPM Availability

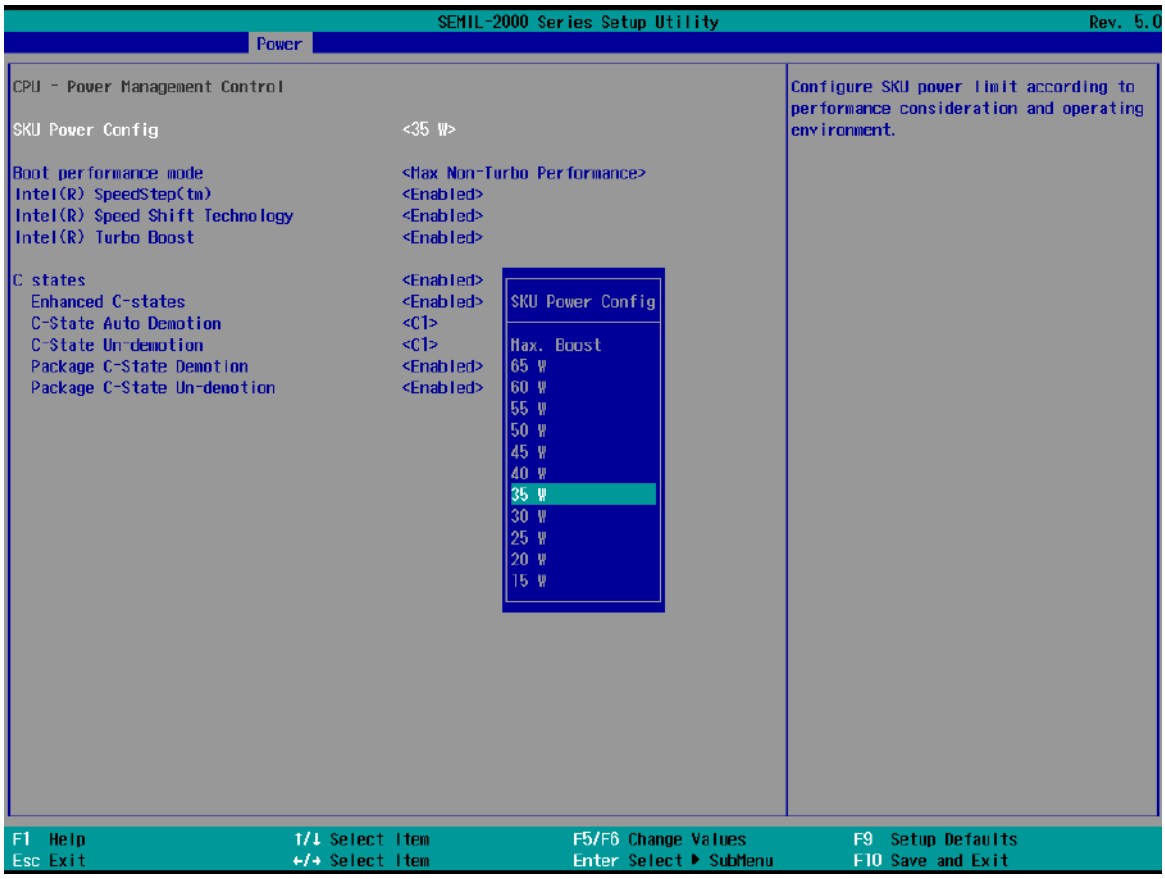
Trusted Platform Module (TPM) is a hardware-based cryptoprocessor to secure hardware by integrating cryptographic keys into devices. The system is designed with on-board TPM 2.0 module. As TPM 2.0 requires 64-bit Windows 10 with UEFI boot mode, it is enabled in BIOS by default.

To enable TPM availability:

1. When system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Security] > [TPM Availability]**, press Enter to bring up Options, Available/ Hidden.
3. Highlight your selection, press Enter and press F10 to “Exit Saving Changes”.

5.1.5 Power & Performance (CPU SKU Power Configuration) – SEMIL-2000 Series

The system supports Intel® 14th/ 13th/ 12th-Gen CPUs. A unique feature, "**SKU Power Config**" is implemented in BIOS to allow users to specify user-defined SKU power limit. The system is designed to have best thermal performance with CPUs of 65W TDP and an L4 GPU. This feature gives you the flexibility of CPU selection and great balance between computing power and operating temperature range.

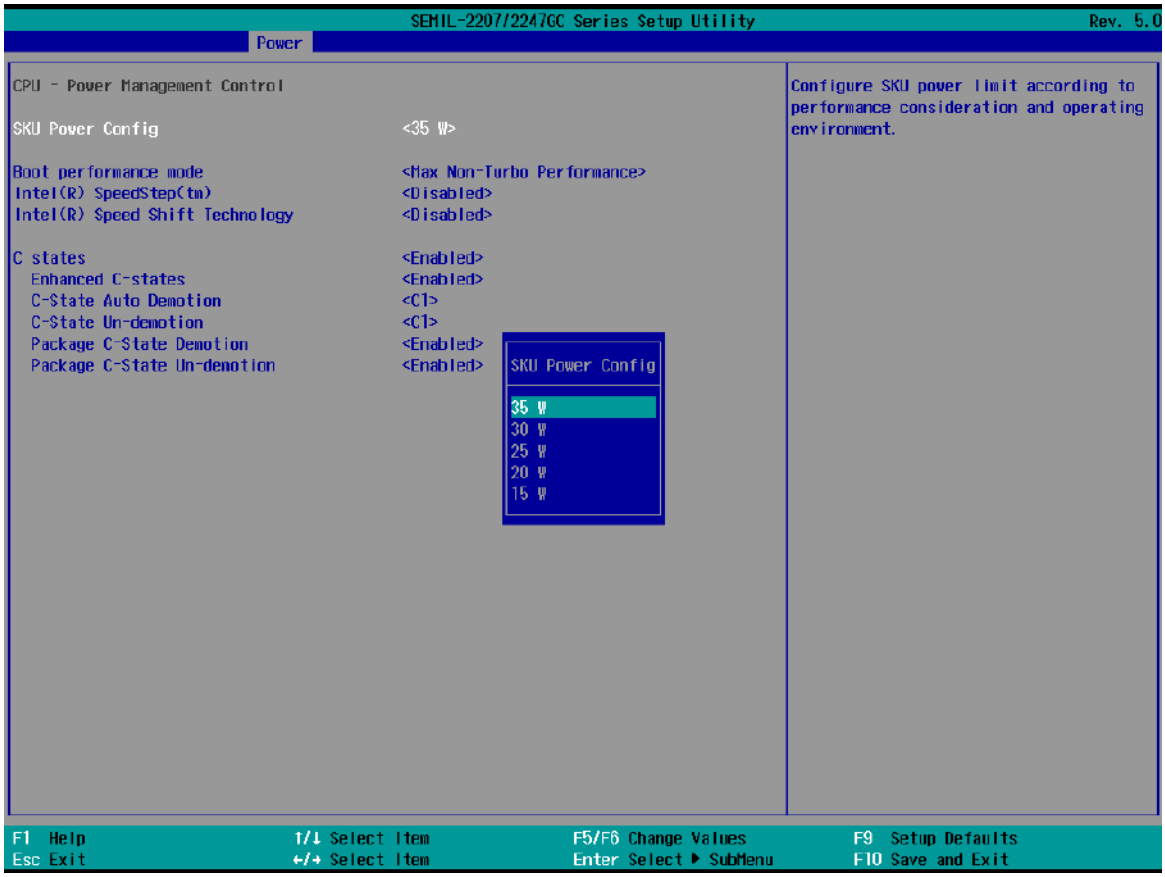


To configure the CPU SKU power limit:

1. When the system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Power]** → **[Power & Performance]**.
3. Select a proper value of SKU power limit for **[SKU Power Config]** option.
4. Press F10 to "Exit Saving Changes".

5.1.6 Power & Performance (CPU SKU Power Configuration) – SEMIL-2200 Series

The system supports Intel® 14th/ 13th/ 12th-Gen CPUs. A unique feature, "**SKU Power Config**" is implemented in BIOS to allow users to specify user-defined SKU power limit. The system is designed to have best thermal performance with CPUs up to 35W TDP and an L4 GPU. This feature gives you the flexibility of CPU selection and great balance between computing power and operating temperature range.



To configure the CPU SKU power limit:

1. When the system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Power]** → **[Power & Performance]**.
3. Select a proper value of SKU power limit for **[SKU Power Config]** option.
4. Press F10 to "Exit Saving Changes".

5.1.7 PoE Power Enable

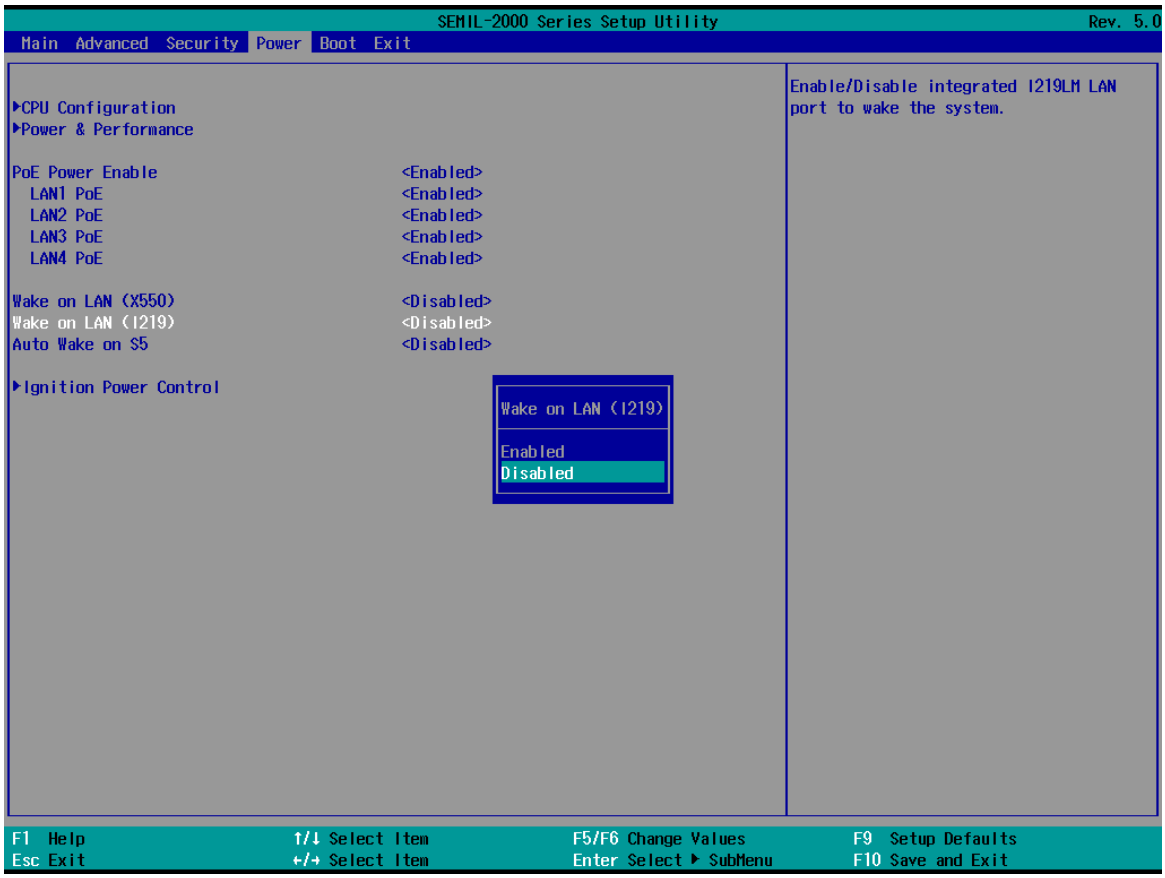
There are four IEEE 802.3at Power Over Ethernet +(PoE+) ports and each port's power can be enabled or disabled individually.

To enable or disable the PoE port:

1. When the system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Power] > [PoE Power Enable]**.
3. Press Enter to bring up setting options, scroll to the setting (Enabled/ Disabled) you desire and press Enter to set.
4. Highlight the LAN port you wish to enable or disable, press ENTER to bring up the setting options, scroll to the setting (Enabled/ Disabled) you desire and press Enter to set.
5. F10 to "Exit Saving Changes

5.1.8 Wake on LAN Option

Wake-on-LAN (WOL) is a mechanism which allows you to turn on your System series via Ethernet connection. To utilize Wake-on-LAN function, you have to enable this option first in BIOS settings. Please refer "Powering On Using Wake-on-LAN" to set up the system.

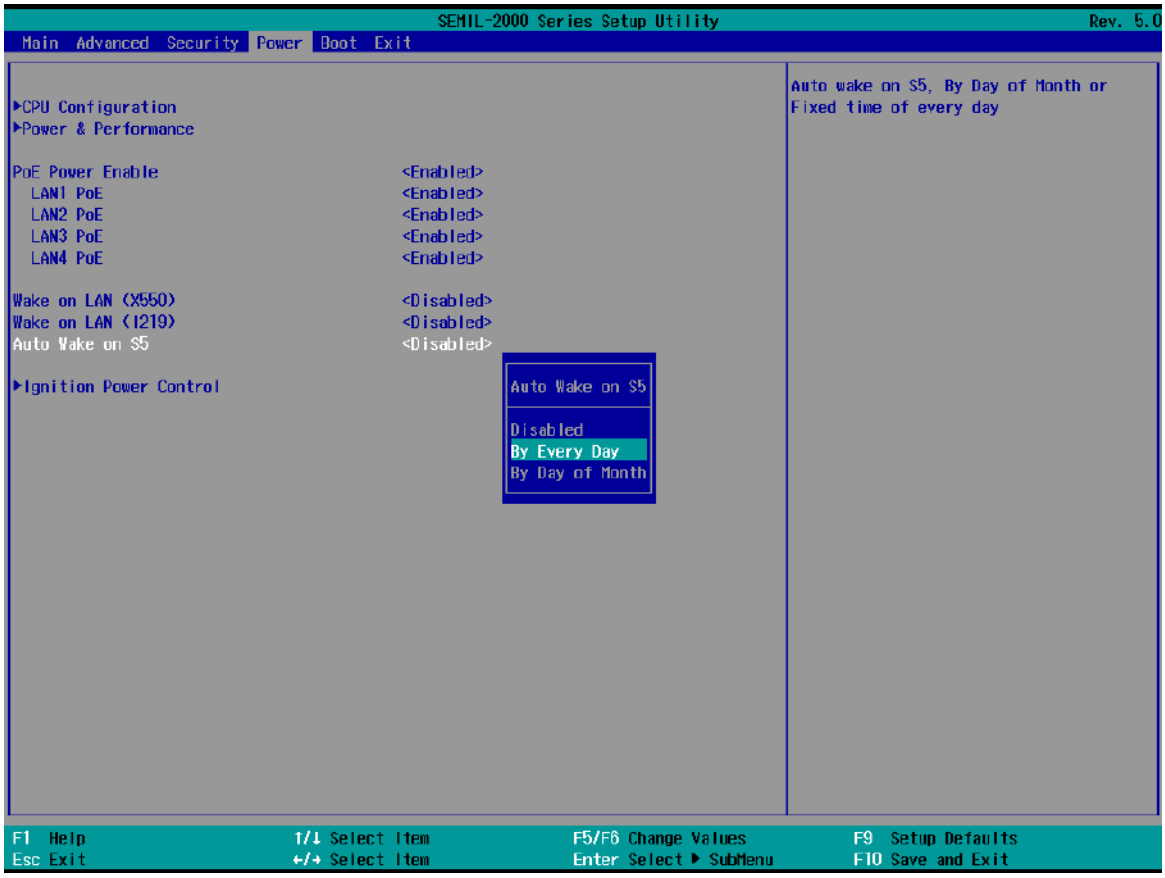


To enable/disable "Wake on LAN" option:

1. When system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Power] > [Wake on LAN (x550)]** or **[Wake on Lan (I219)]**.
3. Press Enter to bring up setting options, scroll to the setting you desire and press Enter to set.
4. Press F10 to "Exit Saving Changes.

5.1.9 Auto Wake on S5

When the system is set to operate in S5 state, the user can specify a time to turn on the system, daily or monthly.

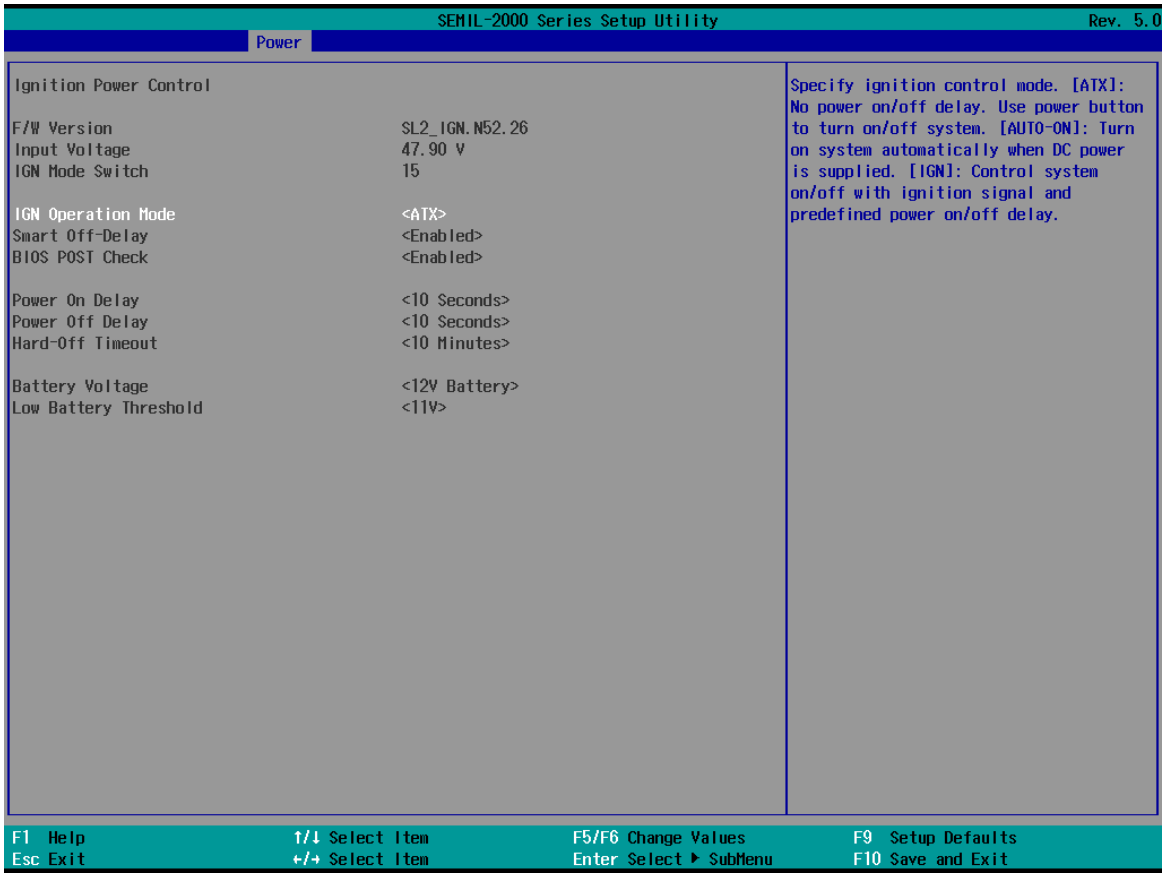


Value	Option	Description
Auto Wake on S5	Disabled	The system does not turn on when operating in state S5.
	By Every Day	The system turns on each day when operating in state S5. Specify the time of day.
	By Day of Month	The system turns on each month when operating in state S5. Specify the day and time.

Go to **[Power]** > **[Auto Wake on S5]**, highlight your selection, press ENTER and press F10 to “Exit Saving Changes”.

5.1.10 Ignition Power Control

The system ignition power control is set via its BIOS. The ignition power control module for in-vehicle applications is an MCU-based implementation that monitors the ignition signal and reacts to turn on/off the system according to predefined on/off delay. Its built-in algorithm supports other features such as ultra-low power standby, battery-low protection, system hard-off, etc.



To set IGN settings:

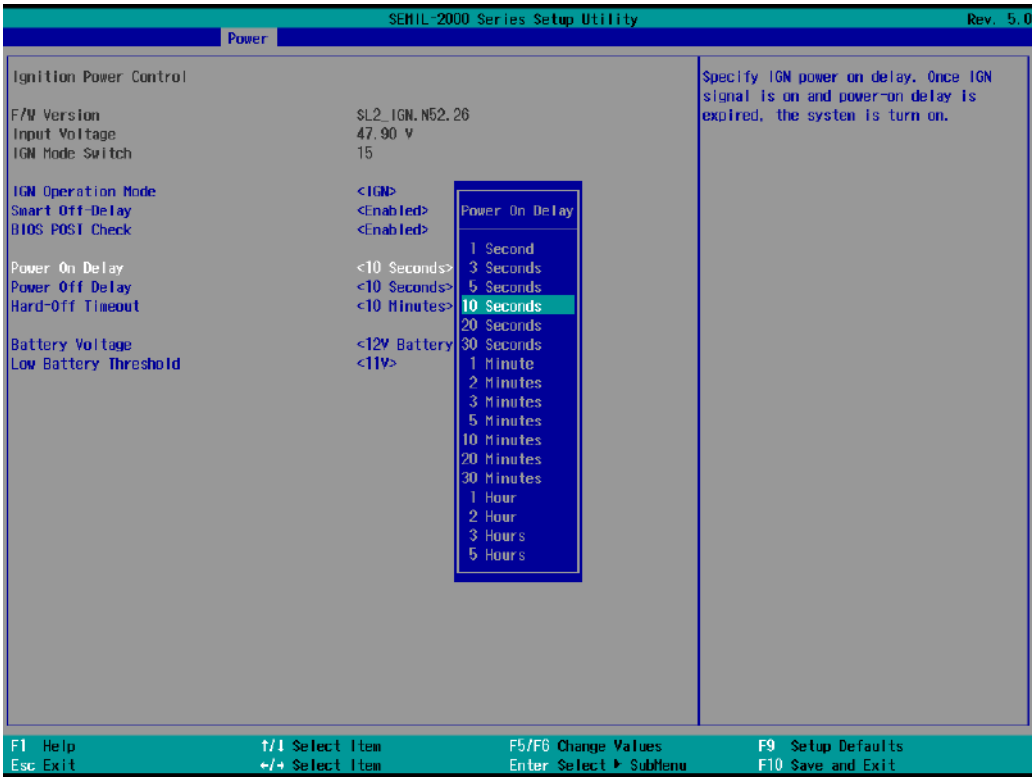
1. Press F2 when the system boots up to enter the BIOS setup utility.

2. Go to **[Power] > [Ignition Power Control]** and press ENTER.

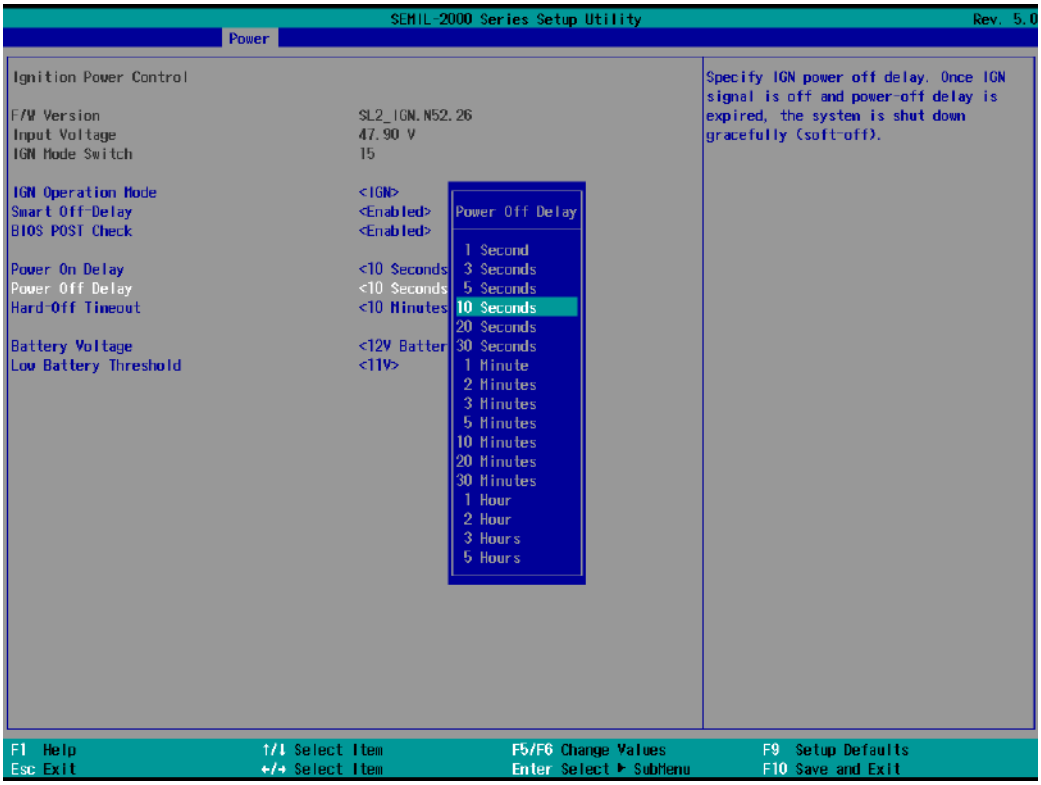
3. Highlight **[IGN Operation Mode]** and select the setting you desire

Setting	Description
[ATX]	The power button turn on/ off the system without delay.
[Auto-on]	The system powers on automatically when DC power is supplied
[IGN]	User set power on/ off delay settings.

4. The ignition power on delay has the following predefined settings.

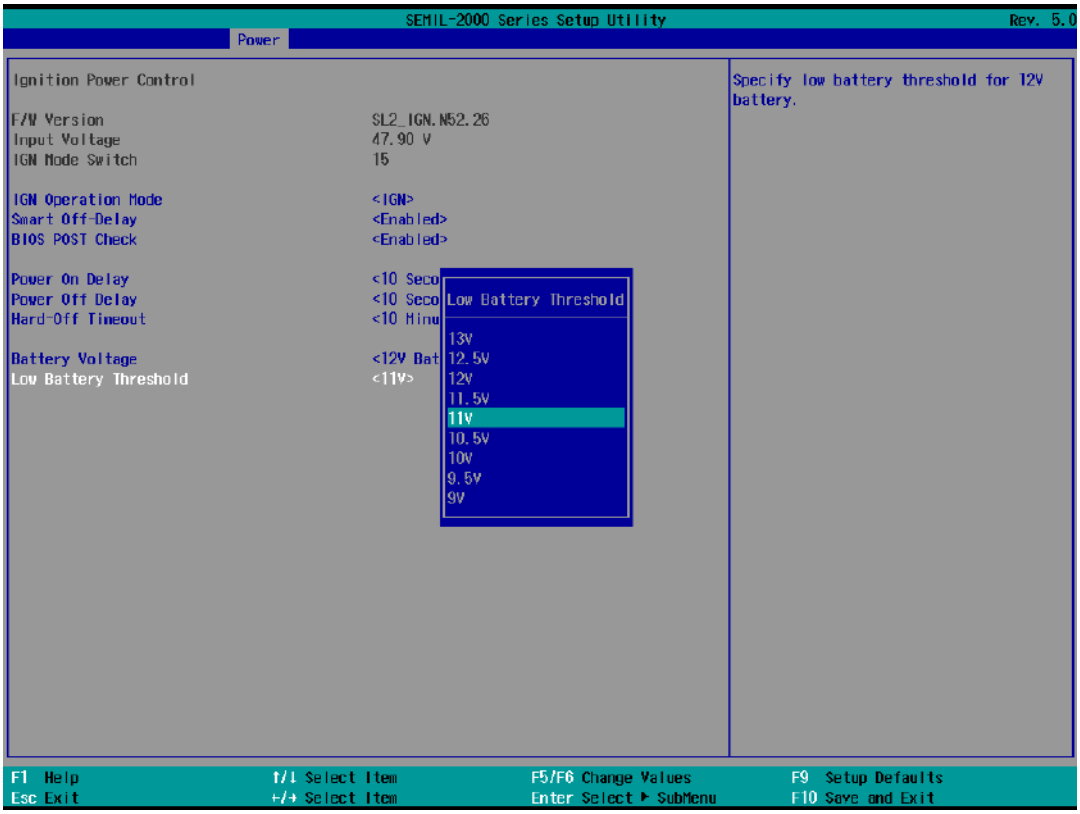


5. The ignition power off delay has the following predefined settings.

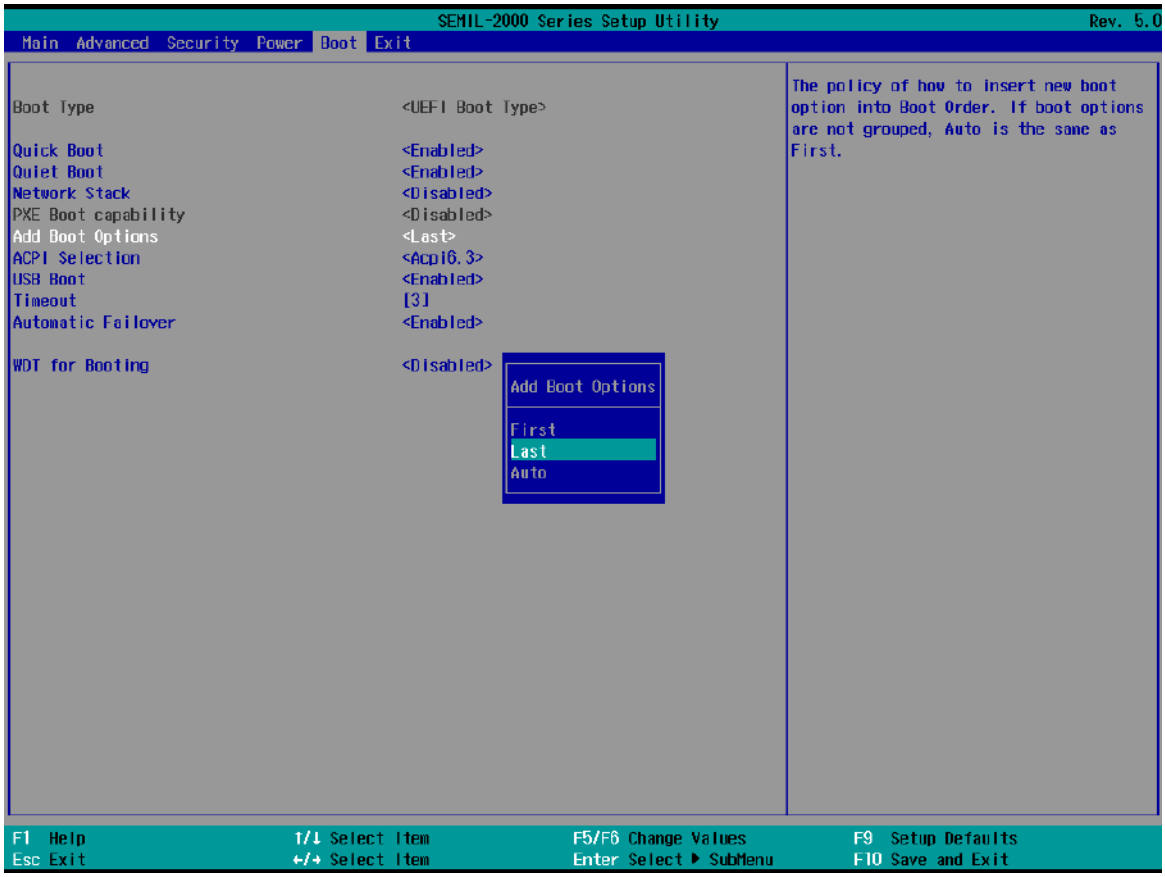


6. You can also set the battery supplied voltage to suit your vehicle type.

7. A Low Battery Threshold can also be set.



5.1.11 Add Boot Options



The “Add Boot Options” allow you to determine whether a newly added device (eg. USB flash disk) is to boot as the first device to boot or the last in the boot sequence.

To set the newly-installed boot device as the first or last boot device:

8. Press F2 when the system boots up to enter the BIOS setup utility.

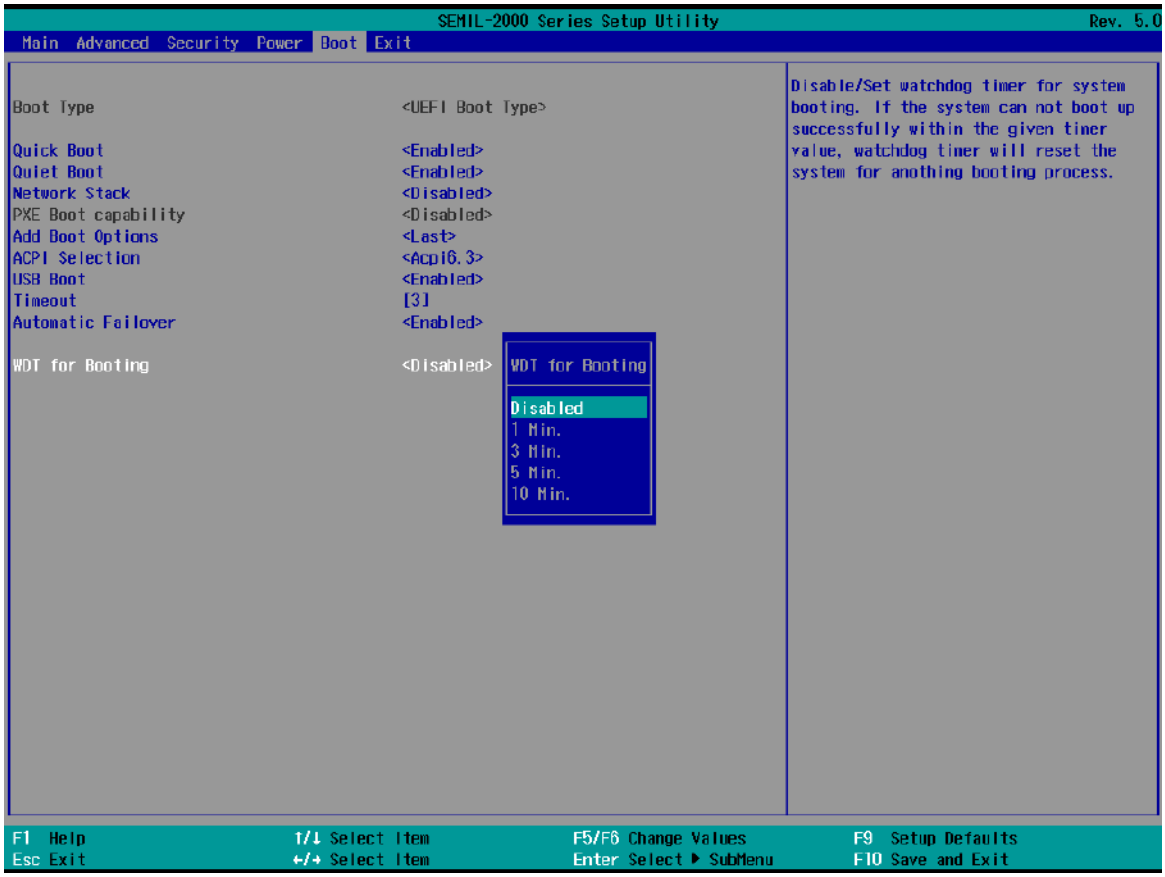
9. Go to **[Boot] > [Add Boot Options]** menu.

10. Select **[First]** or **[Last]** for your newly-added boot device and press ENTER.

11. Highlight your selection and press Enter, press F10 to “Exist Saving Changes”.

5.1.12 Watchdog Timer for Booting

The watchdog timer secures the boot process by means of a timer. Once the timer expires, a reset command is issued to initiate another booting process. There are two options in BIOS menu, "*Automatically after POST*" and "*Manually after Entering OS*". When "*Automatically after POST*" is selected, the BIOS automatically stops the watchdog timer after POST (Power-On Self Test) OK. When "*Manually after Entering OS*" is selected, the user must stop the watchdog timer once booted into the OS. This guarantees the system can always boot into the OS, otherwise another booting process will be initiated. For information about programming watchdog timer, please refer to Watchdog Timer & Isolated DIO.



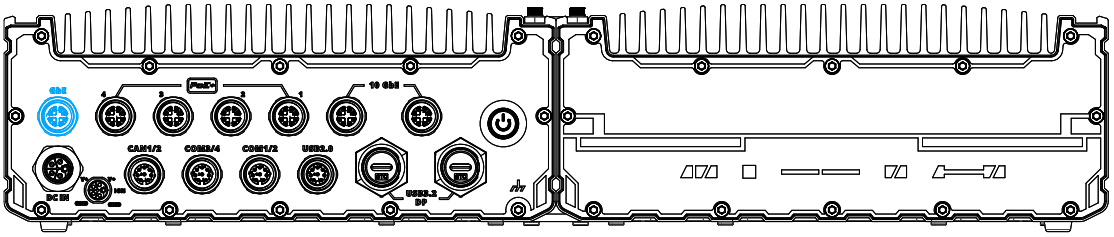
To set the watchdog timer for boot in BIOS:

1. When system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Boot]** menu.
3. Disable or select timeout value for **[WDT for Booting]** option.
4. Once you give a timeout value, the **[WDT Stop Option]** option appears. You can select *"Automatically after POST"* or *"Manually after Entering OS"*.
5. Press F10 to "Exit Saving Changes".

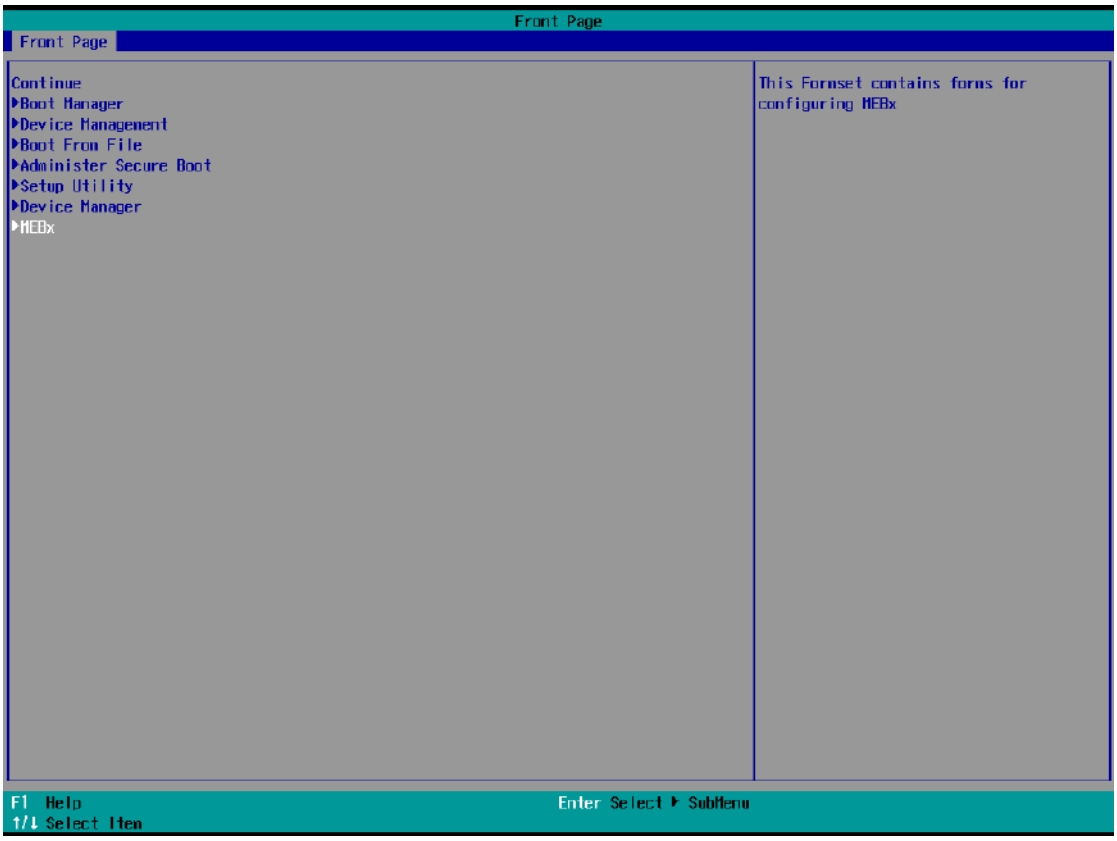
5.2 AMT Configuration

Intel® AMT (Active Management Technology) is a hardware-based technology for remotely managing target PCs via Ethernet connection. The system supports AMT function via its Ethernet port implemented with Intel I219-LM. Prior to using AMT to remotely control the system, you need to configure AMT password and network settings.

1. Connected Ethernet cable to I219-LM port (indicated in **blue**).



2. When the system boots up, press F10 to enter the MEBx configuration menu.



3. When entering MEBx for the first time, it will ask for the default (old) password. Please type “admin” and press ENTER.

4. The system will then request that you enter a new password. The new password must consists of at least one 7-bit ASCII non alpha-numeric character, above 32 (eg,!, @, $) and 8 to 32 characters long. Note that under score "_" is considered an alpha-numeric character.

5. After typing your new password, it will bring you to the MEBx settings page. For more MEBx configuration details, please refer to Intel® MEBX User Guide.

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5.3 RAID Volume Configuration

To set up a RAID 0 or 1 volume in Legacy or UEFI mode, you need to have at least two hard drives or SSDs installed. The system supports RAID configurations in RAID 0 (striping) or RAID 1 (mirror) mode. Users can select the configuration that best suit their needs with RAID 0 (striping) mode offering better hard drive read/ write performances while RAID 1 (mirror) offers better data security.

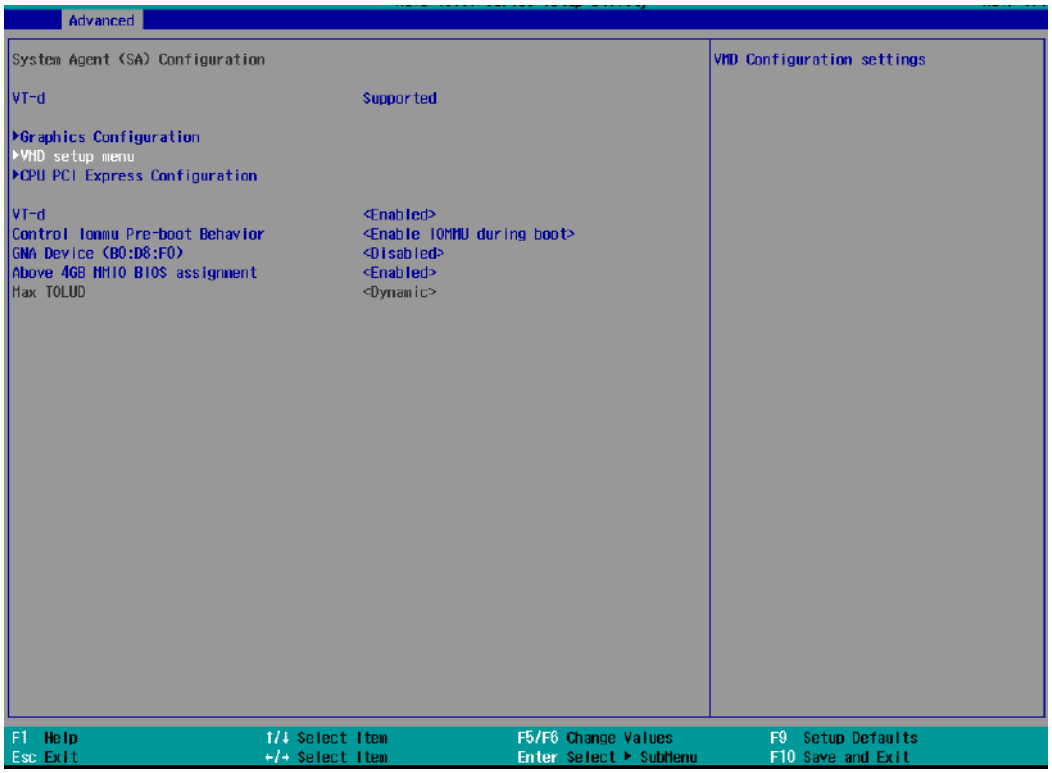
WARNING

Please back up hard drive data before you create or modify RAID volume(s) as the process may cause irreversible data deletion. When creating a RAID volume, it is also recommended to use hard drives from the same batch (same brand, model, capacity, rpm rate, etc.) to avoid performance or capacity allocation issues.

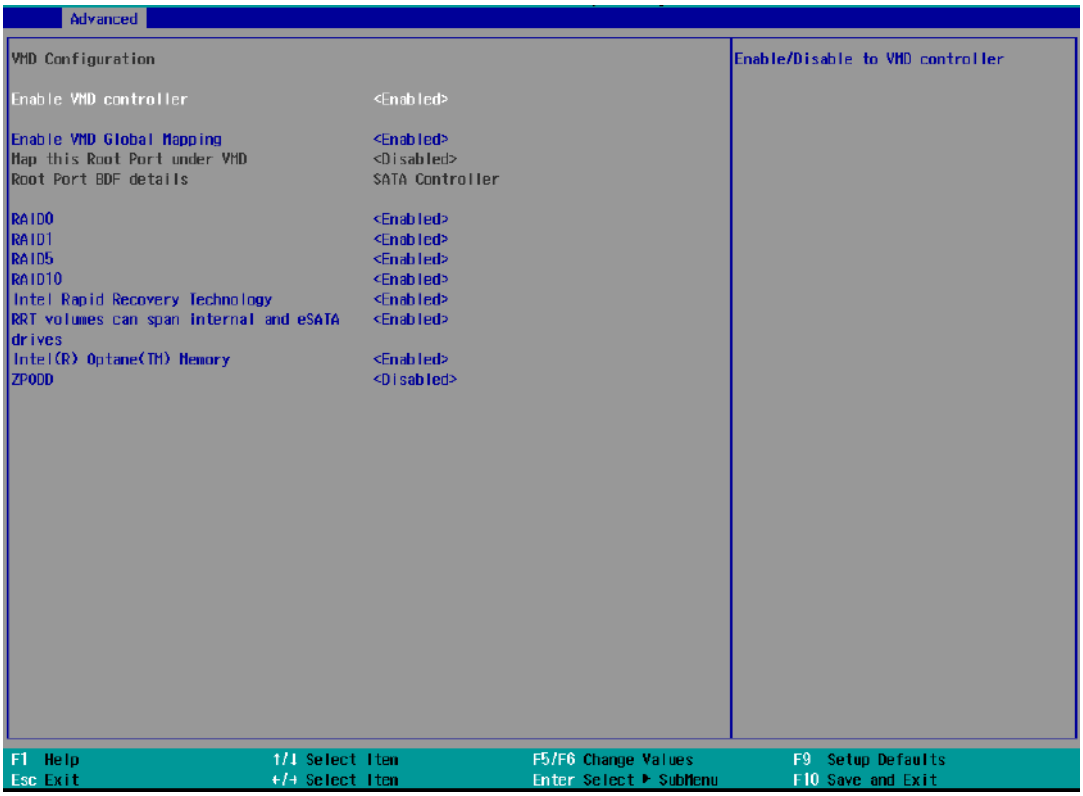
5.3.1 RAID Configuration

To set up RAID configuration, you need to pre-configure the SATA mode setting in the BIOS. Please refer to the following steps:

1. When system boots up, press F2 to enter BIOS setup utility.
2. Go to **[Advanced] > [System Agent (SA) Configuration] > [VMD setup menu]**, and press ENTER.



3. Select **[Enable VMD controller]** and press ENTER, highlight **[Enabled]** and press ENTER.

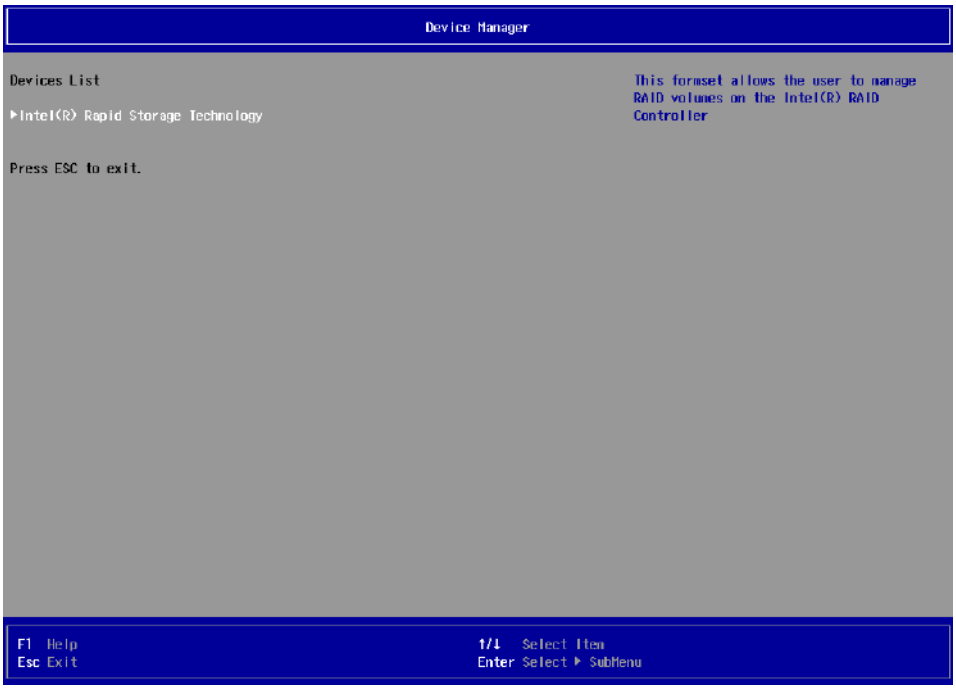


4. Press F10 to “Exit Saving Changes” and reboot the system.

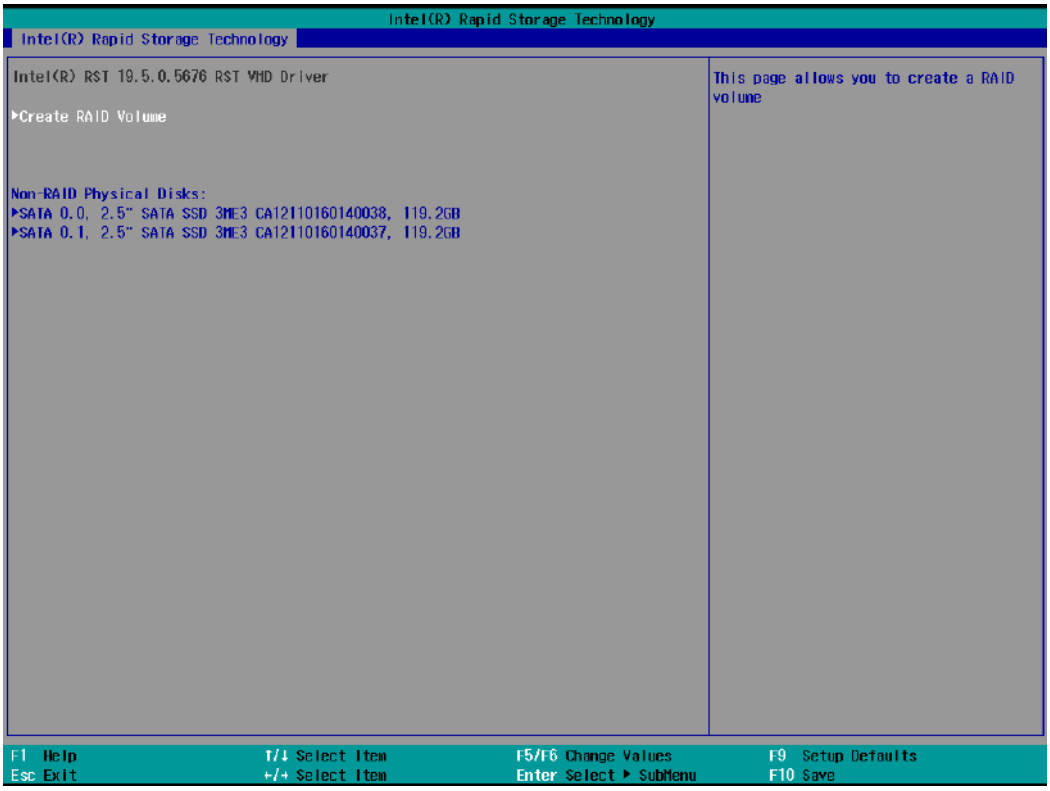
5. When the system reboots, press **[F3]** to enter the Device Manager configuration utility.

5.3.2 RAID Volume Setup

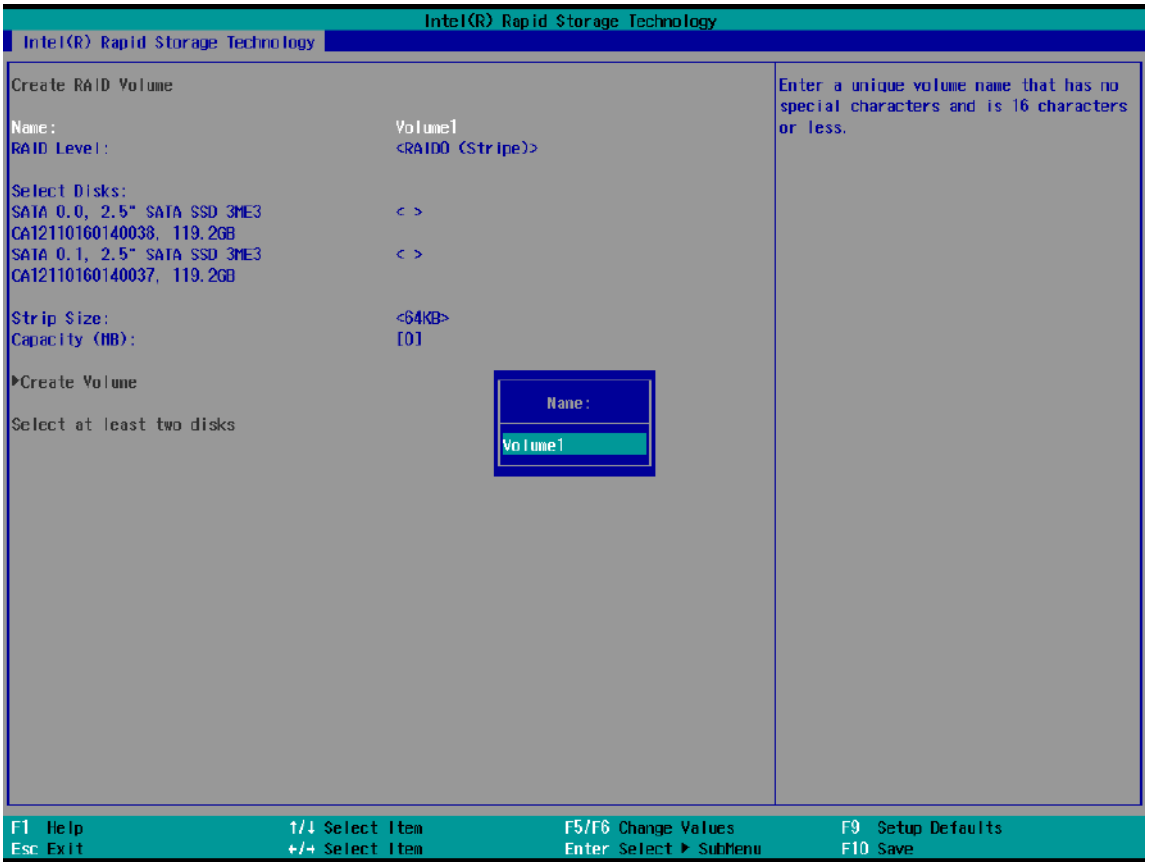
1. Once you've press F3 upon system boot up and you are in the Device Manager configuration utility, select **[Intel® Rapid Storage Technology]** and press ENTER.



2. The following screen shows Non-RAID physical disks and the option "**Create RAID Volume**". Highlight "**Create RAID Volume**" and press ENTER to begin creating your RAID volume.

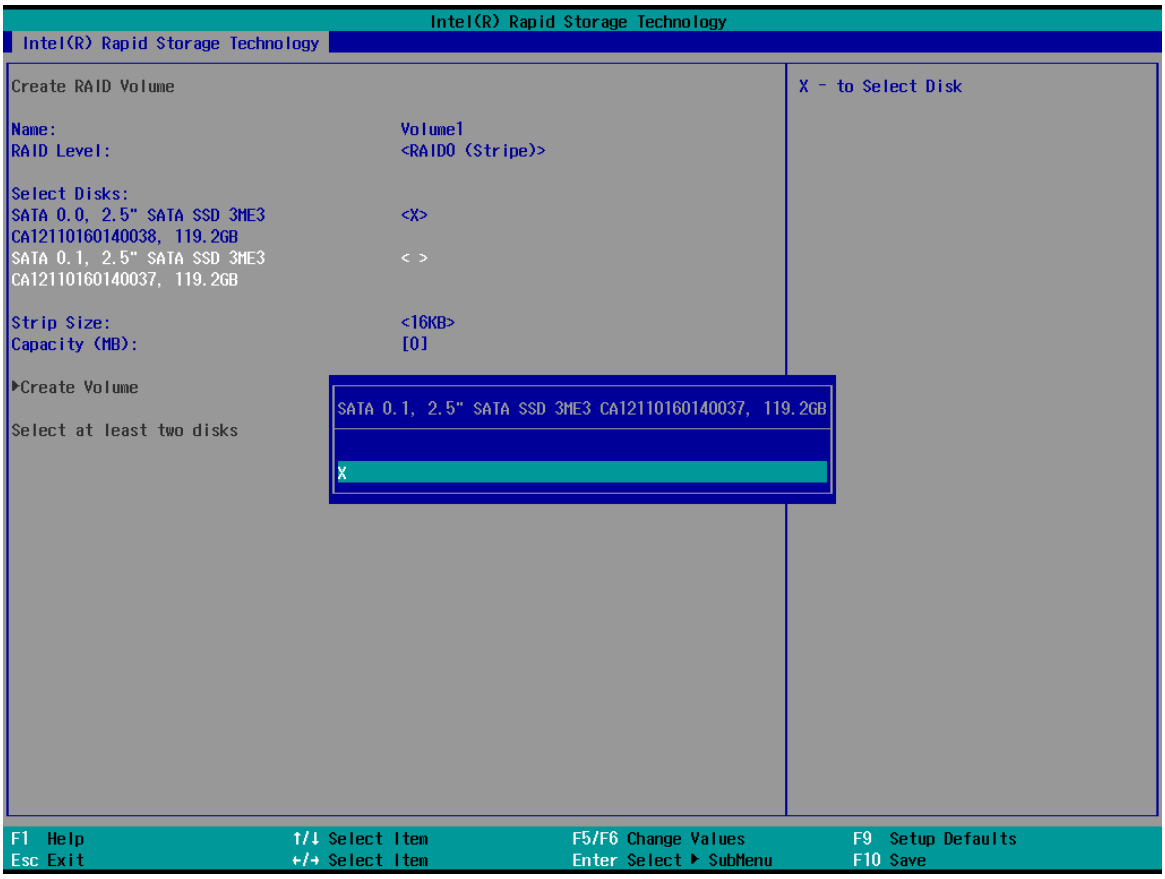


3. The Name option allows you to name your RAID volume. Press ENTER when ready to go to the next option.



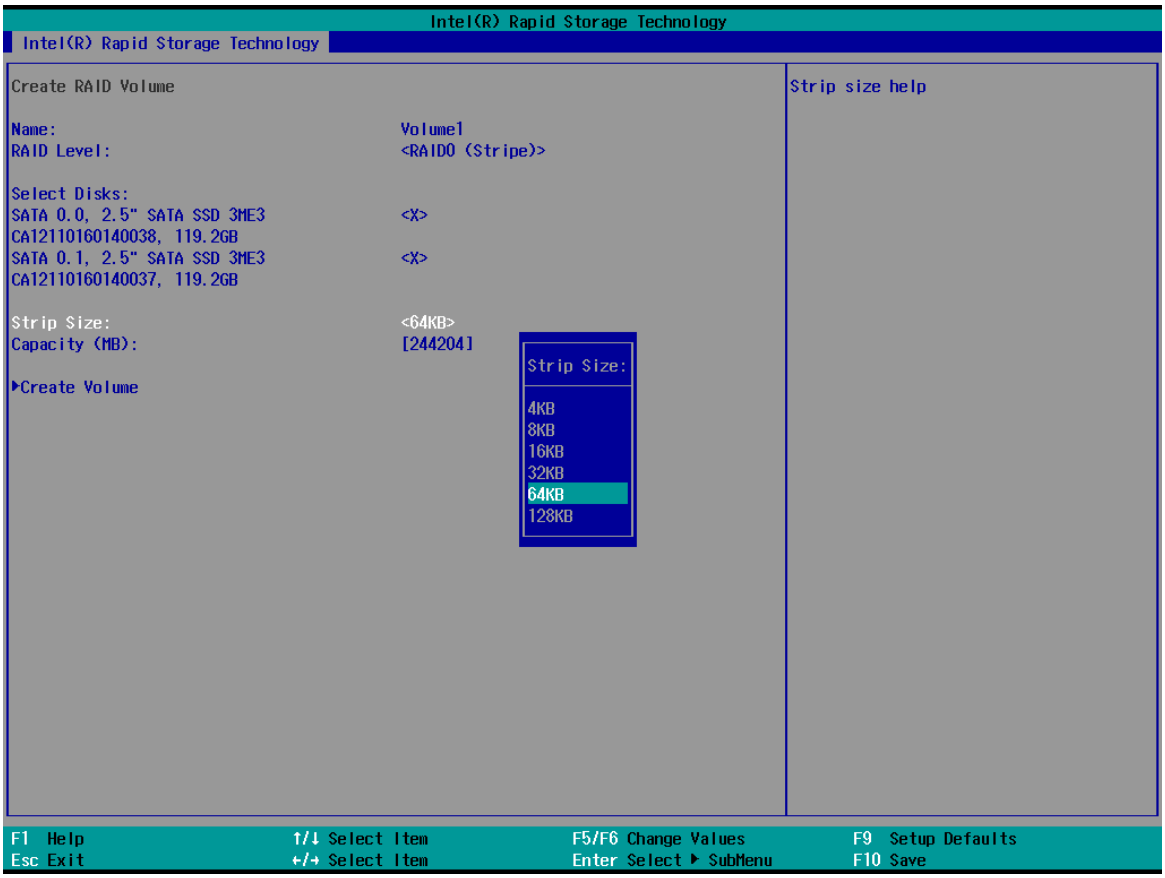
4. The RAID Level option allows you to select RAID-0 (stripping) or RAID-1 (mirror) for your RAID volume. Press ENTER when ready.

5. The Select Disks option allows you to select disk drives for your RAID volume. Highlight a drive and press ENTER, use up/ down arrow keys to highlight “x” and press ENTER to confirm the selection. A minimum of two disk drives must be selected for RAID-0 or RAID-1 configuration. Press ENTER when ready.



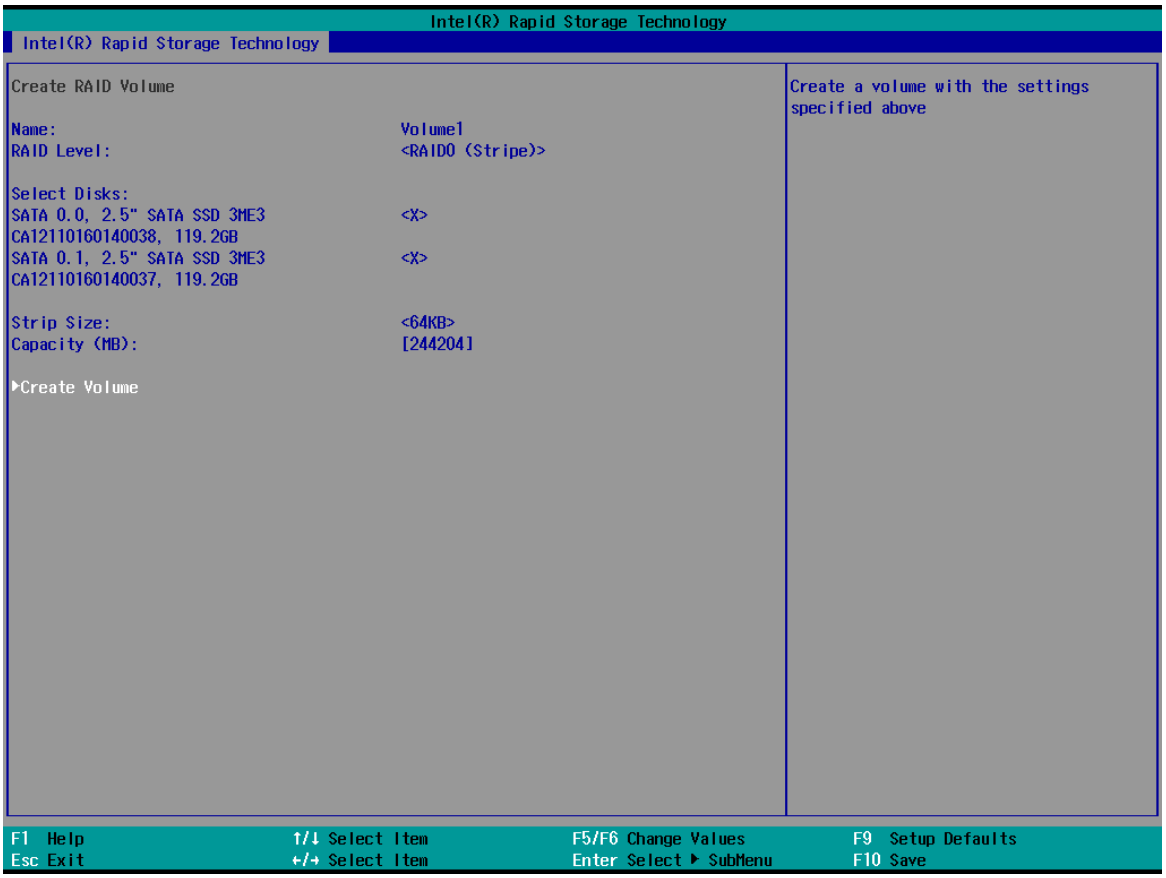
6. The Stripe Size option allows you to configure the stripe size of your RAID volume. Available stripe sizes are 4KB, 8KB, 16KB, 32KB, 64KB, 128KB, use the up and down arrow keys to highlight and press ENTER to confirm the stripe size selection.

   *RAID1(Mirror) does not offer Stripe Size options.

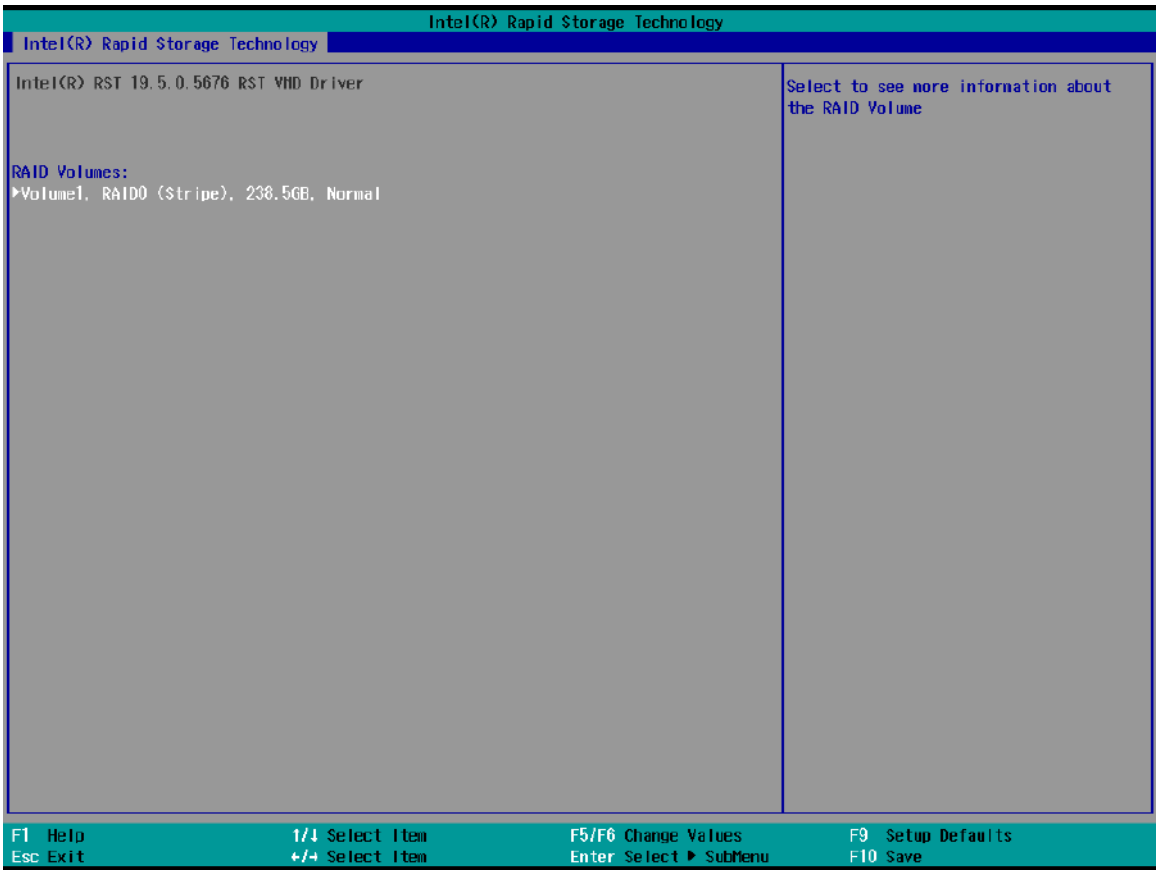


7. The Capacity (MB) option allows you to configure the storage capacity of your RAID volume. By default, the full storage capacity will be applied. Once you have entered a capacity, press ENTER to confirm.

8. The Create Volume option is the final step in the volume creation process. Highlight "**Create Volume**" and press ENTER to begin creating your RAID volume base on the settings you just configured.



9. A summary and status of the RAID volume will be shown when the RAID volume is successfully created.



10. Press F10 to save and Esc to exit the Intel® Rapid Storage Technology configuration page.

NOTE

The above process was to create a RAID-0 volume. If you wish to create a RAID-1 volume, please perform RAID Volume Setup process and select RAID-1 (Mirror) during step 4.

5.3.3 Loading RAID Driver for Windows Installation

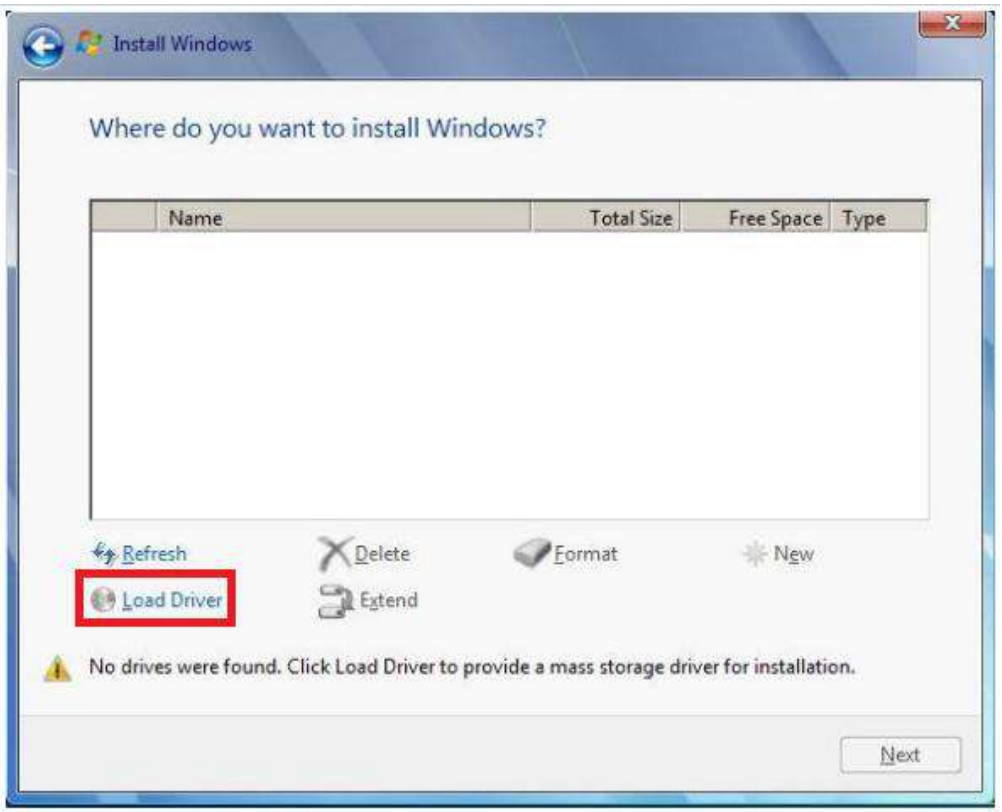
To install Windows on the RAID volume you created, please refer to the following procedure:

1. Please prepare a bootable Windows installation USB drive with the zip file "f6vmdflpy-x64". Download and unzip the driver files, copy the driver files onto the Windows installation USB drive.

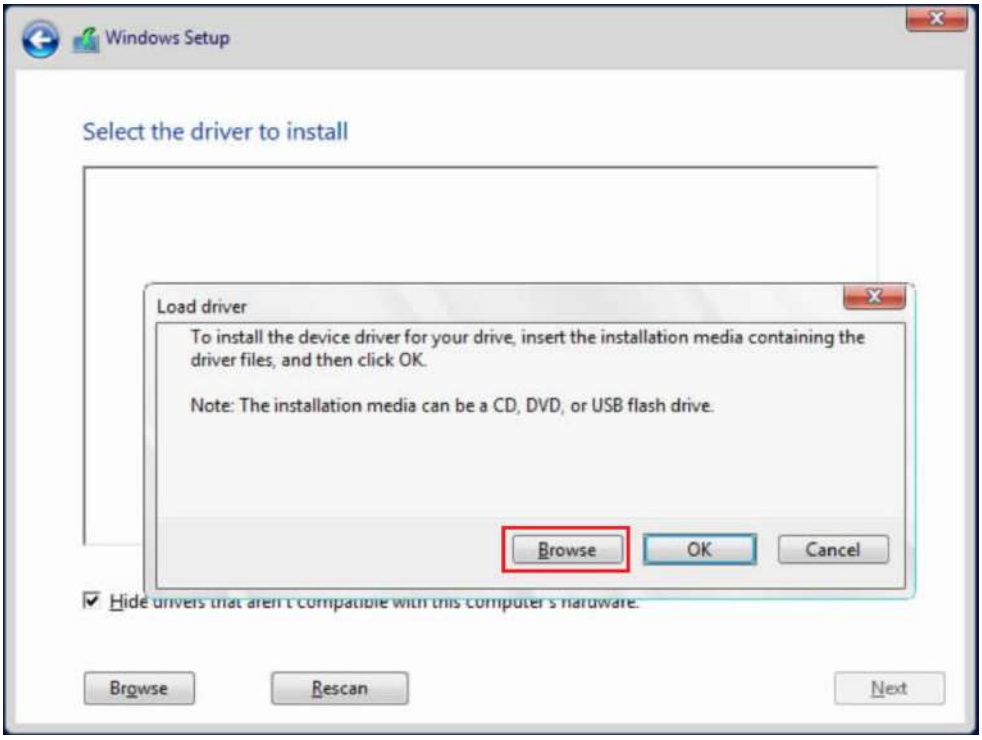
2. Connect the Windows installation USB drive into one of the USB connections on the system.

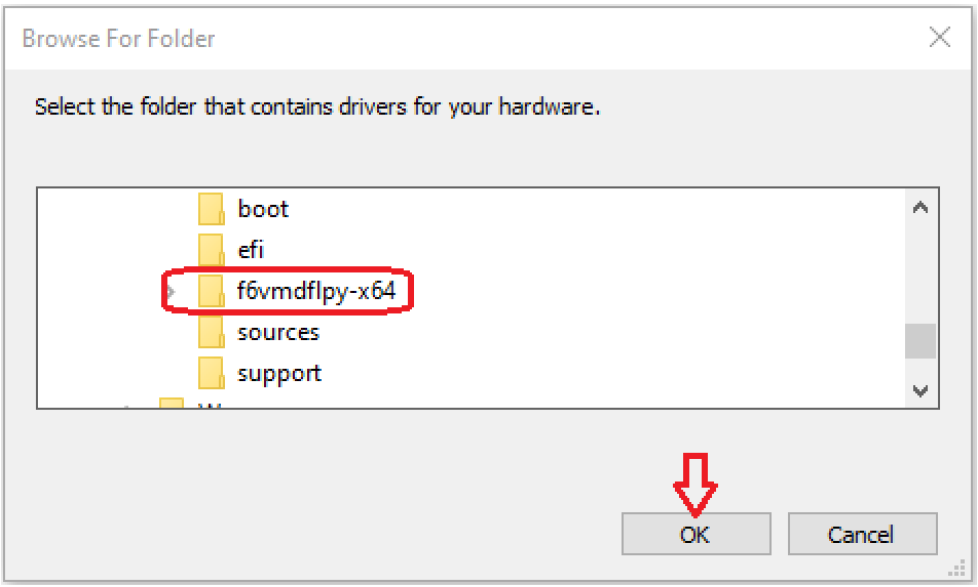
3. Windows installation process should automatically begin (if not, please make sure the boot device in BIOS is set properly).

4. Select the "Load Driver" icon.

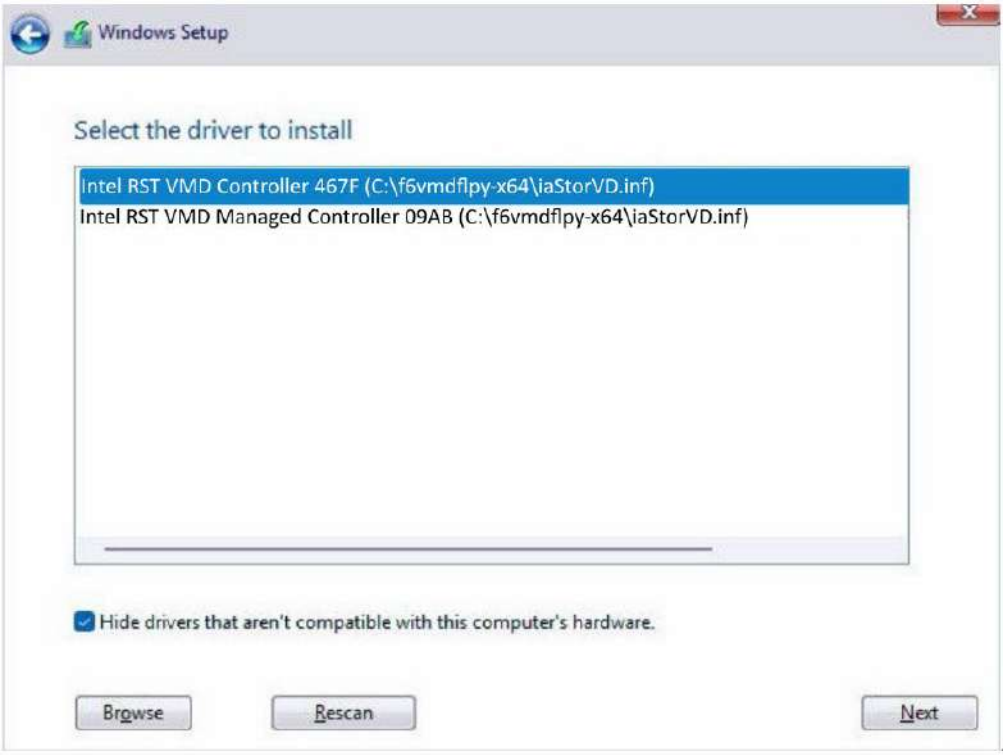


5. In the pop-up Window, select “Browse”, go to the directory where you saved the unzipped drivers “f6vmdflpy-x64”, and click OK.

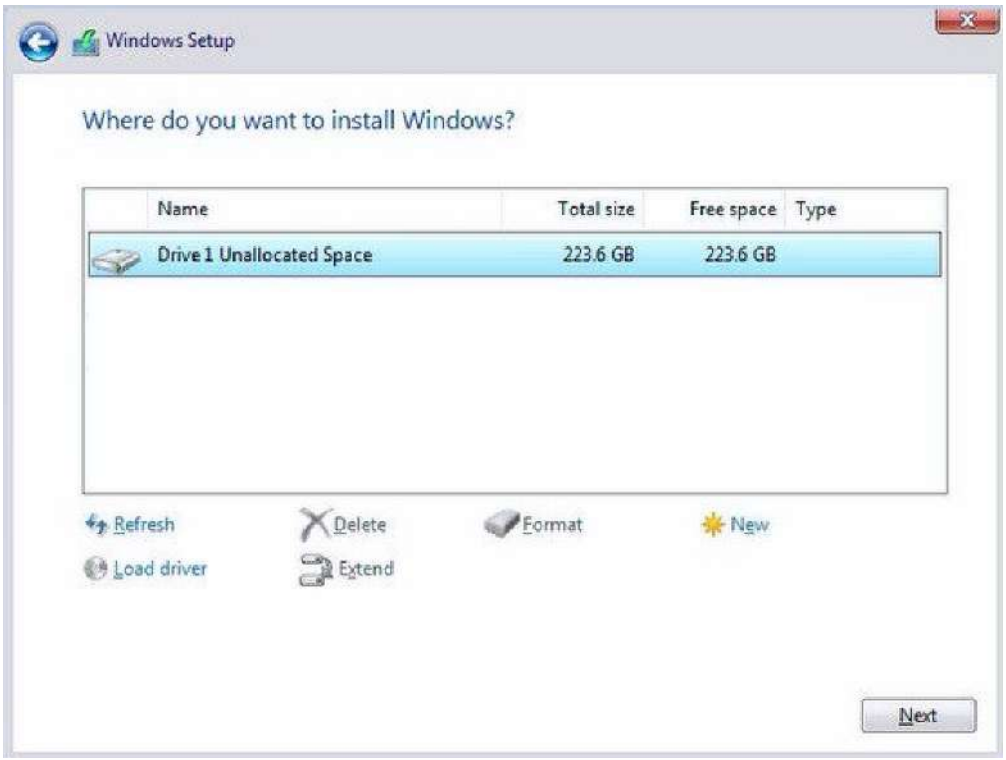




6. Select the driver “Intel RST VMD Controller 467F” and click on Next.



7. The previous created RAID volume shall appear as unallocated space.



From here, follow the standard Windows installation procedures.

6 OS Support and Driver Installation

6.1 Operating System Compatibility

The system supports most operating system developed for Intel® x86 architecture. The following list contains the operating systems which have been tested by Neousys Technology.

- Microsoft Windows 10 LTSC 2021 (x64)
- Ubuntu 20.04.5 LTS, 22.04 LTS, 22.04.1 LTS or other distribution with kernel version ≥ 5.15 */**

NOTE

** For Linux system, user may need to manually compile and install the driver for Intel graphics or I226 GbE controller if the driver is not embedded in kernel. You can visit Intel website for further information.*

*** For distributions, graphics driver and RAID function may not be completely implemented in its kernel. You may encounter restrictions when using these features, such as triple independent display and RAID. For optimum operation, it is the users' responsibility to manually check for new drivers and upgrades!*

Neousys may remove or update operating system compatibility without prior notice. Please contact us if your operating system of choice is not on the list.

6.2 Driver Automatically

The system drivers are available online, please click on this link to download the drivers.

6.3 Driver Installation for Watchdog Timer Control

Neousys provides a driver package which contain function APIs for Watchdog Timer control function. You should install the driver package (WDT_DIO_Setup.exe) in prior to use these functions. Please note that you must install WDT_DIO_Setup_v2.3.1.9 or later versions.

Please refer to this link to download WDT_DIO

Appendix A: Using WDT & DIO

The watchdog timer (WDT) function to ensure reliable system operation. The WDT is a hardware mechanism to reset the system if the watchdog timer is expired. Users can start the WDT and keeping resetting the timer to make sure the system or program is running. Otherwise, the system shall be reset.
In this section, we'll illustrate how to use the function library provided by Neousys to program the WDT functions. Currently, WDT driver library supports Windows 10 x64 and WOW64 platform. For other OS support, please contact Neousys Technology for further information.

Installing WDT_DIO Library

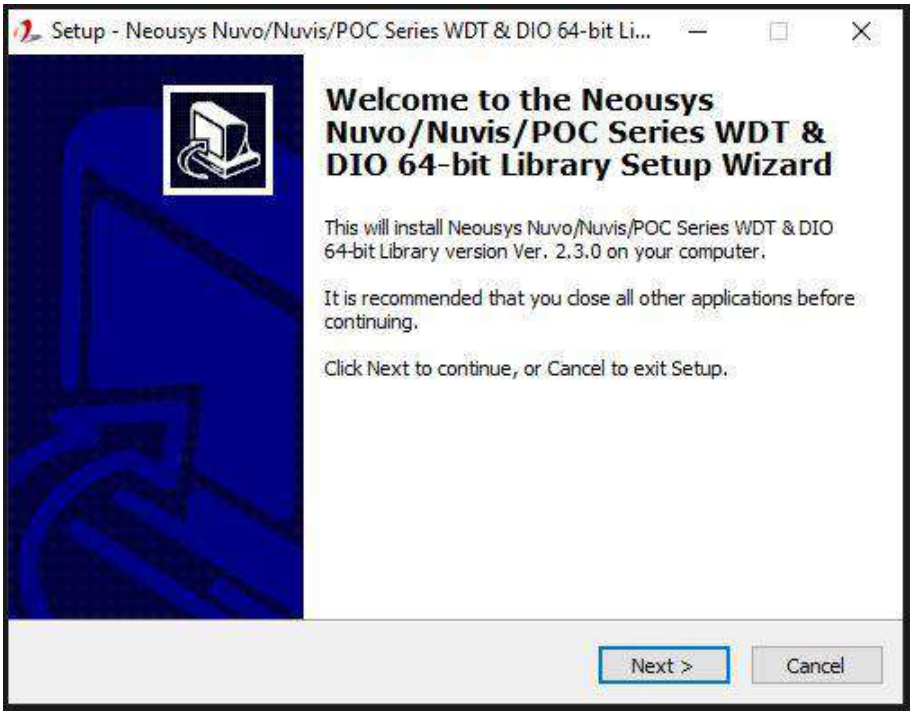
The WDT_DIO function library is delivered in the form of a setup package named **WDT_DIO_Setup.exe**. In prior to program WDT, you should execute the setup program and install the WDT library. Please use the following WDT_DIO_Setup packages according to your operating systems and application.

- For Windows 10 64-bit OS with 64-bit application (x64 mode), please install WDT_DIO_Setup_v2.3.1.9 (x64).exe or later version.

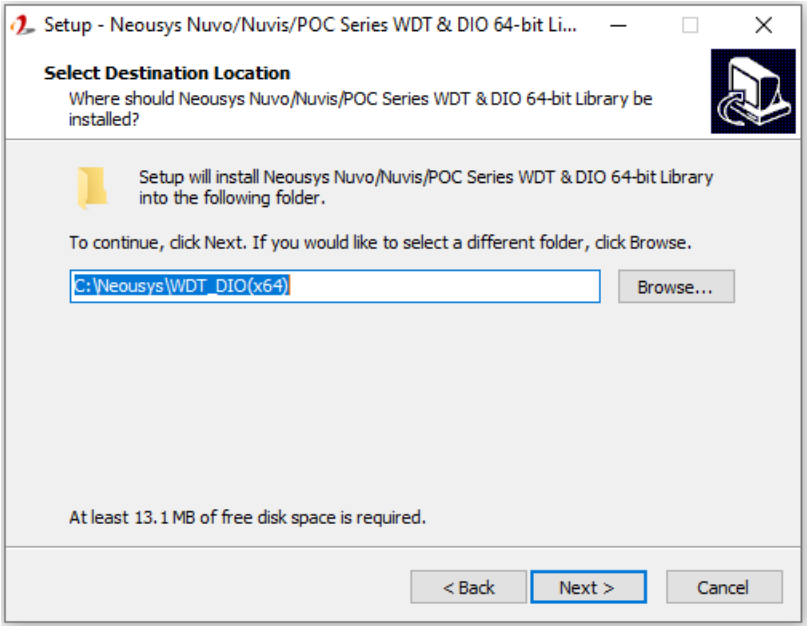
WDT and DIO Library Installation

To setup WDT & DIO Library, please follow instructions below.

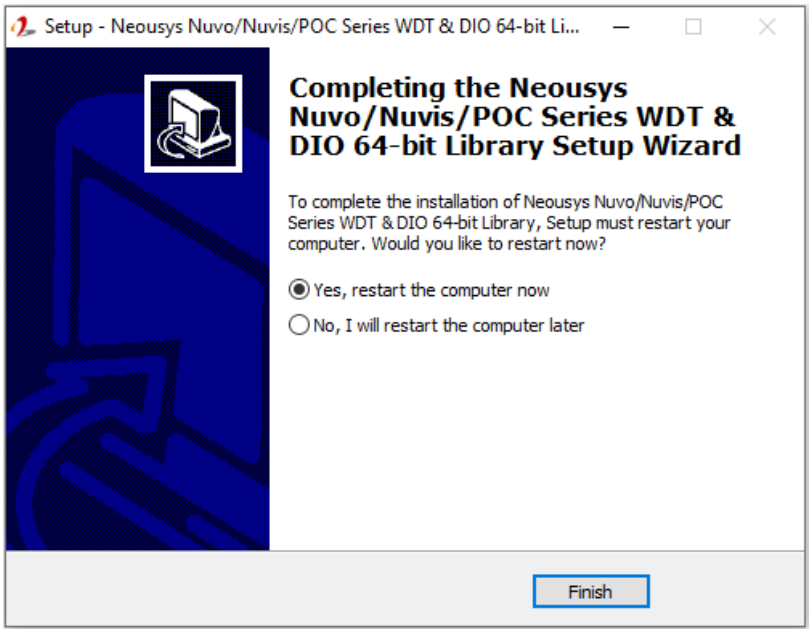
1. Execute **WDT_DIO_Setup.2.3.0.exe** and the following dialog appears.



2. Click “Next >” and specify the directory of installing related files. The default directory is *C:\Neousys\WDT_DIO*.



3. Once the installation has finished, a dialog will appear to prompt you to reboot the system. The WDT & DIO library will take effect after the system has rebooted.



4. When programming your WDT or DIO program, the related files are located in

Header File:	\Include
Library File:	\Lib
Function Reference:	\Manual
Sample Code:	\Sample\WDT_Demo (Demo for Watchdog Timer) \Sample\DIO_Demo (Demo for DIO Control) \Sample\COS_Demo (Demo for change-of-state DI)* \Sample\CAN_Demo (Demo for CAN bus manipulation)* \Sample\IGN_Demo (Demo for ignition status manipulation)* \Sample\POE_Demo (Demo for PoE per-port on/off control)

WDT Function Reference

InitWDT

Syntax	BOOL InitWDT(void);
Description:	Initialize the WDT function. You should always invoke InitWDT() before set or start watchdog timer.
Parameter	None
Return Value	**TRUE:** Successfully initialized **FALSE:** Failed to initialize
Usage	BOOL bRet = InitWDT()

SetWDT

Syntax	BOOL SetWDT(WORD tick, BYTE unit);
Description	Set timeout value and unit for watchdog timer. When InitWDT() is invoked, a default timeout value of 255 seconds is assigned.
Parameter	*tick* WORD value (1 ~ 65535) to indicate timeout ticks. *unit* BYTE value (0 or 1) to indicate unit of timeout ticks. 0 : unit is minute 1: unit is second
Return Value	If value of unit is correct (0 or 1), this function returns TRUE, otherwise FALSE.

Usage	WORD tick=255;
	BYTE unit=1; //unit is second.
	BOOL bRet = SetWDT(tick, unit); //timeout value is 255 seconds

StartWDT

Syntax	BOOL StartWDT(void);
Description	Starts WDT countdown. Once started, the WDT LED indicator will begin blinking. If ResetWDT() or StopWDT is not invoked before WDT countdowns to 0, the WDT expires and the system resets.
Parameter	None
Return Value	If the timeout value is given in correct format (WDT started), this function returns TRUE, otherwise FALSE
Usage	BOOL bRet = StartWDT()

ResetWDT

Syntax	BOOL ResetWDT(void);
Description	Reset the timeout value to the value given by SetWDT().If ResetWDT() or StopWDT is not invoked before WDT countdowns to 0, the WDT expires and the system resets.
Parameter	None
Return Value	Always returns TRUE
Usage	BOOL bRet = ResetWDT()

StopWDT

Syntax	BOOL StopWDT(void);
Description	Stops the countdown of WDT. When WDT has stopped, the WDT LED indicator stops blinking.
Parameter	None
Return Value	Always returns TRUE
Usage	BOOL bRet = StopWDT()

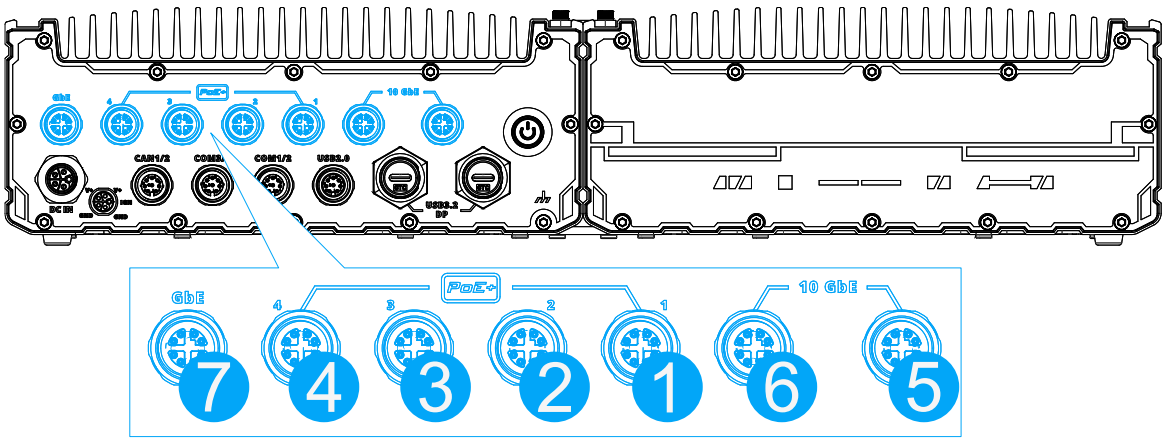
Appendix B: PoE On/ Off Control

The system offers 802.3at PoE+ ports with a unique feature to allow users manually turn on or off the power supply of each PoE port. This can be function can be useful in power device (PD) fault-recovery or power reset.

The function APIs are encapsulated in Neousys WDT_DIO driver package. Please follow the instructions in Appendix A Watchdog Timer & Isolated DIO to install the driver package prior to programming PoE on/off control function.

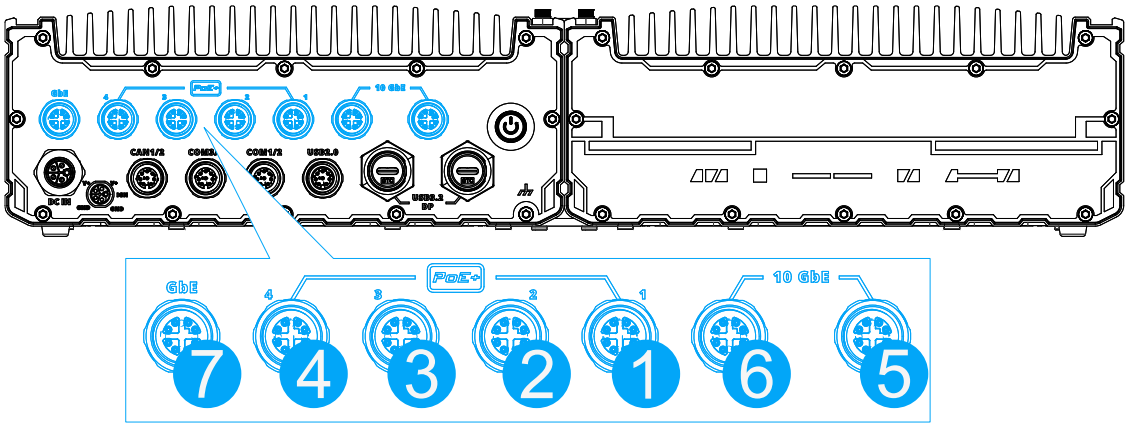
GetStatusPoEPort

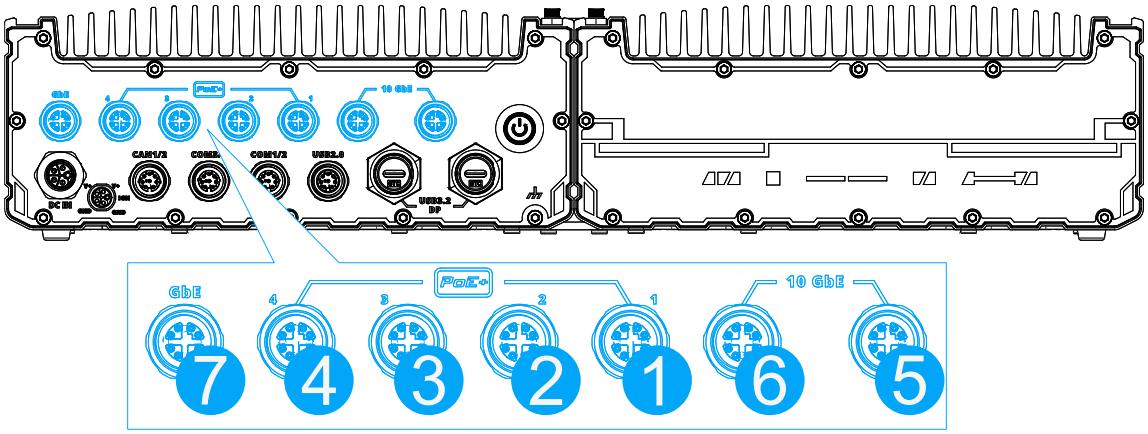
Syntax	BYTE GetStatusPoEPort (Byte port);
Description	Get current on/off status of designated PoE port.
Parameter	*port* BYTE value specifies the index of PoE port. Please refer to the following illustration, *port* should be a value of 1 ~ 7.
Return Value	BYTE value indicating PoE on/off status 0 if port is disabled (off) 1 if port is enabled (on)
Usage	BYTE bEnabled = GetStatusPoEPort (3); //Get on/off status of PoE Port#3



EnablePoEPort

Syntax	BOOL EnablePoEPort (BYTE port);
Description	Turn on PoE power of designated PoE port.
Parameter	*port* BYTE value specifies the index of PoE port. Please refer to the following illustration, *port* should be a value of 1 ~ 7.
Return Value	**TRUE** if enabled success **FALSE** if fail to enable.
Usage	BOOL bRet = EnablePoEPort (3); //Turn on PoE Port#3



DisablePoEPort

Syntax	BOOL DisablePoEPort (BYTE port);
Description	Turn off PoE power of designated PoE port
Parameter	*port* BYTE value specifies the index of PoE port. Please refer to the following illustration, *port* should be a value of 1 ~ 7
Return Value	**TRUE** if disabled success **FALSE** if fail to disable
Usage	BOOL bRet = DisablePoEPort (3); //Turn off PoE Port#3